

32 µA, Ultra-Low Power, 16-Bit Sigma-Delta ADC with Integrated PGA

FEATURES

- ▶ Ultra-low current consumption (typical)
 - ▶ 32 µA: continuous conversion mode (gain = 128)
 - ▶ 5 µA: duty cycling mode (ratio = 1/16)
 - ▶ 0.5 µA: standby mode
 - ▶ 0.1 µA: power-down mode
- ▶ Built-in features for system level power savings
 - ▶ Current saving duty cycle ratio: 1/4 or 1/16
 - Single supply as low as 1.71 V increasing battery length
- ► RMS noise: 25 nV rms at 1.17 SPS (gain = 128) = 48 nV/√Hz
- ▶ Up to 16 noise free bits (gain = 1)
- ▶ Output data rate: 1.17 SPS to 2.4 kSPS
- Operates from 1.71 V to 3.6 V single supply or ±1.8 V split supplies
- ▶ Band gap reference with 15 ppm/°C maximum drift
- ▶ PGA with rail-to-rail analog input
- Adaptable sensor interfacing functionality
 - Matched programmable excitation currents for RTDs
 - On-chip bias voltage generator for thermocouples
 - ▶ Low-side power switch for bridge transducers
 - ▶ Sensor open wire detection

- ▶ Internal temperature sensor and oscillator
- Self and system calibration
- ▶ Flexible filter
- Simultaneous 50 Hz/60 Hz rejection (on selected filter options)
- ► General-purpose outputs
- Diagnostic functionality
- ► Crosspoint multiplexed inputs
 - 8 differential/16 pseudodifferential inputs
- ▶ 5 MHz SPI (3-wire or 4-wire)
- Available in 35-ball, 2.7 mm × 3.56 mm WLCSP and 32-lead, 5 mm × 5 mm LFCSP
- Temperature range: -40°C to +105°C (WLCSP), -40°C to +125°C (LFCSP)
- ▶ AD4131-8 LFCSP pin compatible with AD7124-8 LFCSP

APPLICATIONS

- Smart transmitters
- ▶ Wireless battery and harvester powered sensor nodes
- Portable instrumentation
- ▶ Temperature measurement: thermocouple, RTD, thermistors
- ▶ Pressure measurement: bridge transducers
- ▶ Healthcare and wearables

FUNCTIONAL BLOCK DIAGRAM

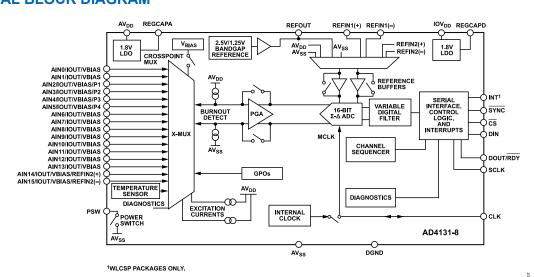


Figure 1. Functional Block Diagram

TABLE OF CONTENTS

| Features | 1 | Digital Interface | 49 |
|---|-------|---|----|
| Applications | 1 | Accessing the Register Map | 49 |
| Functional Block Diagram | 1 | Device Reset | 50 |
| General Description | 5 | ADC Configuration and Operations | 51 |
| Companion Products | 5 | Bipolar/Unipolar Configuration | 51 |
| Specifications | 6 | Status Bits | |
| ADC and AFE Specifications | 6 | Channel Sequencer | 52 |
| Analog Input Specifications | 7 | ADC Conversion Modes | 54 |
| Reference Specifications | 7 | Data Ready Signal | 56 |
| Sensor Biasing Specifications | 8 | Continuous Read Mode | 56 |
| Diagnostics Specifications | 9 | System Synchronization | 58 |
| Rejection Specifications | 9 | ADC Calibration | 58 |
| Logic Input and Output Specifications | 11 | Digital Filters | 61 |
| Power Specifications | 11 | Sinc ³ and Sinc ⁴ Filters | 61 |
| Timing Specifications | 13 | Averaging Filters | 61 |
| Absolute Maximum Ratings | 17 | Post Filters | 61 |
| Thermal Characteristics | 17 | Output Data Rate | |
| Electrostatic Discharge (ESD) Ratings | 17 | 50 Hz and 60 Hz Rejection | 63 |
| ESD Caution | 17 | Sequencer | |
| Pin Configuration and Function Descriptions | 18 | Diagnostics | 68 |
| Typical Performance Characteristics | 24 | Signal Chain Check | 68 |
| Offset Error and Gain Error | 24 | Reference Detection | 68 |
| INL Error and Oscillator | 25 | ADC Errors | |
| Noise | 26 | Overvoltage/Undervoltage Detection | 68 |
| Analog Input Currents | 27 | Power Supply Monitors | |
| Supply Currents | 29 | Main Clock Counter | 69 |
| Reference Input Currents | 30 | SPI Diagnostics | 69 |
| Internal Reference and Temperature Sens | or 31 | CRC Protection | 69 |
| Excitation Currents | 32 | Burnout Currents | 70 |
| Resolution | 33 | Temperature Sensor | 71 |
| Fast Fourier Transform (FFT) | 34 | Diagnostics and Standby Mode | 71 |
| Terminology | 35 | Applications Information | 72 |
| Noise and Resolution | 37 | Power Schemes | |
| 2.5 V Reference | 37 | Recommended Decoupling | 72 |
| 1.25 V Reference | 39 | Input Filters | 72 |
| Noise Spectral Density | 42 | Microprocessor Interfacing | 72 |
| Theory of Operation | 43 | Unused Pins | 72 |
| Overview | 43 | Power-Up and Initialization | 73 |
| Analog-to-Digital Converter (ADC) Core | 43 | Layout and Grounding | 73 |
| ADC Main Clock | 44 | Assembly Guidelines | 73 |
| ADC Reference | 44 | AD4131-8 Registers | |
| Analog Front End | 45 | AD4131-8 Register Summary | 74 |
| Programmable Gain Amplifier | 46 | Registers Details | |
| Other Features | 47 | Outline Dimensions | 99 |
| Power Supplies | 47 | Ordering Guide | 99 |
| Power-Down Modes | 47 | Evaluation Boards | 99 |
| | | | |

TABLE OF CONTENTS

REVISION HISTORY

| 1/2025—Rev. 0 to Rev. A | |
|--|----------|
| Changed Master and Controller to Main (Throughout) | 1 |
| Added 32-Lead LFCSP (Universal) | |
| Changes to Features Section | 1 |
| Changes to Functional Block Diagram Section | |
| Changes to General Description Section | 5 |
| Changes to Gain Error Drift vs. Temperature Parameter, Table 1 | 6 |
| Added Note 2, Table 2 | |
| Added Note 2, Table 3 | |
| Changes to Current Drift Matching Parameter, Table 4 | 8 |
| Changes to REFIN1(+) Overvoltage Detect Level Parameter, REFIN1(-) Undervoltage Detect Level | |
| Parameter, A _{IN} OV Detect Level Parameter, and A _{IN} UV Detect Level Parameter, Table 5 | 9 |
| Changes to Power Supply Rejection (AV _{DD}) Parameter and At DC Parameter, Table 6 | <u>c</u> |
| Changes to Table 8 | 11 |
| Changes to Last SCLK Rising for SW Reset Serial Peripheral Interface (SPI) Transaction to First SCLK | |
| Falling for Next SPI Transaction Parameter and $\overline{\text{CS}}$ Rising Edge for SW Reset SPI Transaction to $\overline{\text{CS}}$ | |
| Falling Edge for Next SPI Transaction Parameter, Table 9 | 13 |
| Changes to Thermal Characteristics Section and Table 11 | 17 |
| Added Table 13; Renumbered Sequentially | 17 |
| Changes to Figure 11 Caption and Table 14 Title | 18 |
| Added Figure 12 and Table 15; Renumbered Sequentially | . 21 |
| Changes to Figure 13 to Figure 18 | 24 |
| Changes to Figure 19 to Figure 24 | 25 |
| Changes to Figure 28 | . 26 |
| Changes to Figure 31 to Figure 42 | 27 |
| Changes to Figure 43 and Figure 45 | |
| Changes to Figure 47 and Figure 48 | 30 |
| Changes to Figure 50, Figure 53, and Figure 54 | |
| Change to Table 21 | |
| Change to Table 29 | |
| Change to Table 34 | |
| Changes to Figure 71 and Figure 72 | |
| Change to Table 43 | |
| Changes to Figure 73 | |
| Replaced Table 48 | |
| Added Table 49 | |
| Changes to Channel Sequencer Section | |
| Changes to Single Sequence Modes Section | |
| Changes to Duty Cycling Mode Section | |
| Changes to Data Ready Signal Section | |
| Changes to Figure 79 and Figure 80 | |
| Changes to Sequencer Timing Section | |
| Changes to Figure 95 and Figure 96 | |
| Changes to Assembly Guidelines Section | |
| Changes to Table 66 | |
| Changes to Table 67 | |
| Changes to Table 70 | /8 |

Data Sheet

TABLE OF CONTENTS

| Changes to Identification Register Section and Table 74 | . 84 |
|---|------|
| Updated Outline Dimensions | . 99 |
| Changes to Ordering Guide | . 99 |
| Changes to Evaluation Boards | |

2/2023—Revision 0: Initial Version

analog.com Rev. A | 4 of 99

GENERAL DESCRIPTION

The AD4131-8 is an ultra-low power, high precision, measurement solution for low bandwidth battery operated applications. The fully integrated analog front end (AFE) includes a multiplexer for up to 16 single-ended or eight differential inputs, programmable gain amplifier (PGA), 16-bit sigma-delta (Σ - Δ) analog-to-digital converter (ADC), on-chip reference and oscillator, selectable filter options, flexible sequencer, sensor biasing and excitation options, diagnostics, and newly added features to improve the battery-operated lifetime (duty cycling).

The AD4131-8 allows users to measure low frequency signals with a current consumption of 28.5 μ A (gain = 1) and 32.5 μ A (gain = 128) while continuously converting, and even lower average currents when using one of the duty cycling options. The AD4131-8 can be configured to have eight differential inputs or 16 single-ended or pseudodifferential inputs, which connect to a crosspoint multiplexer, where any input pair can become a measurement channel input to the PGA and ADC.

The AD4131-8 is designed to allow the user to operate from a single analog supply voltage from 1.71 V to 3.6 V. In battery applications, operation as low as 1.71 V can extend the system lifetime as the AFE can continue its operation, even as the battery voltage dissipates. The digital supply can be separate and range from 1.65 V to 3.6 V.

The following key analog functions are offered on the AD4131-8 to allow simple and effective connection to transducers used for measuring temperature, load, and pressure:

- ▶ PGA. Due to the programmable gain (from 1 to 128) and the high input impedance with low input current, the PGA allows direct interfacing to transducers with low output amplitudes like resistive bridges, thermocouples, and resistance temperature detectors (RTDs).
- ▶ The capacitive PGA allows full common-mode input range, giving designers greater margin for widely varying input common modes. A wider common-mode input range improves the overall resolution and is highly effective in ratio metric measurements.
- ▶ Low drift precision current sources. The IEXC0 and IEXC1 current source can be used to excite 2-, 3-, and 4-wire RTDs. Excitation current output options include 100 nA, 10 μA, 20 μA, 50 μA, 100 μA, 150 μA, and 200 μA.
- ▶ The low-side power switch (PDSW) can be used to power down bridge sensors between conversions. The PDSW can be controlled within the sequencer on a per channel basis, allowing optimum timing and energy savings in the overall system. The PDSW can also allow higher powered analog sensors to be used in a low power system.
- ▶ Voltage bias for thermocouples (the VBIAS source sets the common-mode voltage of a channel to AV_{DD}/2).
- ➤ The flexible sequencer allows the conversion of each enabled preconfigured channel in a predetermined order, allowing a mix of transducer, system checks, and diagnostic measurements to be interleaved. The sequencer eliminates need for repetitive

serial interface communication with the device. Sixteen channels can be configured in the sequence, each of them selecting from eight predefined ADC setups that allow selection of gain, filter type, output data rate, buffering, timing, and reference source.

High levels of integrated front-end functionality coupled with small package options allow smaller end solutions. For example, the AD4131-8 integrates a low thermal drift band gap reference in addition to accepting an external differential reference, which can be internally buffered.

In safety critical applications, the AD4131-8 includes diagnostic functionality such as open wire detection through burnout currents, internal temperature sensor, reference detection, and analog input overvoltage and undervoltage detection. Added diagnostics are included on the digital interface such as cyclic redundancy check (CRC) and serial interface checks for a robust communication link.

COMPANION PRODUCTS

- ► Low Noise, Low Dropout Regulators: ADP150ACBZ-3.3 and ADP150ACBZ-1.8
- Regulated Charge-Pump Inverters: LTC1983ES6-3 and ADP7182AUJZ-1.8
- ▶ Voltage Reference: ADR391 or ADR3625
- ▶ Low Power Microcontrollers: MAX32670 (precision), MAX32655 (BLE), MAX32663A (ECG)

analog.com Rev. A | 5 of 99

SPECIFICATIONS

 AV_{DD} = 1.71 V to 3.6 V, IOV_{DD} = 1.65 V to 3.6 V, AV_{SS} = DGND = 0 V, REFIN1(+) = 2.5 V (for AV_{DD} - AV_{SS} \geq 2.7 V), REFIN1(+) = 1.25 V (for AV_{DD} - AV_{SS} \leq 2.7 V), REFIN1(-) = AV_{SS} , internal main clock (MCLK) (MCLK frequency (I_{MCLK}) = 76.8 kHz), PGA enabled (default), reference buffers bypassed (default), temperature range = I_{MIN} to I_{MAX} , and decoupling as per the Recommended Decoupling section, unless otherwise noted.

ADC AND AFE SPECIFICATIONS

Table 1. ADC and AFE Specifications

| Parameter ¹ | Min | Тур | Max | Unit | Test Conditions/Comments |
|---|--------|-------------------|-----------------|-------------|--|
| SAMPLING DYNAMICS | | | | | |
| Output Data Rate (ODR) | 1.17 | | 2400 | SPS | See the Output Data Rate section |
| Active Time ² | | 100% | | | Continuous conversion mode |
| | | 25% | | | DUTY_CYC_RATIO = 1/43 |
| | | 6.25% | | | DUTY_CYC_RATIO = 1/16 ³ |
| STATIC PERFORMANCE | | | | | |
| No Missing Codes ² | 16 | | | Bits | FS ⁴ > 2, sinc ⁴ filter |
| | 16 | | | Bits | FS ⁴ > 8, sinc ³ filter |
| Resolution and Update Rate ² | | | | | See the Noise and Resolution section |
| RMS Noise and Update Rate ² | | | | | See the Noise and Resolution section |
| Noise Spectral Density ² | | | | | See the Noise and Resolution section |
| Integral Nonlinearity (INL) ² | -5 | ±2 | +5 | ppm of FSR1 | Gain = 1 |
| | -15 | ±4 | +15 | ppm of FSR1 | Gain > 1 ⁵ |
| Offset Error ⁶ | | | | | |
| Before Calibration | | ±2 | | μV | Gain = 1, PGA bypass ⁷ |
| | | ±10 | | μV | Gain = 1 to 16 |
| | | ±2 | | μV | Gain = 32 to 128 |
| After Internal and System Calibration | | In order of noise | | | |
| Offset Error Drift vs. Temperature ⁸ | | 3 | 30 | nV/°C | Gain = 1, PGA bypass ⁷ |
| | | 120/gain | (140/gain) + 90 | nV/°C | Gain = 1 to 128 |
| Gain Error ^{6, 9} | | | | | |
| Before Calibration | -0.015 | | +0.015 | % | Gain = 1 ¹⁰ , T _A = 25°C |
| | | 0.5 | | % | Gain = 1, PGA bypass ⁷ |
| | | 0.5 | | % | Gain > 1 |
| After Internal Calibration ¹¹ | -0.12 | +0.01 | +0.12 | % | |
| After System Calibration ¹¹ | | In order of noise | | | |
| Gain Error Drift vs. Temperature | | 0.1 | 1 | ppm/°C | Gain = 1, PGA bypass ⁷ |
| | | 0.1 | 2 | ppm/°C | Gain = 1 to 16, T _A = −40°C to +105°C |
| | | 0.1 | 3 | ppm/°C | $T_A = -40$ °C to +125°C (LFCSP only) |
| | | 0.1 | 3 | ppm/°C | Gain = 32 to 128, T _A = -40°C to +105°C |
| | | 0.1 | 4 | ppm/°C | $T_A = -40^{\circ}C$ to +125°C (LFCSP only) |

¹ See the Terminology section.

analog.com Rev. A | 6 of 99

These specifications are not production tested but are supported by characterization data at the initial product release.

Duty cycling mode is enabled by setting MODE = 0b1001 in the ADC_CONTROL register. The DUTY_CYC_RATIO bit can be found in the same register. See the Duty Cycling Mode and Duty Cycling Mode Timing sections.

⁴ FS is the decimal equivalent of the FS, Bits[10:0] in the filter registers.

The nonlinearity for gain > 1 is production tested for gain = 32 and voltage reference (V_{REF}) = 2.5 V. For the other conditions, this specification is supported by characterization data at the initial product release.

Following a system or internal zero-scale calibration, the offset error is in the order of the noise for the programmed gain and output data rate selected. A system full-scale calibration reduces the gain error to the order of the noise for the programmed gain and output data rate.

PGA BYP n = 1. The PGA BYP n bit can be found in each CONFIG n register. See the Programmable Gain Amplifier section for more details.

SPECIFICATIONS

ANALOG INPUT SPECIFICATIONS

Table 2. Analog Input Specifications

| Parameter ¹ | Min | Тур | Max | Unit | Test Conditions/Comments ² |
|---|--------------------------------|------|-------------------------------|-------|---|
| ANALOG INPUT VOLTAGE ³ | | | | | V _{REF} = REFIN1(+) – REFIN1(-), or internal reference |
| Differential Input Voltage Ranges | | | ±V _{REF} /gain | V | PGA on ⁴ |
| Absolute Analog Input (A _{IN}) Voltage Limits | AV _{SS} - 0.05 | | $AV_{DD} + 0.05$ | V | |
| ANALOG INPUT CURRENT ³ | | | | | |
| Absolute Input Current | | | | | |
| Gain = 1 | -3 | ±0.5 | +3 | nA | |
| Gain = 1 | | ±2.5 | | nA | PGA bypass ⁵ |
| Gain > 1 | -1 | ±0.5 | +1 | nA | |
| Differential Input Current | | | | | |
| Gain = 1 | -3 | ±0.5 | +3 | nA | |
| Gain = 1 | | ±1.5 | | nA | PGA bypass ⁵ |
| Gain > 1 | -1 | ±0.5 | +1 | nA | |
| Analog Input Current Drift | | | | | |
| Gain = 1, Gain > 1 | | 2 | 15 | pA/°C | |
| Gain = 1 | | 2 | | pA/°C | PGA bypass ⁵ |
| SYSTEM CALIBRATION ³ | | | | | |
| Calibration Limits | | | | | |
| Full Code | | | 1.05 × V _{REF} /gain | V | DATA = 0xFFFF |
| Zero Code | −1.05 × V _{REF} /gain | | | V | DATA = 0x0000 |
| Input Span | 0.8 × V _{REF} /gain | | 2.1 × V _{REF} /gain | V | |

¹ See the Terminology section.

REFERENCE SPECIFICATIONS

Table 3. Reference Specifications

| Parameter ¹ | Min | Тур | Max | Unit | Test Conditions/Comments ² |
|---|--------------|------|--------------|--------|--|
| REFERENCE OUTPUT | | | | | Internal reference enabled, load capacitance (C _L) = 1 nF |
| Initial Accuracy | 2.5 - 0.2% | 2.5 | 2.5 + 0.2% | V | T _A = 25°C |
| | 1.25 – 0.45% | 1.25 | 1.25 + 0.45% | V | T _A = 25°C |
| Temperature Coefficient (TC) (Drift) ³ | | 2 | 15 | ppm/°C | $T_A = -40^{\circ}\text{C to } +105^{\circ}\text{C}, V_{REF} = 2.5 \text{ V}$ |
| | | 2 | 15 | ppm/°C | $T_A = -40^{\circ}\text{C to } +105^{\circ}\text{C}, V_{REF} = 1.25 \text{ V}$ |
| Output Current Load Capability | | ±1 | | mA | |
| Load Regulation Sourcing and Sinking | | 90 | | μV/mA | Change in output voltage (ΔV_{OUT})/change in output current (ΔI_{LOAD}) |
| Power Supply Rejection | | 95 | | dB | |

analog.com Rev. A | 7 of 99

⁸ Recalibration at any temperature removes these errors.

⁹ Gain error applies to both positive and negative full scale. A factory calibration is performed at gain = 1 and T_A = 25°C (PGA_BYP_n = 0).

¹⁰ This gain error is factory calibrated at ambient temperature and at a gain of 1 (PGA_BYP_n = 0).

¹¹ CAL_RANGE_X2 = 1 for V_{REF} > 2 V. The CAL_RANGE_X2 bit can be found in the MISC register. See the Internal Gain Calibration section for more details.

 $^{^{2}}$ T_A = -40°C to +105°C.

These specifications are not production tested but are supported by characterization data at the initial product release.

⁴ PGA_BYP_n = 0, when V_{REF} > (AV_{DD} - AV_{SS} - 200 mV), the input differential range cannot exceed (AV_{DD} - AV_{SS} - 200 mV)/gain.

⁵ PGA_BYP_n = 1. The PGA_BYP_n bit can be found in each CONFIG_n register. See the Programmable Gain Amplifier section for more details.

SPECIFICATIONS

Table 3. Reference Specifications (Continued)

| Parameter ¹ | Min | Тур | Max | Unit | Test Conditions/Comments ² |
|--|-------------------------|------|-----------------------|--------|---|
| Output Voltage Noise (0.1 Hz to 10 Hz) | | 40 | | μV p-p | T _A = 25°C |
| Output Voltage Noise Density | | 800 | | nV/√Hz | T _A = 25°C |
| Turn On Settling Time | | 280 | | μs | T _A = 25°C |
| REFERENCE INPUTS | | | | | Reference input (REFIN) = REFIN1(+) – REFIN1(-) |
| External REFIN Voltage ³ | 0.5 | | AV_{DD} – AV_{SS} | V | |
| Absolute REFINx pins Voltage Limits ³ | AV _{SS} - 0.05 | | $AV_{DD} + 0.05$ | V | Reference buffers disabled ⁴ |
| | AV _{SS} + 0.1 | | $AV_{DD} - 0.1$ | V | Reference buffers enabled ⁴ |
| Reference Input Current | | | | | |
| Absolute Input Current | -11 | ±7 | +11 | nA | Reference buffers disabled ⁴ |
| | -4 | ±0.2 | +4 | nA | Reference buffers enabled ⁴ |
| Reference Input Current Drift ³ | | 10 | 21 | pA/°C | Reference buffers disabled ⁴ |
| | | 1.6 | 20 | pA/°C | Reference buffers enabled ⁴ |
| Normal Mode Rejection | | | | | Same as for analog inputs |
| Common-Mode Rejection | | 90 | | dB | |

¹ See the Terminology section.

SENSOR BIASING SPECIFICATIONS

Table 4. Sensor Biasing Specifications

| Parameter ¹ | Min | Тур | Max | Unit | Test Conditions/Comments |
|---|-------------------------|------------------------------|------------------|--------|---|
| EXCITATION CURRENT SOURCES | | | | | Available on any analog input pin |
| (IEXC0 and IEXC1) | | | | | |
| Output Current | | 10/20/50/100/ 150/200/0.1 | | μΑ | Selectable on a per channel basis |
| Initial Tolerance | | ±1 | | % | T _A = 25°C |
| Current Drift ² | | 50 | | ppm/°C | |
| Current Matching ^{2, 3} | -1.6 | ±0.5 | +1.6 | % | 10 μΑ/20 μΑ/50 μΑ/100 μΑ/150 μΑ/200 μΑ |
| | -3.2 | ±1 | +3.2 | % | 100 nA |
| Current Drift Matching ² | | 3 | 25 | ppm/°C | 10 μA/20 μA/50 μA/100 μA/150 μA/200 μA, Τ _A = -40°C to +105°C |
| | | | 32 | ppm/°C | $T_A = -40$ °C to +125°C (LFCSP only) |
| | | 5 | 60 | ppm/°C | 100 nA, $T_A = -40^{\circ}C$ to $+105^{\circ}C$ |
| | | | 78 | | $T_A = -40$ °C to +125°C (LFCSP only) |
| Line Regulation | | 0.1 | | %/V | 10 μΑ/20 μΑ/50 μΑ/100 μΑ/150 μΑ/200 μΑ |
| | | 0.3 | | %/V | 100 nA |
| Load Regulation | | 0.1 | | %/V | 10 μΑ/20 μΑ/50 μΑ/100 μΑ/150 μΑ/200 μΑ |
| | | 2.5 | | %/V | 100 nA |
| Output Compliance | AV _{SS} + 0.05 | | $AV_{DD} - 0.27$ | V | 2% accuracy |
| BIAS VOLTAGE (V _{BIAS}) GENERATOR | | | | | Available on any analog input pin |
| V_{BIAS} | | $(AV_{DD} + AV_{SS})/2$ | | V | |
| Start-Up Time | | | | | Dependent on the capacitance connected to AINx |
| | | 3.7 | | μs/nF | $AV_{DD} = 3.3 \text{ V}, AV_{SS} = DGND$ |
| | | 6.7 | | μs/nF | AV_{DD} = 1.8 V, AV_{SS} = DGND |
| LOW-SIDE POWER SWITCH ² | | | | | |
| On Resistance (R _{ON}) | | 10 | 15 | Ω | |

analog.com Rev. A | 8 of 99

 $^{^{2}}$ T_A = -40°C to +105°C.

³ These specifications are not production tested but are supported by characterization data at the initial product release.

⁴ The REF_BUFP_n and REF_BUFM_n bits can be found in each CONFIG_n register. See the Reference Buffers section for more details.

SPECIFICATIONS

Table 4. Sensor Biasing Specifications (Continued)

| Parameter ¹ | Min | Тур | Max | Unit | Test Conditions/Comments |
|------------------------|-----|-----|-----|------|--------------------------|
| Allowable Current | | | 30 | mA | Continuous current |

¹ See the Terminology section.

DIAGNOSTICS SPECIFICATIONS

Table 5. Diagnostics Specifications

| Parameter ^{1, 2} | Min | Тур | Max | Unit | Test Conditions/Comments |
|--|-------------------------|-----------|------------------|------|------------------------------------|
| TEMPERATURE SENSOR | | | | | 2.5 V external reference, gain = 1 |
| Accuracy | | ±1 | | °C | After calibration at 25°C |
| Nominal Sensitivity ³ | | 860.66 | | μV/K | |
| Reading at 25°C | | 258 | | mV | |
| REFERENCE | | | | | REFIN = REFIN1(+) – REFIN1(-) |
| Reference Detect Threshold | 0.7 | | 1 | V | |
| REFIN1(+) Overvoltage Detect Level | AV _{DD} + 0.13 | | $AV_{DD} + 0.03$ | V | |
| REFIN1(-) Undervoltage Detect Level | AV _{SS} - 0.03 | | AV_{SS} - 0.13 | V | |
| A _{IN} OVERVOLTAGE (OV) AND UNDERVOLTAGE (UV) | | | | | |
| A _{IN} OV Detect Level | AV _{DD} + 0.13 | | $AV_{DD} + 0.03$ | V | |
| A _{IN} UV Detect Level | AV _{SS} - 0.03 | | AV_{SS} - 0.13 | V | |
| BURNOUT CURRENTS | | | | | |
| A _{IN} Current | | 0.5, 2, 4 | | μA | |

¹ See the Terminology section.

REJECTION SPECIFICATIONS

Table 6. Rejection Specifications

| Parameter ¹ | Min | Тур | Max | Unit | Test Conditions/Comments |
|--|-----|-----|-----|------|--|
| POWER SUPPLY REJECTION (AV _{DD}) | | | | | External MCLK, f _{MCLK} = 76.8 kHz, A _{IN} = 1 V/gain |
| | 96 | | | dB | Gain = 1, gain = 1 and PGA bypass ² , T _A = −40°C to +105°C |
| | 79 | | | dB | $T_A = -40$ °C to +125°C (LFCSP only) |
| | 94 | | | dB | Gain = 2 to 16, $T_A = -40^{\circ}$ C to +105°C |
| | 90 | | | dB | $T_A = -40$ °C to +125°C (LFCSP only) |
| | 102 | | | dB | Gain = 32 to 128, $T_A = -40^{\circ}\text{C}$ to +105°C |
| | 96 | | | dB | $T_A = -40$ °C to +125°C (LFCSP only) |
| COMMON-MODE REJECTION ^{3, 4, 5} | | | | | |
| At DC | 86 | 90 | | dB | $A_{IN} = 1 \text{ V, gain} = 1, T_A = -40^{\circ}\text{C to } +105^{\circ}\text{C}$ |
| | 85 | | | dB | $T_A = -40$ °C to +125°C (LFCSP only) |
| | 112 | 135 | | dB | A _{IN} = 1 V/gain, gain = 2 to 16 |
| | 108 | 122 | | dB | A _{IN} = 1 V/gain, gain = 32 to 128 |
| Sinc ³ Filter | | | | | Input frequency (f _{IN}) = notch frequency (f _{NOTCH}) ± 1 Hz |
| At 50 Hz and 60 Hz | 115 | | | dB | 10 SPS (FS = 240) |
| At 50 Hz | 115 | | | dB | 50 SPS (FS = 48) |
| At 60 Hz | 115 | | | dB | 60 SPS (FS = 40) |
| Sinc ³ + REJ60 Filter | | | | | f _{IN} = f _{NOTCH} ± 1 Hz |

analog.com Rev. A | 9 of 99

² These specifications are not production tested but are supported by characterization data at the initial product release.

 $^{^{3}}$ Matching between IOUT0 and IOUT1, $V_{OUT} = 0 \text{ V}$.

² These specifications are not production tested but are supported by characterization data at the initial product release.

³ Guaranteed by design.

SPECIFICATIONS

Table 6. Rejection Specifications (Continued)

| Parameter ¹ | Min | Тур | Max | Unit | Test Conditions/Comments |
|--|-----|-----|-----|-------|--|
| At 50 Hz and 60 Hz | 115 | | | dB | 50 SPS (FS = 48) |
| Sinc ³ + Sinc ¹ Averaging Filter | | | | | f _{IN} = f _{NOTCH} ± 1 Hz |
| At 50 Hz | 120 | | | dB | 40 SPS (FS = 6, first notch at 50 Hz) |
| At 60 Hz | 120 | | | dB | 48 SPS (FS = 5, first notch at 60 Hz) |
| Sinc ⁴ + Sinc ¹ Averaging Filter | | | | | f _{IN} = f _{NOTCH} ± 1 Hz |
| At 50 Hz | 115 | | | dB | 36.36 SPS (FS = 6, first notch at 60 Hz) |
| At 60 Hz | 115 | | | dB | 43.63 SPS (FS = 5, first notch at 50 Hz) |
| Post Filters | | | | | f _{IN} = f _{NOTCH} ± 1 Hz |
| At 50 Hz and 60 Hz | 125 | | | dB | Post Filter 1, ODR = 26.087 SPS |
| | 125 | | | dB | Post Filter 2, ODR = 24 SPS |
| | 125 | | | dB | Post Filter 3, ODR = 19.355 SPS |
| | 120 | | | dB | Post Filter 4, ODR = 16.21 SPS |
| NORMAL MODE REJECTION ^{3, 4} | | | | | |
| Sinc ³ Filter | | | | | f _{IN} = f _{NOTCH} ± 1 Hz |
| External Clock | | | | | IN INOICH - I II |
| At 50 Hz and 60 Hz | 100 | | | dB | 10 SPS (FS = 240) |
| 711 00 112 dild 00 112 | 65 | | | dB | 50 SPS (FS = 48), Sinc ³ + REJ60 filter |
| At 50 Hz | 95 | | | dB | 50 SPS (FS = 48) |
| At 60 Hz | 98 | | | dB | 60 SPS (FS = 40) |
| Internal Clock | 30 | | | ub ub | 00 01 0 (1 0 - 40) |
| At 50 Hz and 60 Hz | 84 | | | dB | 10 SPS (FS = 240) |
| At 30 Hz and 00 Hz | 58 | | | dB | 50 SPS (FS = 48), Sinc ³ + REJ60 filter |
| At 50 Hz | 79 | | | dB | 50 SPS (FS = 48) |
| At 60 Hz | 81 | | | dB | 60 SPS (FS = 40) |
| Averaging Filters | 01 | | | ub | $f_{IN} = f_{NOTCH} \pm 0.5 \text{ Hz}$ |
| External Clock | | | | | IN - NOTCH ± 0.3 MZ |
| At 50 Hz | 40 | | | dB | FS = 6 |
| At 60 Hz | 40 | | | dB | FS = 5 |
| Internal Clock | 42 | | | ub | 13-0 |
| At 50 Hz | 20 | | | 4D | |
| | 30 | | | dB | |
| At 60 Hz | 31 | | | dB | £ = £ 1.411= |
| Post Filters | | | | | $f_{IN} = f_{NOTCH} \pm 1 Hz$ |
| External Clock | 40 | | | l In | D 15'1 1 ODD 00 007 OD0 |
| At 50 Hz and 60 Hz | 46 | | | dB | Post Filter 1, ODR = 26.087 SPS |
| | 62 | | | dB | Post Filter 2, ODR = 24 SPS |
| | 86 | | | dB | Post Filter 3, ODR = 19.355 SPS |
| | 91 | | | dB | Post Filter 4, ODR = 16.21 SPS |
| Internal Clock | | | | | |
| At 50 Hz and 60 Hz | 40 | | | dB | Post Filter 1, ODR = 26.087 SPS |
| | 54 | | | dB | Post Filter 2, ODR = 24 SPS |
| | | 73 | | dB | Post Filter 3, ODR = 19.355 SPS |
| | 77 | | | dB | Post Filter 4, ODR = 16.21 SPS |

¹ See the Terminology section.

analog.com Rev. A | 10 of 99

² PGA_BYP_n = 1. The PGA_BYP_n bit can be found in each CONFIG_n register. See the Programmable Gain Amplifier section for more details.

³ These specifications are not production tested but are supported by characterization data at the initial product release.

 $^{^4\,\,}$ FS is the decimal equivalent of the FS, Bits[10:0] in the filter registers.

 $^{^{5}}$ When gain > 1, the common-mode voltage is between (AV_{SS} + 0.1 + 0.5/gain) and (AV_{DD} - 0.1 - 0.5/gain).

SPECIFICATIONS

LOGIC INPUT AND OUTPUT SPECIFICATIONS

Table 7. Logic Input and Output Specifications

| Parameter | Min | Тур | Max | Unit | Test Conditions/Comments |
|---|--------------------------|-----------------|-----------------------|------|--|
| LOGIC INPUTS ^{1, 2} | | | | | |
| Input Low Voltage (V _{INL}) | 0 | | $0.3 \times IOV_{DD}$ | V | $1.65 \text{ V} \le \text{IOV}_{DD} < 3.6 \text{ V}$ |
| Input High Voltage (V _{INH}) | 0.7 × IOV _{DD} | | IOV_DD | V | $1.65 \text{ V} \le \text{IOV}_{DD} < 3.6 \text{ V}$ |
| Voltage Hysteresis | | 0.5 | | V | $1.65 \text{ V} \le \text{IOV}_{DD} \le 3.6 \text{ V}$ |
| Current | -1 | | +1 | μA | Input voltage (V _{IN}) = IOV _{DD} or DGND |
| Pin Capacitance | | 10 | | pF | Per digital pin |
| LOGIC OUTPUTS ^{1, 2} (INCLUDING CLK) | | | | | |
| Output Low Voltage (V _{OL}) | 0 | | 0.4 | V | Sink current (I _{SINK}) = 100 μA |
| Output High Voltage (V _{OH}) | IOV _{DD} – 0.35 | | IOV_DD | V | Source current (I _{SOURCE}) = 100 μA |
| Floating State Leakage Current | -1 | | +1 | μA | |
| Floating State Output Capacitance | | 10 | | pF | |
| Data Output Coding ³ | | Offset binary | | | Bipolar bit = 0b1, default setting |
| | | Straight binary | | | Bipolar bit = 0b0 |
| CLOCK | | | | | |
| Internal Cock | | | | | |
| Frequency | 76.8 – 2% | 76.8 | 76.8 + 2% | kHz | |
| Duty Cycle ² | | 50:50 | | % | |
| Wake-Up Time ^{2, 4} | | 850 | | μs | |
| External Clock ² | | | | | |
| Frequency | | 76.8 | | kHz | |
| Duty Cycle | | 45:55 to 55:45 | | % | |
| DIGITAL OUTPUTS (P1 to P4) ⁵ | | | | | |
| Output Low Voltage (V _{OL}) ² | 0 | | 0.4 | V | I _{SINK} = 100 μA |
| Output High Voltage (V _{OH}) ² | AV _{DD} – 0.6 | | AV_DD | V | I _{SOURCE} = 100 μA |

¹ See the Pin Configuration and Function Descriptions section.

POWER SPECIFICATIONS

Table 8. Power Specifications

| Parameter | Min | Тур | Max | Unit | Test Conditions/Comments |
|---------------------------------------|------|-----|-----|------|------------------------------------|
| POWER SUPPLY VOLTAGE | | | | | |
| AV _{DD} to AV _{SS} | 1.71 | | 3.6 | V | |
| IOV _{DD} to DGND | 1.65 | | 3.6 | V | |
| AV _{SS} to DGND | -1.8 | | 0 | V | |
| AV _{DD} to DGND | 0.9 | | | V | |
| IOV _{DD} to AV _{SS} | | | 5.4 | V | |
| POWER SUPPLY CURRENTS ¹ | | | | | |
| AV _{DD} Current | | | | | Internal oscillator enabled |
| External Reference | | | | | |
| Gain = 1 | | 20 | 23 | μA | PGA bypass ² |
| | | | 24 | μA | T _{MAX} = 125°C |
| Gain = 1 to 16 | | 25 | 30 | μA | Continuous conversion mode current |

analog.com Rev. A | 11 of 99

² These specifications are not production tested but are supported by characterization data at the initial product release.

³ The bipolar bit can be found in the ADC_CONTROL register. See the Data Output Coding section for more details.

⁴ See also the Out of Standby Mode Timing section for further details.

⁵ General-purpose output pins used as digital pins require AV_{SS} = DGND and AV_{DD} = IOV_{DD}. See the General-Purpose Output section.

SPECIFICATIONS

Table 8. Power Specifications (Continued)

| Parameter | Min | Тур | Max | Unit | Test Conditions/Comments |
|---|-----|------|------|------|--|
| | | | 32 | μA | T _{MAX} = 125°C |
| | | 7.5 | | μA | DUTY_CYC_RATIO = 1/43 |
| | | 2.5 | | μA | DUTY_CYC_RATIO = 1/16 ³ |
| Gain = 32 to 128 | | 29 | 35 | μA | Continuous conversion mode current |
| | | | 38 | μA | T _{MAX} = 125°C |
| | | 8.5 | | μA | DUTY_CYC_RATIO = 1/4 ³ |
| | | 3 | | μA | DUTY_CYC_RATIO = 1/16 ³ |
| Increase due to Reference Buffer ^{4,} | | 0.25 | | μA | Per reference buffer |
| Increase due to Internal Reference ⁴ | | 6.5 | 8 | μA | Continuous conversion mode current |
| | | 1.75 | | μA | DUTY_CYC_RATIO = 1/4 ³ |
| | | 0.45 | | μA | DUTY_CYC_RATIO = 1/16 ³ |
| Increase due to V _{BIAS} on ⁴ | | 1 | 1.2 | μA | |
| IOV _{DD} Current | | 3.5 | 6.9 | μA | Continuous conversion mode current |
| | | | 12.5 | μA | T _{MAX} = 125°C |
| | | 1.8 | | μA | DUTY_CYC_RATIO = 1/4 ³ |
| | | 1.4 | | μA | DUTY_CYC_RATIO = 1/16 ³ |
| POWER-DOWN CURRENTS ¹ | | | | | |
| Standby Mode Current | | | | | |
| AV_DD | | 0.2 | 1.3 | μA | Analog low dropout (LDO) regulator on |
| | | | 2.5 | μA | T _{MAX} = 125°C |
| IOV_DD | | 0.35 | 3.5 | μA | Digital LDO regulator on |
| | | | 11 | μA | T _{MAX} = 125°C |
| Power-Down Mode Current | | | | | |
| AV_DD | | 0.01 | 1 | μA | Analog LDO regulator off |
| | | | 1.2 | μA | T _{MAX} = 125°C |
| IOV_DD | | 0.13 | 1 | μA | Digital LDO regulator off |
| OPERATING TEMPERATURE RANGE | | | | | |
| T _{MIN} | -40 | | | °C | |
| T _{MAX} | | | 105 | °C | Wafer level chip scale package (WLCSP) |
| | | | 125 | °C | Lead frame chip scale package (LFCSP) |

¹ The digital inputs are equal to IOV_{DD} or DGND with excitation currents disabled.

analog.com Rev. A | 12 of 99

² PGA_BYP_n = 1. The PGA_BYP_n bit can be found in each CONFIG_n register. See the Programmable Gain Amplifier section for more details.

Duty cycling mode is enabled by setting MODE = 0b1001 in the ADC_CONTROL register. The DUTY_CYC_RATIO bit can be found in the same register. See the Duty Cycling Mode and Duty Cycling Mode Timing sections.

⁴ These specifications are not production tested but are supported by characterization data at the initial product release.

SPECIFICATIONS

TIMING SPECIFICATIONS

 AV_{DD} = 1.71 V to 3.6 V, IOV_{DD} = 1.65 V to 3.6 V, AV_{SS} = DGND = 0 V, Input Logic 0 = DGND = 0 V, Input Logic 1 = IOV_{DD} , internal MCLK (f_{MCLK} = 76.8 kHz), temperature range = T_{MIN} to T_{MAX} , and decoupling as outlined in the Recommended Decoupling section, unless otherwise noted. All digital input signals are specified with rise time (t_R) = fall time (t_F) = 5 ns (10% to 90% of IOV_{DD} and timed from a voltage level of $IOV_{DD}/2$).

Table 9. Timing Specifications

| Parameter ¹ | Symbol | Min | Max | Unit |
|--|---|-------------------------|----------------------|------|
| REGISTER ACCESS IN 3-WIRE MODE ^{2, 3, 4} | | | | |
| SCLK Cycle Time | t _{SCK} | 200 | | ns |
| SCLK High Pulse Width | t _{SCKH} | 90 | | ns |
| SCLK Low Pulse Width | t _{SCKL} | 90 | | ns |
| DIN Data Setup Time | t _{DIN_SET} | 10 | | ns |
| DIN Data Hold Time | t _{DIN_HOL} | 10 | | ns |
| SCLK Falling Edge to DOUT Becomes Available | t _{DOUT VALID} | | 80 | ns |
| SCLK Falling Edge to DOUT Remains Available | t _{DOUT} HOL | 10 | | ns |
| SCLK Rising Edge to DOUT Disable Delay ⁵ | t _{DOUT_DIS_DEL} | | | |
| DOUT DIS DEL = 0 ⁶ | | 10 | | ns |
| DOUT_DIS_DEL = 16 | | 100 | | ns |
| Delay Between Consecutive Write Operations ⁷ (Last SCLK Rising to First SCLK Falling) | t _{WR_DEL} | 3/f _{MCLK} | 4/f _{MCLK} | sec |
| Data Ready ⁸ High Time if Data Ready is Low and the Next Conversion is Available | t _{RDYH} | 4/f _{MCLK} | | sec |
| Last SCLK Rising for SW Reset Serial Peripheral Interface (SPI) Transaction to First SCLK Falling for Next SPI Transaction | t _{RESET_DELAY} T _A = −10°C to | 1920/f _{MCLK} | | sec |
| | T _{MAX} | 44550/5 | | |
| DEGIOTED ACCESS IN A MIDE MODE? 3.0 | | 11550/f _{MCLK} | | |
| REGISTER ACCESS IN 4-WIRE MODE ^{2, 3, 9} | | | | |
| CS Falling Edge to DOUT Enable Time ¹⁰ | t _{DOUT_EN} | | 80 | ns |
| CS Setup Time: CS Falling Edge to First SCLK Falling Edge | t _{CS_SET} | 0 | | ns |
| CS Hold Time: Last SCK Rising Edge to CS Rising Edge Delay | t _{CS_HOL} | 0 | | ns |
| CS Rising Edge to DOUT Disable Time ¹⁰ | t _{DOUT_DIS} | | 80 | ns |
| CS High Pulse Width (Between Read/Write Operations) | t _{CS_PW} | 20 | | ns |
| CS Rising Edge for SW Reset SPI Transaction to CS Falling Edge for Next SPI Transaction | t_{RESET_DELAY} $T_A = -10^{\circ}C$ to | 1920/f _{MCLK} | | sec |
| | T _{MAX} | | | |
| | | 11550/f _{MCLK} | | |
| CONTINUOUS READ MODE ¹¹ | | | | |
| Data Ready ⁸ Falling Edge to First SCLK Falling Edge | t _{RDYL_SCKL} | 20 | | ns |
| SCLK Falling Edge to New DOUT Becomes Available | t _{DOUT_VALID} | | 80 | ns |
| SYNCHRONIZATION MODE ¹² | | | | |
| SYNC Low Pulse Width | t _{SYNC_PW} | 4/f _{MCLK} | | sec |
| STANDBY MODE | | | | |
| Wake-Up Time from SPI Write to Exit Standby Mode ¹³ | t _{WU_STBY} | | 36/f _{MCLK} | sec |
| DUTY CYCLING | | | | |
| Wake Up Time | t _{WU_DUTY} | | 32/f _{MCLK} | sec |

¹ These specifications are not production tested but are supported by characterization data at the initial product release.

analog.com Rev. A | 13 of 99

² The device operates with SPI Mode 3: SCLK idles high, the falling edge of SCLK is the drive edge for DOUT, and the rising edge of SCLK is the sample edge for DIN.

³ CSB_EN = 0b0 (default) in the ADC_CONTROL register (3-wire mode). Change this bit to 1 to enable 4-wire mode.

⁴ See the 3-Wire Mode Timing Diagrams section.

⁵ CS pin held low.

SPECIFICATIONS

- 6 This bit can be found in the ADC_CONTROL register and it is only active if CSB_EN = 0b0 in the same register.
- Applies only when SYNC is high, or MM_CRC_ERR_EN = 0b1 and only for ADC_CONTROL and error register writes.
- For the data ready signal related timing specifications, the INT pin is considered (INT PIN SEL = 0b00 in the IO CONTROL register). See the Data Ready Signal section.
- ⁹ See the 4-Wire Mode Timing Diagrams section.
- 10 In 4-wire mode (CSB_EN = 0b1), the DOUT pin changes from tristate (CS pin high) to enabled after the CS falling edge, then changes back to tristate following the CS rising edge. In 3-wire mode, CS pin can still be used to enable (CS pin low) and disable (CS pin high) the DOUT pin.
- 11 Set CONT_READ = 0b1 in the ADC_CONTROL register to enable continuous read mode. See the Continuous Read Mode Timing Diagram and Continuous Read Mode sections for details.
- ¹² See the System Synchronization section.
- 13 Internal oscillator is kept alive. See the internal clock wake-up time specification in Table 7 and the Out of Standby Mode Timing section for further details.

3-Wire Mode Timing Diagrams

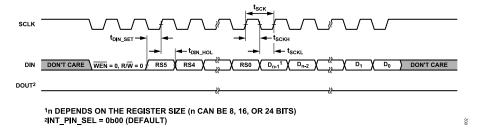


Figure 2. Write Cycle Timing Diagram, 3-Wire Mode (CSB_EN Bit Set to 0), CS Pin Tied Low

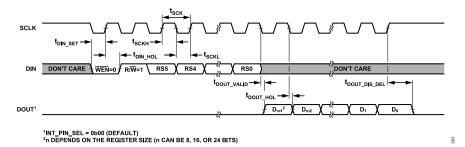


Figure 3. Read Cycle Timing Diagram, 3-Wire Mode (CSB EN Bit Set to 0), CS Pin Tied Low

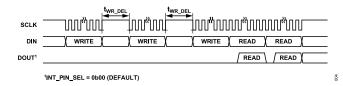


Figure 4. Delay Between Consecutive Serial Operations, 3-Wire Mode (CSB_EN Bit Set to 0), CS Pin Tied Low

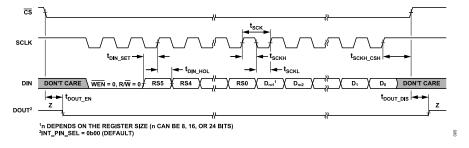


Figure 5. Write Cycle Timing Diagram, 3-Wire Mode (CSB_EN Bit Set to 0), CS Pin Used to Tristate the DOUT Pin

analog.com Rev. A | 14 of 99

SPECIFICATIONS

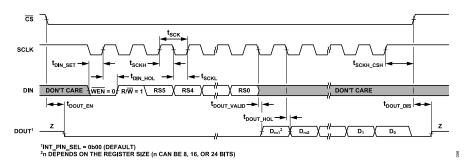


Figure 6. 3-Wire Mode Read Cycle Timing Diagram, 3-Wire Mode (CSB_EN Bit Set to 0), CS Pin Used to Tristate the DOUT Pin

4-Wire Mode Timing Diagrams

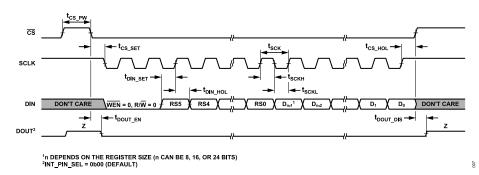


Figure 7. Write Cycle Timing Diagram, 4-Wire Mode (CSB EN Bit Set to 1)

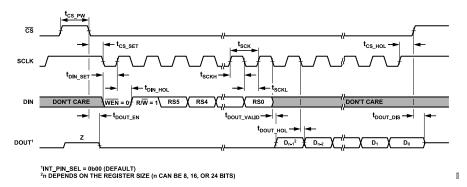


Figure 8. Read Cycle Timing Diagram, 4-Wire Mode (CSB EN Bit Set to 1)

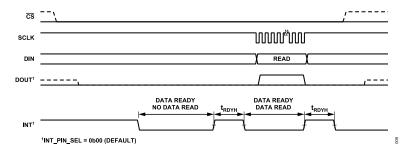


Figure 9. Data Ready High Time when Data Ready is Initially Low and the Next Conversion is Available

analog.com Rev. A | 15 of 99

SPECIFICATIONS

Continuous Read Mode Timing Diagram

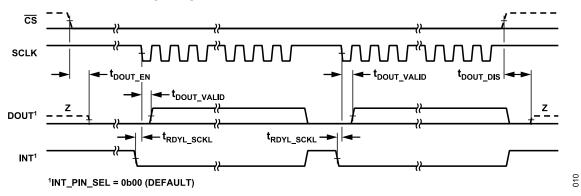


Figure 10. Continuous Read Mode Timing

analog.com Rev. A | 16 of 99

ABSOLUTE MAXIMUM RATINGS

 $T_A = 25$ °C, unless otherwise noted.

Table 10. Absolute Maximum Ratings

| Parameter | Rating |
|--|-------------------------------------|
| AV _{DD} to AV _{SS} | -0.3 V to +3.96 V |
| IOV _{DD} to DGND | -0.3 V to +3.96 V |
| IOV _{DD} to AV _{SS} | -0.3 V to +5.94 V |
| AV _{SS} to DGND | -1.98 V to +0.3 V |
| AINx to AV _{SS} | -0.3 V to AV _{DD} + 0.3 V |
| REFIN1(+), REFIN1(-) to AV _{SS} | -0.3 V to AV _{DD} + 0.3 V |
| Digital Inputs ¹ to DGND | -0.3 V to IOV _{DD} + 0.3 V |
| Digital Outputs ¹ to DGND | -0.3 V to IOV _{DD} + 0.3 V |
| AINx/Digital Input Current | 10 mA |
| Storage Temperature Range | -65°C to +150°C |
| Junction Temperature (T _J) | 150°C |
| Lead Temperature, Soldering Reflow | 260°C, as per JEDEC J-STD-020 |

See the Pin Configuration and Function Descriptions section for a list of the digital input and digital output pins.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

Absolute maximum ratings are tested individually only, not in combination, and they all apply for any given configuration.

THERMAL CHARACTERISTICS

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Careful attention to PCB thermal design is required.

Thermal resistance values specified in Table 11 were calculated based on JEDEC specifications and must be used in compliance with JESD51-12.

Table 11. Thermal Resistance

| Package Type ¹ | θ_{JA} | θ_{JB} | $\theta_{\text{JC_TOP}}$ | Ψ_{JB} | Ψ_{JT} | Unit |
|---------------------------|---------------|---------------|---------------------------|------------------|------------------|------|
| CB-35-3 | 46.2 | 11 | 0.32 | 4.4 | 0.2 | °C/W |
| CP-32-29 | 40.7 | 12.1 | 16 | N/A ² | N/A ² | °C/W |

The values in Table 11 were calculated based on the standard JEDEC 2S2P thermal test board with 6 × 11 thermal vias. See the JEDEC JESD51 series.

 $\theta_{JA},~\theta_{JB},~\text{and}~\theta_{JC}$ are mainly used to compare the thermal performance of the package of the device with other semiconductor packages when all test conditions listed are similar. $\theta_{JA},~\theta_{JB},~\text{and}~\theta_{JC}$ can be used for first order approximation of the junction temperature in the system environment.

For WLCSP devices, using Ψ_{JB} or Ψ_{JT} is a more appropriate way to estimate the worst-case junction temperature of the device in

the system environment if an accurate thermal measurement of the board temperature near the device under test (DUT) or directly on the package top surface operating in the system environment is available.

Using the parameters listed in Table 11 in accordance with JEDEC standards in the JESD51 series is recommended.

The AD4131-8 can be damaged when T_J limits are exceeded. See Table 10 for the absolute maximum junction temperature specification. Monitoring the ambient temperature does not guarantee that T_J is within the specified maximum temperature limits. In applications with high power dissipation and/or poor thermal resistance, T_J must be monitored using the internal temperature sensor.

ELECTROSTATIC DISCHARGE (ESD) RATINGS

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

Human body model (HBM) per ANSI/ESDA/JEDEC JS-001.

Field induced charged device model (FICDM) per ANSI/ESDA/JE-DEC JS-002.

Machine model (MM) per ANSI/ESD STM5.2. MM voltage values are for characterization only.

ESD Ratings for AD4131-8

Table 12. AD4131-8, 35-Ball WLCSP

| ESD Model | Withstand Threshold (V) | Class |
|-----------|-------------------------|-------|
| HBM | 4000 | 3A |
| FICDM | 500 | C2a |
| MM | 400 | C |

Table 13. AD4131-8, 32-Lead LFCSP

| ESD Model | Withstand Threshold (V) | Class |
|-----------|-------------------------|-------|
| НВМ | 4000 | 3A |
| FICDM | 1000 | C3 |
| MM | 400 | C |

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

analog.com Rev. A | 17 of 99

² N/A means not applicable.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

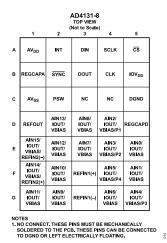


Figure 11. WLCSP Pin Configuration

Table 14, WI CSP Pin Function Description

| Pin No. | LCSP Pin Function Descripti Mnemonic | Type ¹ | Description |
|---------|--------------------------------------|-------------------|---|
| A1 | AV _{DD} | S | Analog Supply Voltage, Relative to AV _{SS} . See the Power Supplies section. |
| A2 | INT | DO | Interrupt Pin. The INT pin functions as a data ready signal. See the Data Ready Signal section. |
| A3 | DIN | DI | Serial Data Logic Input. Data on the DIN pin is transferred to the control registers within the ADC, with the register selection bits (RS, Bits[5:0]) of the COMMS register identifying the appropriate register. See the Digital Interface section. |
| A4 | SCLK | DI | Serial Clock Logic Input. This serial clock input is for data transfers to and from the ADC. The serial clock can be continuous with all data transmitted in a continuous train of pulses. Alternatively, SCLK can be a gated clock with the information transmitting to or from the ADC in smaller batches of data. See the Digital Interface section. |
| A5 | CS | DI | Chip Select Active Low Logic Input. Use \overline{CS} to select the ADC in systems with more than one device on the serial bus or as a frame synchronization signal in communicating with the device. \overline{CS} can be hardwired low if the SPI diagnostics are unused, allowing the ADC to operate in 3-wire mode with SCLK, DIN, and DOUT interfacing with the device. See the Digital Interface section. |
| B1 | REGCAPA | S | Analog LDO Regulator Output. Decouple the REGCAPA pin to AV _{SS} with a 0.1 µF capacitor. It is not recommended to connect any additional load to the REGCAPA pin. See the Internal LDOs section. |
| B2 | SYNC | DI | Synchronization Logic Input. The SYNC pin is a logic input that allows synchronization of the digital filters and analog modulators when using multiple AD4131-8 devices. See the System Synchronization section. |
| B3 | DOUT (WLCSP) | DO | Serial Data Logic Output. The DOUT pin functions as a serial data output pin to readback the content of any register with read access. See the Digital Interface section. |
| B4 | CLK | DI/O | Clock Input and Clock Logic Output. The internal clock can be made available at this pin. Alternatively, the internal clock can be disabled, and the ADC can be driven by an external clock. See the ADC Main Clock section. |
| B5 | IOV _{DD} | S | Serial Interface Supply Voltage, 1.65 V to 3.6 V. See the Power Supplies section. |
| C1 | AV _{SS} | S | Analog Supply Voltage Reference. The voltage on AV_{DD} is referenced to AV_{SS} . AV_{SS} is either tied to DGND or it can be taken below 0 V to provide a dual power supply to the AD4131-8. The minimum AV_{SS} is -1.8 V and the differential between AV_{DD} and AV_{SS} must be between 1.71 V and 3.6 V. See the Power Supplies section. |
| C2 | PSW | Al | Low-Side Power Switch to AV _{SS} . See the Power-Down Switch section. |
| C3, C4 | NC | N/A ² | No Connect. These pins must be mechanically soldered to the PCB. These pins can be connected to DGND or left electrically floating. |
| C5 | DGND | S | Digital/Common Ground Reference Point. See the Power Supplies section. |
| D1 | REFOUT | AO | Internal Reference Output. The buffered output of the internal voltage reference is available on the REFOUT pin. A 1 nF capacitor is required on the REFOUT pin when the internal reference is active. See the ADC Reference section. |
| D2 | AIN13/IOUT/VBIAS | AI/O | Analog Input 13 (AIN13) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be mad available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |

analog.com Rev. A | 18 of 99

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Table 14. WLCSP Pin Function Descriptions (Continued)

| Pin No. | Mnemonic | Type ¹ | Description |
|---------|---------------------------------|-------------------|--|
| D3 | AIN8/IOUT/VBIAS | AI/O | Analog Input 8 (AIN8) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be mad available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| D4 | AIN2/IOUT/VBIAS/P1 | AI/O | Analog Input 2 (AIN2) (Default)/Output of Internal Excitation Current Source/Bias Voltage/General Purpose Output 1. Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be mad available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. General-Purpose Output 1 (P1). The P1 pin can be used as a general-purpose output, referenced between AV _{SS} and |
| D5 | REGCAPD | s | AV _{DD} . When AV _{SS} is tied to DGND and IOV _{DD} is tied to AV _{DD} , the P1 pin can operate like a digital output. Digital LDO Regulator Output. Decouple the REGCAPD pin to DGND with a 0.1 μF capacitor. It is not recommended to |
| 50 | TREGOTAL D | | connect any additional load to the REGCAPD pin. See the Internal LDOs section. |
| E1 | AIN15/IOUT/ VBIAS/ REFIN2(-) | AI/O | Analog Input 15 (AIN15) (Default)/Output of Internal Excitation Current Source/Bias Voltage/Negative Reference Input |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be mad available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| | | | Negative Reference Input (REFIN2($-$)). The REFIN2($-$) pin can be anywhere between AV _{SS} and AV _{DD} $-$ 0.5 V. |
| Ξ2 | 2 AIN12/IOUT/VBIAS AI/O | AI/O | Analog Input 12 (AIN12) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be mad available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| E3 | AIN7/IOUT/VBIAS | AI/O | Analog Input 7 (AIN7) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be mad available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| E4 | AIN3/IOUT/VBIAS/P2 | AI/O | Analog Input 3 (AIN3) (Default)/Output of Internal Excitation Current Source/Bias Voltage/General Purpose Output 2. Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be mad available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| | | | General-Purpose Output 2 (P2). The P2 pin can be used as a general-purpose output, referenced between AV_{SS} and AV_{DD} . When AV_{SS} is tied to DGND and IOV_{DD} is tied to AV_{DD} , the P2 pin can operate like a digital output. |
| E5 | AIN0/IOUT/VBIAS | AI/O | Analog Input 0 (AIN0) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be mad available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| F1 | AIN14/IOUT/ VBIAS/ REFIN2(+) | AI/O | Analog Input 14 (AIN14) (Default)/Output of Internal Excitation Current Source/Bias Voltage/Positive Reference Input. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be mad available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| | | | Positive Reference Input (REFIN2(+)). An external reference can be applied between REFIN2(+) and REFIN2(-). REFIN2(+) can be anywhere between AV _{DD} and AV _{SS} + 0.5 V. The nominal reference voltage (REFIN2(+) to REFIN2(-)) is 2.5 V, but the device functions with a reference from 0.5 V to AV _{DD} . |

analog.com Rev. A | 19 of 99

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Table 14. WLCSP Pin Function Descriptions (Continued)

| Pin No. | Mnemonic | Type ¹ | Description |
|---------|--------------------|---|--|
| F2 | AIN10/IOUT/VBIAS | AI/O | Analog Input 10 (AIN10) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| F3 | REFIN1(+) | Al | Positive Reference Input. An external reference can be applied between REFIN1(+) and REFIN1(-). The REFIN1(+) pin can be anywhere between AV _{DD} and AV _{SS} + 0.5 V. The device functions with a reference from 0.5 V to AV _{DD} . See the ADC Reference section. |
| F4 | AIN5/IOUT/VBIAS/P4 | AI/O | Analog Input 5 (AIN5) (Default)/Output of Internal Excitation Current Source/Bias Voltage/General-Purpose Output 4. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| | | | General-Purpose Output 4 (P4). The P4 pin can be used as a general-purpose output, referenced between AV_{SS} and AV_{DD} . When AV_{SS} is tied to DGND and IOV_{DD} is tied to AV_{DD} , the P4 pin can operate like a digital output. |
| F5 | AIN1/IOUT/VBIAS | AI/O | Analog Input 1 (AIN1) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. | |
| | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS | |
| • | | | pin. |
| G1 | AIN11/IOUT/VBIAS | AI/O | Analog Input 11 (AIN11) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| G2 | AIN9/IOUT/VBIAS | AI/O | Analog Input 9 (AIN9) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| G3 | REFIN1(-) | Al | Negative Reference Input. The REFIN1(-) pin can be anywhere between AV _{SS} and AV _{DD} - 0.5 V. See the ADC Reference section. |
| G4 | AIN6/IOUT/VBIAS | AI/O | Analog Input 6 (AIN6) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| G5 | AIN4/IOUT/VBIAS/P3 | AI/O | Analog Input 4 (AIN4) (Default)/Output of Internal Excitation Current Source/Bias Voltage/General Purpose Output 3. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| | | | General-Purpose Output 3 (P3). The P3 pin can be used as a general-purpose output, referenced between AV_{SS} and AV_{DD} . When AV_{SS} is tied to DGND and IOV_{DD} is tied to AV_{DD} , the P3 pin can operate like a digital output. |

AO is analog output, S is supply, AI is analog input, AI/O is analog input or output, DI is digital input, DO is digital output, and DI/O is digital input or output.

analog.com Rev. A | 20 of 99

² N/A means not applicable.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

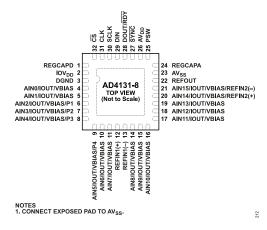


Figure 12. LFCSP Pin Configuration

Table 15. LFCSP Pin Function Descriptions

| Pin No. | Mnemonic | Type ¹ | Description |
|---------|--------------------|-------------------|--|
| 1 | REGCAPD | S | Digital LDO Regulator Output. Decouple the REGCAPD pin to DGND with a 0.1 µF capacitor. It is not recommended to connect any additional load to the REGCAPD pin. See the Internal LDOs section. |
| 2 | IOV _{DD} | S | Serial Interface Supply Voltage, 1.65 V to 3.6 V. See the Power Supplies section. |
| 3 | DGND | S | Digital/Common Ground Reference Point. See the Power Supplies section. |
| 4 | AIN0/IOUT/VBIAS | AI/O | Analog Input 0 (AIN0) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| 5 | AIN1/IOUT/VBIAS | AI/O | Analog Input 1 (AIN1) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| 3 | AIN2/IOUT/VBIAS/P1 | AI/O | Analog Input 2 (AIN2) (Default)/Output of Internal Excitation Current Source/Bias Voltage/General Purpose Output 1. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| | | | General-Purpose Output 1 (P1). The P1 pin can be used as a general-purpose output, referenced between AV_{SS} and AV_{DD} . When AV_{SS} is tied to DGND and IOV_{DD} is tied to AV_{DD} , the P1 pin can operate like a digital output. |
| 7 | AIN3/IOUT/VBIAS/P2 | AI/O | Analog Input 3 (AIN3) (Default)/Output of Internal Excitation Current Source/Bias Voltage/General Purpose Output 2. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| | | | General-Purpose Output 2 (P2). The P2 pin can be used as a general-purpose output, referenced between AV_{SS} and AV_{DD} . When AV_{SS} is tied to DGND and IOV_{DD} is tied to AV_{DD} , the P2 pin can operate like a digital output. |
| 3 | AIN4/IOUT/VBIAS/P3 | AI/O | Analog Input 4 (AIN4) (Default)/Output of Internal Excitation Current Source/Bias Voltage/General Purpose Output 3. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| | | | General-Purpose Output 3 (P3). The P3 pin can be used as a general-purpose output, referenced between AV_{SS} and AV_{DD} . When AV_{SS} is tied to DGND and IOV_{DD} is tied to AV_{DD} , the P3 pin can operate like a digital output. |

analog.com Rev. A | 21 of 99

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Table 15. LFCSP Pin Function Descriptions (Continued)

| Pin No. | Mnemonic | Type ¹ | Description |
|---------|--------------------|-------------------|---|
| 9 | AIN5/IOUT/VBIAS/P4 | AI/O | Analog Input 5 (AIN5) (Default)/Output of Internal Excitation Current Source/Bias Voltage/General-Purpose Output 4. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| | | | General-Purpose Output 4 (P4). The P4 pin can be used as a general-purpose output, referenced between AV_{SS} and AV_{DD} . When AV_{SS} is tied to DGND and IOV_{DD} is tied to AV_{DD} , the P4 pin can operate like a digital output. |
| 10 | AIN6/IOUT/VBIAS | AI/O | Analog Input 6 (AIN6) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| 11 | AIN7/IOUT/VBIAS | AI/O | Analog Input 7 (AIN7) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| 12 | REFIN1(+) | Al | Positive Reference Input. An external reference can be applied between REFIN1(+) and REFIN1(-). The REFIN1(+) pin can be anywhere between AV_{DD} and AV_{SS} + 0.5 V. The device functions with a reference from 0.5 V to AV_{DD} . See the ADC Reference section. |
| 13 | REFIN1(-) | Al | Negative Reference Input. The REFIN1(-) pin can be anywhere between AV _{SS} and AV _{DD} - 0.5 V. See the ADC Reference section. |
| 14 | AIN8/IOUT/VBIAS | AI/O | Analog Input 8 (AIN8) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| 15 | AIN9/IOUT/VBIAS | AI/O | Analog Input 9 (AIN9) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| 16 | AIN10/IOUT/VBIAS | AI/O | Analog Input 10 (AIN10) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| 17 | AIN11/IOUT/VBIAS | AI/O | Analog Input 11 (AIN11) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| 18 | AIN12/IOUT/VBIAS | AI/O | Analog Input 12 (AIN12) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| 19 | AIN13/IOUT/VBIAS | AI/O | Analog Input 13 (AIN13) (Default)/Output of Internal Excitation Current Source/Bias Voltage. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |

analog.com Rev. A | 22 of 99

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Table 15. LFCSP Pin Function Descriptions (Continued)

| Pin No. | Mnemonic | Type ¹ | Description |
|---------|---------------------------------|-------------------|--|
| 20 | AIN14/IOUT/ VBIAS/ REFIN2(+) | AI/O | Analog Input 14 (AIN14) (Default)/Output of Internal Excitation Current Source/Bias Voltage/Positive Reference Input. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| | | | Positive Reference Input (REFIN2(+)). An external reference can be applied between REFIN2(+) and REFIN2(-). REFIN2(+) can be anywhere between AV _{DD} and AV _{SS} + 0.5 V. The nominal reference voltage (REFIN2(+) to REFIN2(-)) is 2.5 V, but the device functions with a reference from 0.5 V to AV _{DD} . |
| 21 | AIN15/IOUT/ VBIAS/ REFIN2(-) | AI/O | Analog Input 15 (AIN15) (Default)/Output of Internal Excitation Current Source/Bias Voltage/Negative Reference Input. |
| | | | Output of Internal Excitation Current Source (IOUT). The internal programmable excitation current source can be made available at the IOUT pin. Either IOUT1 or IOUT0 can be switched to this output. |
| | | | Bias Voltage (VBIAS). A bias voltage midway between the analog power supply rails can be generated at the VBIAS pin. |
| | | | Negative Reference Input (REFIN2(-)). The REFIN2(-) pin can be anywhere between AV _{SS} and AV _{DD} – 0.5 V. |
| 22 | REFOUT | AO | Internal Reference Output. The buffered output of the internal voltage reference is available on the REFOUT pin. A 1 nF capacitor is required on the REFOUT pin when the internal reference is active. See the ADC Reference section. |
| 23 | AV _{SS} | S | Analog Supply Voltage Reference. The voltage on AV_{DD} is referenced to AV_{SS} . AV_{SS} is either tied to DGND or it can be taken below 0 V to provide a dual power supply to the AD4131-8. The minimum AV_{SS} is -1.8 V and the differential between AV_{DD} and AV_{SS} must be between 1.71 V and 3.6 V. See the Power Supplies section. |
| 24 | REGCAPA | S | Analog LDO Regulator Output. Decouple the REGCAPA pin to AV _{SS} with a 0.1 µF capacitor. It is not recommended to connect any additional load to the REGCAPA pin. See the Internal LDOs section. |
| 25 | PSW | Al | Low-Side Power Switch to AV _{SS} . See the Power-Down Switch section. |
| 26 | AV _{DD} | S | Analog Supply Voltage, Relative to AV _{SS} . See the Power Supplies section. |
| 27 | SYNC | DI | Synchronization Logic Input. The SYNC pin is a logic input that allows synchronization of the digital filters and analog modulators when using multiple AD4131-8 devices. See the System Synchronization section. |
| 28 | DOUT/RDY (LFCSP) | DO | Serial Data Logic Output. The DOUT/RDY pin functions as a serial data output pin to readback the content of any register with read access. See the Digital Interface section. |
| 29 | DIN | DI | Serial Data Logic Input. Data on the DIN pin is transferred to the control registers within the ADC, with the register selection bits (RS, Bits[5:0]) of the COMMS register identifying the appropriate register. See the Digital Interface section. |
| 30 | SCLK | DI | Serial Clock Logic Input. This serial clock input is for data transfers to and from the ADC. The serial clock can be continuous with all data transmitted in a continuous train of pulses. Alternatively, SCLK can be a gated clock with the information transmitting to or from the ADC in smaller batches of data. See the Digital Interface section. |
| 31 | CLK | DI/O | Clock Input and Clock Logic Output. The internal clock can be made available at this pin. Alternatively, the internal clock can be disabled, and the ADC can be driven by an external clock. See the ADC Main Clock section. |
| 32 | CS | DI | Chip Select Active Low Logic Input. Use $\overline{\text{CS}}$ to select the ADC in systems with more than one device on the serial bus, or as a frame synchronization signal in communicating with the device. $\overline{\text{CS}}$ can be hardwired low if the SPI diagnostics are unused, allowing the ADC to operate in 3-wire mode with SCLK, DIN, and DOUT interfacing with the device. See the Digital Interface section. |

AO is analog output, S is supply, Al is analog input, Al/O is analog input or output, DI is digital input, DO is digital output, and DI/O is digital input or output.

analog.com Rev. A | 23 of 99

TYPICAL PERFORMANCE CHARACTERISTICS

 $AV_{DD} = 3.3 \text{ V}$, $IOV_{DD} = 1.8 \text{ V}$, $AV_{SS} = DGND = 0 \text{ V}$, $V_{REF} = 2.5 \text{ V}$ (internal), internal MCLK, $T_A = 25^{\circ}\text{C}$, sinc^3 filter, FS = 48, gain = 1, PGA enabled, reference buffers bypassed, and decoupling, as outlined in the Recommended Decoupling section, unless otherwise noted.

OFFSET ERROR AND GAIN ERROR

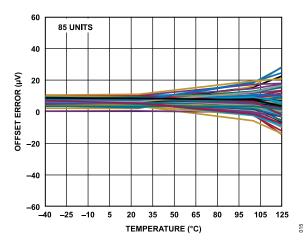


Figure 13. Offset Error vs. Temperature (Gain = 1, Before Calibration)

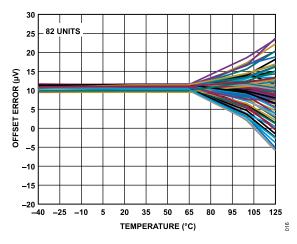


Figure 14. Offset Error vs. Temperature (Gain = 8, Before Calibration)

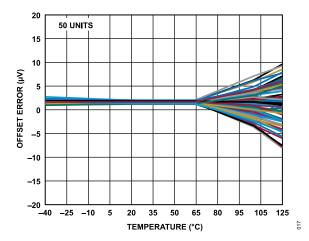


Figure 15. Offset Error vs. Temperature (Gain = 32, Before Calibration)

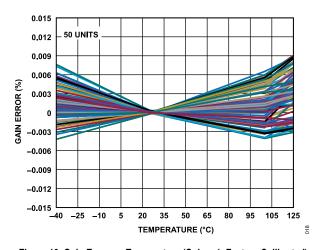


Figure 16. Gain Error vs. Temperature (Gain = 1, Factory Calibrated)

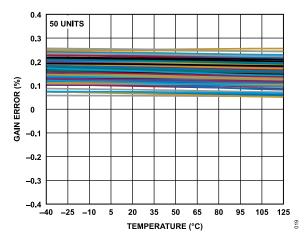


Figure 17. Gain Error vs. Temperature (Gain = 8, Before Calibration)

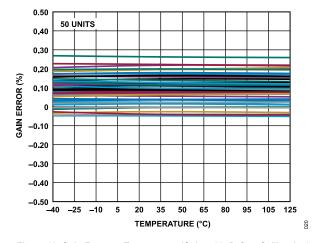


Figure 18. Gain Error vs. Temperature (Gain = 32, Before Calibration)

analog.com Rev. A | 24 of 99

TYPICAL PERFORMANCE CHARACTERISTICS

INL ERROR AND OSCILLATOR

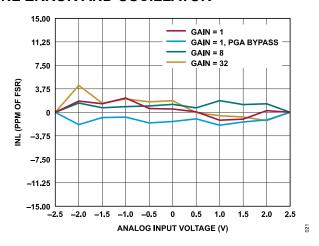


Figure 19. INL Error vs. Differential Input Amplitude for Various Gains (Sinc³ Filter, ODR = 50 SPS, Internal 2.5 V Reference)

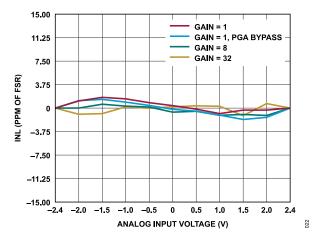


Figure 20. INL Error vs. Differential Input Amplitude for Various Gains (Sinc³ Filter, ODR = 50 SPS, External 2.5 V Reference)

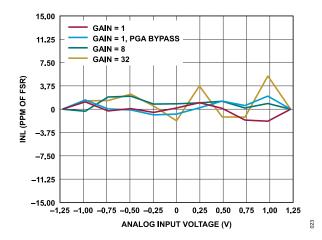


Figure 21. INL Error vs. Differential Input Amplitude for Various Gains (Sinc³ Filter, ODR = 50 SPS, AV_{DD} = 1.8 V, Internal 1.25 V Reference)

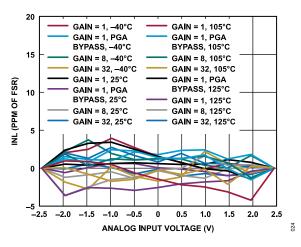


Figure 22. INL Error vs. Differential Input Amplitude for Various Gains and Temperatures (Sinc³ Filter, ODR = 50 SPS, Internal 2.5 V Reference)

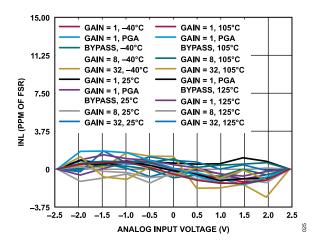


Figure 23. INL Error vs. Differential Input Amplitude for Various Gains and Temperatures (Sinc³ Filter, ODR = 50 SPS, External 2.5 V Reference)

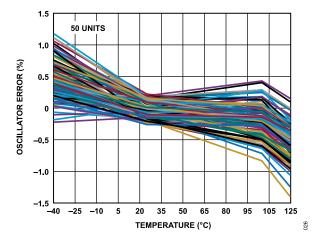


Figure 24. Internal Oscillator Error vs. Temperature

analog.com Rev. A | 25 of 99

TYPICAL PERFORMANCE CHARACTERISTICS

NOISE

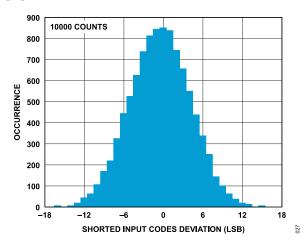


Figure 25. Noise Histogram Plot (Sinc³ Filter, ODR = 50 SPS, Gain = 1)

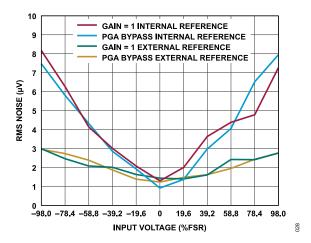


Figure 26. RMS Noise vs. Analog Input Voltage (Sinc³ Filter, ODR = 50 SPS, Gain = 1 and Gain = 1 with PGA Bypass, 2.5 V Reference)

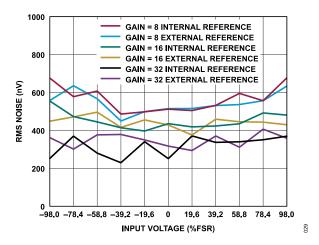


Figure 27. RMS Noise vs. Analog Input Voltage (Sinc³ Filter, ODR = 50 SPS, Gain = 8, Gain = 16 and Gain = 32, 1.25 V Reference)

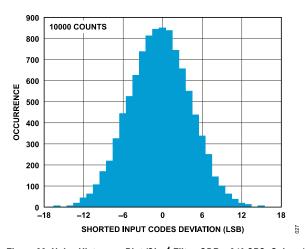


Figure 28. Noise Histogram Plot (Sinc⁴ Filter, ODR = 240 SPS, Gain = 1, Internal 1.25 V Reference)

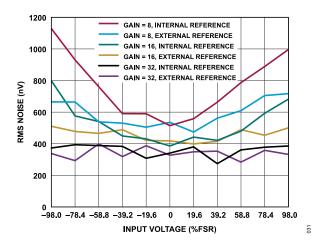


Figure 29. RMS Noise vs. Analog Input Voltage (Sinc³ Filter, ODR = 50 SPS, Gain = 8, Gain = 16 and Gain = 32, 2.5 V Reference)

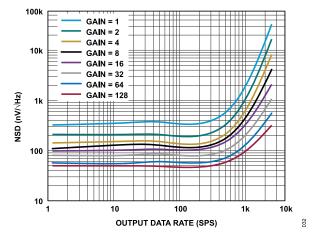


Figure 30. NSD vs. Output Data Rate for Various Gains (Sinc³ Filter, External 2.5 V Reference)

analog.com Rev. A | 26 of 99

TYPICAL PERFORMANCE CHARACTERISTICS

ANALOG INPUT CURRENTS

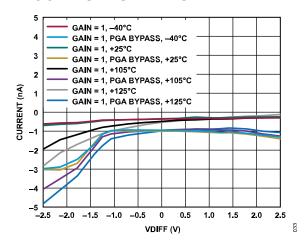


Figure 31. Absolute AINP Current vs. Differential AIN Voltage (VDIFF) for Various Temperatures (Gain = 1, VCM = $AV_{DD}/2$)

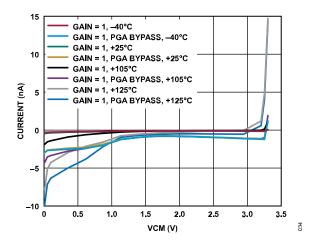


Figure 32. Absolute AINP Current vs. AIN Common-Mode Voltage (VCM) for Various Temperatures (Gain = 1, VDIFF = 0 V)

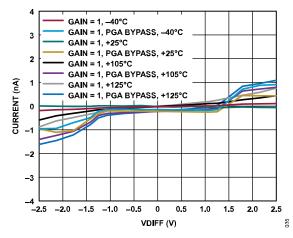


Figure 33. Differential AIN Current vs. VDIFF for Various Temperatures (Gain = 1, VCM = $AV_{DD}/2$)

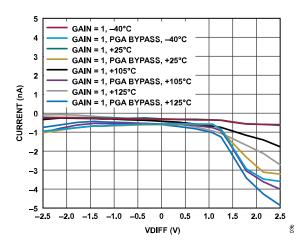


Figure 34. Absolute AINM Current vs. VDIFF for Various Temperatures (Gain = 1, VCM = $AV_{DD}/2$)

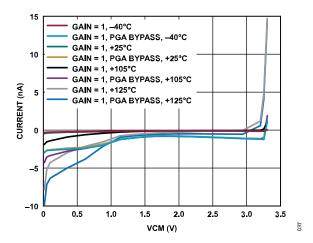


Figure 35. Absolute AINM Current vs. VCM for Various Temperatures (Gain = 1, VDIFF = 0 V)

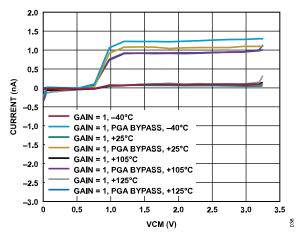


Figure 36. Differential AIN Current vs. VCM for Various Temperatures (Gain = 1, VCM = $AV_{DD}/2$)

analog.com Rev. A | 27 of 99

TYPICAL PERFORMANCE CHARACTERISTICS

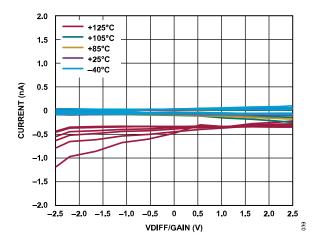


Figure 37. Absolute AINP Current vs. Normalized Differential AIN Voltage (VDIFF/Gain) for Various Temperatures (Gain = 2 to 128, VCM = AV_{DD}/2)

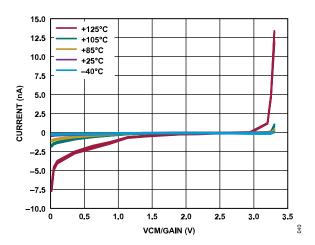


Figure 38. Absolute AINP Current vs. Normalized AIN Common-Mode Voltage (VCM/Gain) for Various Temperatures (Gain = 2 to 128, VDIFF = 0 V)

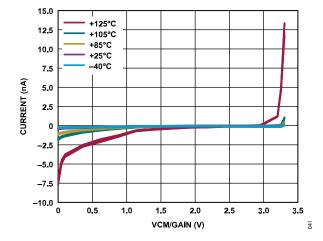


Figure 39. Differential AIN Current vs. VDIFF/Gain for Various Temperatures (Gain = 2 to 128, VCM = $AV_{DD}/2$)

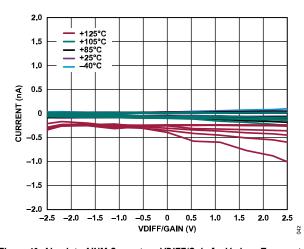


Figure 40. Absolute AINM Current vs. VDIFF/Gain for Various Temperatures (Gain = 2 to 128, VCM = $AV_{DD}/2$)

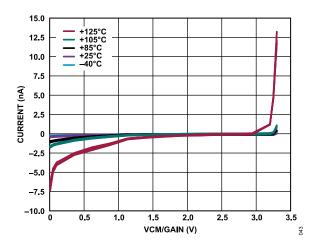


Figure 41. Absolute AINM Current vs. VCM/Gain for Various Temperatures (Gain = 2 to 128, VDIFF = 0 V)

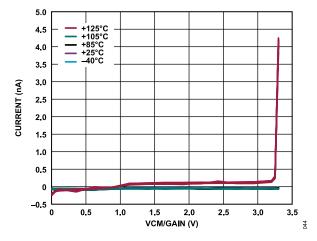


Figure 42. Differential AIN Current vs. VCM/Gain for Various Temperatures (Gain = 2 to 128, VDIFF = 0 V)

analog.com Rev. A | 28 of 99

TYPICAL PERFORMANCE CHARACTERISTICS

SUPPLY CURRENTS

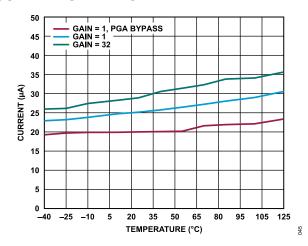


Figure 43. AV_{DD} Current vs. Temperature for Various Gains

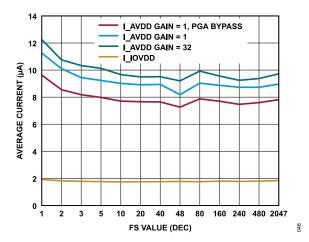


Figure 44. Duty Cycling Current Consumption (AV $_{\rm DD}$) and IOV $_{\rm DD}$), DUTY_CYC_RATIO = 1/4 (I_AVDD is AV $_{\rm DD}$ Current, I_IOVDD is IOV $_{\rm DD}$ Current)

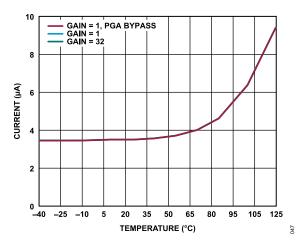


Figure 45. IOV_{DD} Current vs. Temperature

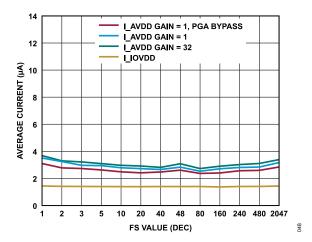


Figure 46. Duty Cycling Current Consumption (AV_{DD} and IOV_{DD}), DUTY CYC RATIO = 1/16

analog.com Rev. A | 29 of 99

TYPICAL PERFORMANCE CHARACTERISTICS

REFERENCE INPUT CURRENTS

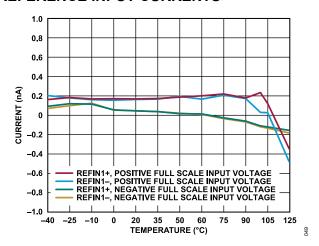


Figure 47. Reference Input Current vs. Temperature (Reference Buffer On, External 2.5 V Reference)

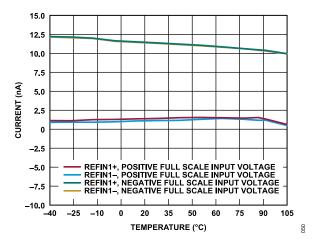


Figure 48. Reference Input Current vs. Temperature (Reference Buffer Bypass, External 2.5 V Reference)

analog.com Rev. A | 30 of 99

TYPICAL PERFORMANCE CHARACTERISTICS

INTERNAL REFERENCE AND TEMPERATURE SENSOR

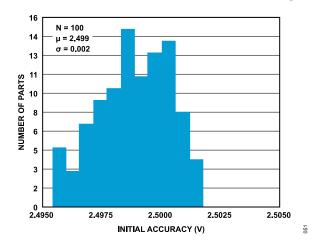


Figure 49. 2.5 V Internal Reference Voltage Histogram

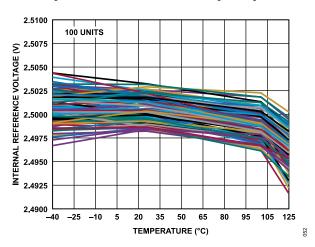


Figure 50. 2.5 V Internal Reference Voltage vs. Temperature

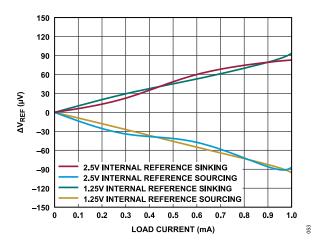


Figure 51. 1.25 V (AV $_{\rm DD}$ = 1.8 V) and 2.5 V (AV $_{\rm DD}$ = 3.3 V) Internal Reference Voltage vs. Load Current

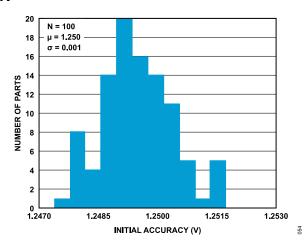


Figure 52. 1.25 V Internal Reference Voltage Histogram

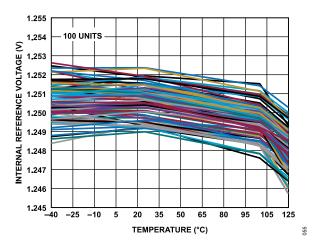


Figure 53. 1.25 V Internal Reference Voltage vs. Temperature

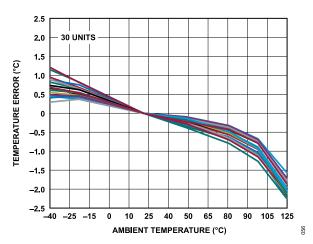


Figure 54. Temperature Sensor Error vs. Ambient Temperature after Calibration at 25°C

analog.com Rev. A | 31 of 99

TYPICAL PERFORMANCE CHARACTERISTICS

EXCITATION CURRENTS

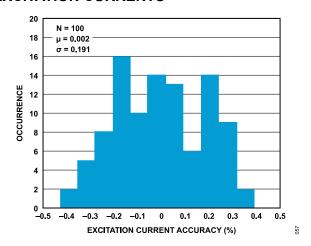


Figure 55. Excitation Current Initial Accuracy Histogram (100 μA)

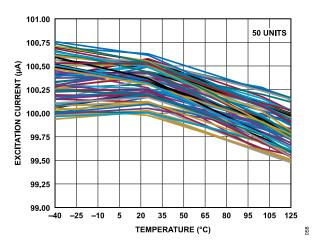


Figure 56. Excitation Current vs. Temperature (100 μA)

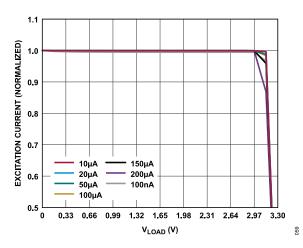


Figure 57. Output Compliance for Various IEXC Sources (AV $_{DD}$ = 3.3 V, V $_{LOAD}$ is Load Voltage)

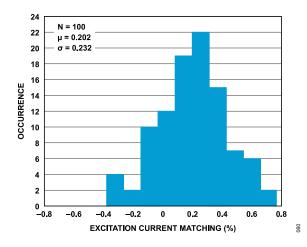


Figure 58. Excitation Current Initial Matching Histogram (100 μA)

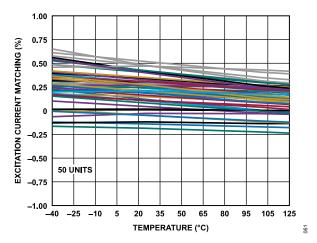


Figure 59. Excitation Current Matching vs. Temperature (100 μA)

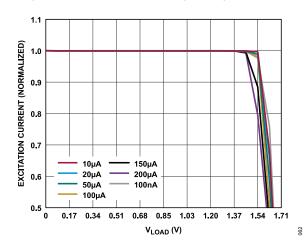


Figure 60. Output Compliance for Various IEXC Sources (AV_{DD} = 1.71 V)

analog.com Rev. A | 32 of 99

TYPICAL PERFORMANCE CHARACTERISTICS

RESOLUTION

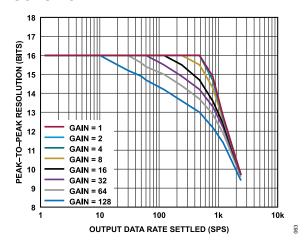


Figure 61. Peak-to-Peak Resolution vs. Output Data Rate (Settled) for Various Gains (Sinc³ Filter)

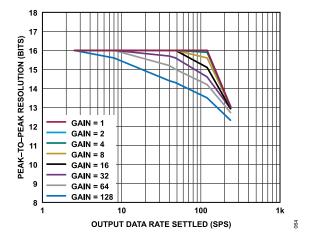


Figure 62. Peak-to-Peak Resolution vs. Output Data Rate (Settled) for Various Gains (Sinc³ + Sinc¹ Filter)

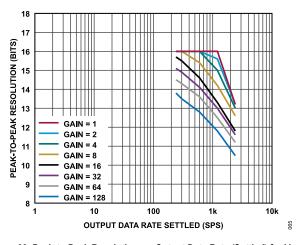


Figure 63. Peak-to-Peak Resolution vs. Output Data Rate (Settled) for Various

Gains (Sinc⁴ Filter)

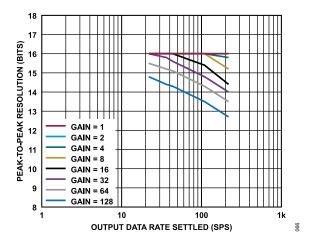


Figure 64. Peak-to-Peak Resolution vs. Output Data Rate (Settled) for Various Gains (Sinc⁴ + Sinc¹ Filter)

analog.com Rev. A | 33 of 99

TYPICAL PERFORMANCE CHARACTERISTICS

FAST FOURIER TRANSFORM (FFT)

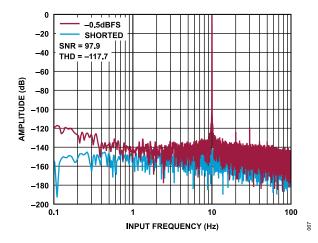


Figure 65. FFT, -0.5 dBFS vs. Shorted Inputs, 10 Hz Input Tone, Sinc³ Filter, ODR = 240 SPS, Gain = 1, Internal Reference

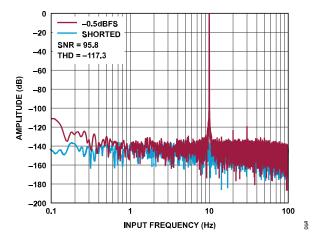


Figure 66. FFT, -0.5 dBFS vs. Shorted Inputs, 10 Hz Input Tone, Sinc³ Filter, ODR = 240 SPS, Gain = 1, External Reference

analog.com Rev. A | 34 of 99

TERMINOLOGY

ANALOG INPUT

AINP

AINP refers to the positive analog input.

AINM

AINM refers to the negative analog input.

Input Span

The input span specification defines the minimum and maximum input voltages from zero to full scale that the analog input can accept and still calibrate gain accurately.

ADC

Integral Nonlinearity (INL) Error

INL is the maximum deviation from a straight line passing through the endpoints of the ADC transfer function. The endpoints of the transfer function are zero scale (not to be confused with bipolar zero), a point 0.5 LSB below the first code transition (000 ... 000 to 000 ... 001), and full scale, a point 0.5 LSB above the last code transition (111 ... 110 to 111 ... 111). The error is expressed in ppm of the full-scale range.

Offset Error

Offset error is the difference between the ideal midscale input voltage (0 V) and the actual voltage producing the midscale output code.

Offset Calibration Range

In the system calibration modes, the AD4131-8 calibrates offset with respect to the analog input. The offset calibration range specification defines the range of voltages that the AD4131-8 can accept and still calibrate offset accurately.

Gain Error

Full-Scale Range (FSR)

The full-scale range is the input range the AD4131-8 can accept based on the choice of reference voltage and gain value. For a differential input signal, $FSR = 2 \times V_{RFF}/gain$.

Full-Scale Calibration Range

The full-scale calibration range is the range of voltages that the AD4131-8 can accept in the system calibration mode and still calibrate full scale correctly.

Output Data Rate (ODR)

The output data rate is the rate at which ADC conversions are available on a single settled channel when the ADC is continuously converting.

Same Conversion Output Data Rate (1CNV_ODR)

The same conversion output data rate is the rate at which ADC conversions are available using multiple channels with the same filter settings and taking one sample per channel.

REFERENCE

Line Regulation

Line regulation refers to the change in output voltage in response to a given change in supply voltage and is expressed in μ V/V.

Load Regulation

Load regulation refers to the change in output voltage in response to a given change in load current and is expressed in $\mu V/mA$.

Voltage Reference (V_{REF}) Temperature Coefficient (TC)

V_{REF} TC is a measure of the change in the reference output voltage with a change in the ambient temperature of the device, normalized by the output voltage at 25°C. V_{REF} TC is specified using the box method, which defines TC as the maximum change in the reference output over a given temperature range expressed in ppm/°C, as follows:

$$V_{REF}$$
 $TC = \left(\frac{V_{REF_MAX} - V_{REF_MIN}}{V_{REF_NOM} \times TEMP_RANGE}\right) \times 10^6 ppm/^{\circ}C$

where:

 V_{REF_MAX} is the maximum reference voltage output measured over the full temperature range.

 V_{REF_MIN} is the minimum reference voltage output measured over the full temperature range.

V_{REF_NOM} is the nominal reference voltage output at ambient temperature (25°C).

TEMP_RANGE is the difference between the maximum and minimum operating temperature of the reference.

Voltage Reference (V_{REF}) Noise Spectral Density (NSD)

V_{REF} NSD is a measurement of the internally generated thermal noise characterized as a spectral density nV/√Hz.

TEMPERATURE SENSOR

Accuracy

The temperature sensor accuracy is the deviation of the internal measured temperature vs. the real ambient temperature normalized to a 25°C measurement. Temperature sensor accuracy is measured in °C.

analog.com Rev. A | 35 of 99

TERMINOLOGY

Sensitivity

The temperature sensor sensitivity is the output voltage change due to a change in ambient temperature and is expressed in $\mu V/K$ or LSB/K.

analog.com Rev. A | 36 of 99

NOISE AND RESOLUTION

Table 16 through Table 35 show the RMS and peak-to-peak noise, effective resolution, and noise-free (peak-to-peak) resolution of the AD4131-8 for various output data rates, gain settings, and filters. The numbers represent the bipolar input range with an external reference of 2.5 V for the 3.3 V operations and 1.25 V for the 1.8 V operations, with the reference buffers in bypass mode. These numbers are typical and are generated with a differential input voltage of 0 V when the ADC is continuously converting on a single

channel. It is important to note that the effective resolution is calculated using the RMS noise, whereas the peak-to-peak resolution (shown in parentheses) is calculated based on peak-to-peak noise (shown in parentheses). The peak-to-peak resolution represents the resolution without a code flicker.

Effective Resolution = Log₂(Input Range/RMS Noise)

Peak-to-Peak Resolution = Log₂(Input Range/Peak-to-Peak Noise)

2.5 V REFERENCE

Sinc³

Table 16. RMS Noise (Peak-to-Peak Noise) vs. Gain and Output Data Rate, Expressed in μV_{RMS} (μV_{P-P})

| | ODR | | Gain = 1 | | | | | | | | |
|----------|-------|-----------------------|------------------|---------------------|---------------------|---------------------|--------------------|-------------------|-------------------|------------------|--------------|
| S (Dec.) | (SPS) | f _{3dB} (Hz) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 2047 | 1.17 | 0.3 | 0.19 (1.19) | 0.22 (1.29) | 0.13 (0.84) | 0.09 (0.55) | 0.07 (0.46) | 0.06 (0.42) | 0.05 (0.32) | 0.04 (0.23) | 0.03 (0.19) |
| 480 | 5 | 1.3 | 0.35 (2.19) | 0.43 (2.58) | 0.25 (1.64) | 0.18 (1.09) | 0.15 (0.92) | 0.13 (0.86) | 0.10 (0.62) | 0.08 (0.51) | 0.06 (0.40) |
| 240 | 10 | 2.6 | 0.49 (3.08) | 0.59 (3.78) | 0.36 (2.29) | 0.25 (1.64) | 0.21 (1.40) | 0.18 (1.15) | 0.14 (0.88) | 0.11 (0.75) | 0.09 (0.60) |
| 160 | 15 | 3.92 | 0.57 (3.68) | 0.75 (4.97) | 0.44 (2.93) | 0.30 (1.86) | 0.26 (1.60) | 0.22 (1.41) | 0.18 (1.21) | 0.13 (0.87) | 0.11 (0.71) |
| 30 | 30 | 7.86 | 0.83 (5.46) | 1.03 (6.76) | 0.62 (3.87) | 0.43 (2.66) | 0.37 (2.32) | 0.30 (2.16) | 0.25 (1.56) | 0.18 (1.24) | 0.15 (0.96) |
| 48 | 50 | 13.15 | 1.08 (7.05) | 1.32 (8.35) | 0.80 (5.32) | 0.56 (3.58) | 0.48 (3.24) | 0.40 (2.61) | 0.33 (2.17) | 0.25 (1.50) | 0.20 (1.24) |
| 10 | 60 | 15.78 | 1.17 (7.55) | 1.46 (8.74) | 0.88 (5.66) | 0.62 (4.07) | 0.51 (3.35) | 0.44 (2.89) | 0.36 (2.22) | 0.27 (1.70) | 0.23 (1.42) |
| 20 | 120 | 31.8 | 1.59 (10.13) | 2.13 (14.31) | 1.25 (8.49) | 0.89 (5.81) | 0.74 (4.72) | 0.63 (3.86) | 0.51 (3.29) | 0.37 (2.24) | 0.31 (1.95) |
| 10 | 240 | 64.8 | 2.49 (15.90) | 3.13 (20.66) | 1.89 (11.38) | 1.37 (8.67) | 1.12 (6.82) | 1.00 (6.70) | 0.77 (5.12) | 0.56 (3.54) | 0.47 (2.98) |
| 5 | 480 | 133.44 | 5.76 (33.78) | 6.65 (43.32) | 3.86 (24.94) | 2.55 (16.49) | 2.10 (13.59) | 1.80 (11.71) | 1.28 (7.90) | 0.91 (6.06) | 0.74 (4.37) |
| 3 | 800 | 231.2 | 25.44 (149.22) | 25.34 (155.38) | 13.34 (85.49) | 7.20 (45.70) | 4.72 (30.04) | 3.69 (23.55) | 2.29 (15.36) | 1.54 (9.50) | 1.27 (7.51) |
| | 1200 | 361.2 | 108.05 (667.42) | 109.77 (658.78) | 55.46 (355.07) | 28.45 (179.07) | 14.81 (94.36) | 9.07 (57.71) | 5.10 (33.51) | 3.10 (19.22) | 2.25 (14.91) |
| | 2400 | 626.4 | 873.32 (5423.90) | 890.93 (5424.10) | 440.53 (2516.04) | 221.90 (1317.65) | 110.41 (763.43) | 57.08 (361.40) | 29.00 (189.77) | 14.90 (88.22) | 8.66 (57.57) |

Table 17. Effective Resolution (Peak-to-Peak Resolution) vs. Gain and Output Data Rate, Expressed in Bits

| | | Gain = 1 | | | | | | | | |
|-----------|-----------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| FS (Dec.) | ODR (SPS) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 2047 | 1.17 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) |
| 180 | 5 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) |
| 240 | 10 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) |
| 160 | 15 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.7) |
| 30 | 30 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.2) |
| 18 | 50 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.6) | 16 (14.9) |
| 10 | 60 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.4) | 16 (14.7) |
| 20 | 120 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.5) | 16 (15) | 16 (14.2) |
| 10 | 240 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.5) | 16 (14.9) | 16 (14.4) | 16 (13.6) |
| 5 | 480 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.5) | 16 (14.7) | 16 (14.2) | 16 (13.7) | 15.7 (13) |
| } | 800 | 16 (14.9) | 16 (14.9) | 16 (14.8) | 16 (14.7) | 16 (14.3) | 16 (13.6) | 16 (13.3) | 15.6 (12.9) | 14.9 (12.2) |
|) | 1200 | 15.5 (12.8) | 15.5 (12.8) | 15.5 (12.7) | 15.5 (12.7) | 15.4 (12.6) | 15.1 (12.4) | 14.9 (12.2) | 14.6 (11.9) | 14.1 (11.4) |
| | 2400 | 12.5 (9.8) | 12.5 (9.7) | 12.5 (9.7) | 12.5 (9.7) | 12.5 (9.7) | 12.4 (9.7) | 12.4 (9.7) | 12.4 (9.6) | 12.1 (9.4) |

analog.com Rev. A | 37 of 99

NOISE AND RESOLUTION

Sinc⁴

Table 18. RMS Noise (Peak-to-Peak Noise) vs. Gain and Output Data Rate, Expressed in μV_{RMS} (μV_{P-P})

| | ODR | | Gain = 1 | | | | | | | | |
|-----------|-------|-----------------------|----------------|-------------------|-------------------|-------------------|-------------------|------------------|--------------|--------------|--------------|
| FS (Dec.) | (SPS) | f _{3dB} (Hz) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 10 | 240 | 55.68 | 2.28 (15.00) | 2.88 (18.38) | 1.73 (10.83) | 1.24 (8.07) | 1.04 (6.95) | 0.90 (5.97) | 0.68 (4.03) | 0.51 (3.24) | 0.43 (2.75) |
| 8 | 300 | 70.2 | 2.61 (17.58) | 3.30 (22.25) | 1.95 (12.22) | 1.38 (9.61) | 1.20 (7.79) | 1.01 (6.36) | 0.79 (5.18) | 0.58 (3.75) | 0.50 (3.18) |
| 4 | 600 | 144 | 4.16 (28.81) | 5.42 (33.28) | 3.36 (21.01) | 2.52 (15.70) | 2.18 (13.45) | 1.93 (12.52) | 1.36 (8.88) | 0.98 (6.44) | 0.82 (5.18) |
| 2 | 1200 | 301.2 | 8.81 (55.63) | 11.56 (78.78) | 7.54 (48.28) | 5.74 (37.16) | 5.09 (34.30) | 4.68 (31.83) | 2.95 (20.42) | 2.03 (13.39) | 1.71 (10.61) |
| 1 | 2400 | 544.8 | 71.51 (430.67) | 77.87 (459.58) | 38.91 (227.06) | 22.80 (138.04) | 15.77 (101.41) | 12.93 (79.89) | 7.70 (47.71) | 5.19 (32.50) | 4.08 (26.55) |

Table 19. Effective Resolution (Peak-to-Peak Resolution) vs. Gain and Output Data Rate, Expressed in Bits

| | ODR | Gain = 1 | | | | ' | | | | |
|-----------|-------|-------------|-----------|-----------|-----------|-------------|-------------|-------------|-------------|-------------|
| FS (Dec.) | (SPS) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 10 | 240 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.7) | 16 (15.1) | 16 (14.5) | 16 (13.8) |
| 8 | 300 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.5) | 16 (14.9) | 16 (14.3) | 16 (13.5) |
| 4 | 600 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.4) | 16 (14.6) | 16 (14.1) | 16 (13.6) | 15.5 (12.8) |
| 2 | 1200 | 16 (16) | 16 (16) | 16 (15.6) | 16 (15) | 16 (14.2) | 16 (13.3) | 15.7 (13) | 15.2 (12.5) | 14.5 (11.8) |
| 1 | 2400 | 16 (13.4) | 16 (13.2) | 16 (13.2) | 15.7 (13) | 15.3 (12.6) | 14.6 (11.8) | 14.3 (11.6) | 13.9 (11.2) | 13.2 (10.5) |

Sinc³ + Sinc¹ (Averaging Filter)

Table 20. RMS Noise (Peak-to-Peak Noise) vs. Gain and Output Data Rate, Expressed in μV_{RMS} (μV_{P-P})

| | ODR | | Gain = 1 | | | | | | | | |
|-----------|-------|-----------------------|----------------|-------------------|-------------------|-------------------|------------------|--------------|--------------|--------------|-------------|
| FS (Dec.) | (SPS) | f _{3dB} (Hz) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 96 | 2.5 | 1.36 | 0.36 (2.38) | 0.44 (2.78) | 0.27 (1.64) | 0.18 (1.17) | 0.15 (0.93) | 0.13 (0.81) | 0.11 (0.71) | 0.08 (0.54) | 0.07 (0.47) |
| 30 | 8 | 4.36 | 0.63 (3.97) | 0.79 (5.26) | 0.46 (3.08) | 0.33 (2.11) | 0.27 (1.66) | 0.23 (1.43) | 0.20 (1.21) | 0.14 (0.96) | 0.12 (0.77) |
| ô | 40 | 21.85 | 1.41 (9.04) | 1.78 (11.82) | 1.06 (7.30) | 0.75 (4.82) | 0.65 (4.02) | 0.53 (3.46) | 0.44 (2.66) | 0.32 (2.10) | 0.27 (1.72) |
| 5 | 48 | 26.22 | 1.60 (9.93) | 2.00 (13.21) | 1.22 (8.34) | 0.83 (6.03) | 0.70 (4.20) | 0.59 (3.79) | 0.48 (3.06) | 0.35 (2.37) | 0.29 (1.85) |
| 2 | 120 | 65.7 | 11.42 (74.40) | 11.93 (77.28) | 6.09 (39.49) | 3.16 (19.49) | 1.92 (11.57) | 1.32 (8.21) | 0.92 (6.09) | 0.65 (4.09) | 0.53 (3.56) |
| 1 | 240 | 130.8 | 89.40 (518.14) | 90.32 (537.21) | 44.72 (266.52) | 22.48 (146.02) | 11.75 (74.63) | 6.13 (37.84) | 3.21 (19.99) | 1.80 (11.39) | 1.15 (7.30) |

Table 21. Effective Resolution (Peak-to-Peak Resolution) vs. Gain and Output Data Rate, Expressed in Bits

| | ODR | Gain = 1 | | | | | | | | |
|-----------|-------|-------------|-----------|-----------|-----------|-----------|-------------|-------------|-------------|-------------|
| FS (Dec.) | (SPS) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 96 | 2.5 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) |
| 30 | 8 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.6) |
| ô | 40 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.7) | 16 (15.2) | 16 (14.4) |
| 5 | 48 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.6) | 16 (15) | 16 (14.3) |
| 2 | 120 | 16 (16) | 16 (16) | 16 (15.9) | 16 (15.9) | 16 (15.6) | 16 (15.1) | 16 (14.6) | 16 (14.2) | 16 (13.5) |
| 1 | 240 | 15.8 (13.1) | 15.8 (13) | 15.8 (13) | 15.8 (13) | 15.7 (13) | 15.6 (12.9) | 15.6 (12.9) | 15.4 (12.7) | 15.1 (12.3) |

analog.com Rev. A | 38 of 99

NOISE AND RESOLUTION

Sinc⁴ + Sinc¹ (Averaging Filter)

Table 22. RMS Noise (Peak-to-Peak Noise) vs. Gain and Output Data Rate, Expressed in μV_{RMS} (μV_{P-P})

| | ODR | f _{3dB} | Gain = 1 | | | | | | | | |
|-----------|--------|------------------|--------------|--------------|--------------|--------------|--------------|--------------|-------------|-------------|-------------|
| FS (Dec.) | (SPS) | (Hz) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 10 | 21.82 | 13.02 | 1.10 (6.85) | 1.37 (8.54) | 0.82 (5.26) | 0.57 (3.70) | 0.46 (2.96) | 0.40 (2.42) | 0.34 (2.14) | 0.25 (1.57) | 0.20 (1.41) |
| 6 | 36.36 | 21.7 | 1.36 (8.94) | 1.73 (12.22) | 1.07 (7.25) | 0.74 (4.79) | 0.63 (4.11) | 0.51 (3.26) | 0.42 (2.82) | 0.32 (2.17) | 0.26 (1.77) |
| 5 | 43.64 | 26.04 | 1.53 (10.53) | 1.93 (13.41) | 1.15 (7.15) | 0.81 (5.04) | 0.69 (4.28) | 0.58 (3.62) | 0.48 (3.18) | 0.34 (2.35) | 0.30 (1.80) |
| 2 | 109.1 | 62.25 | 2.61 (17.58) | 3.39 (20.96) | 2.05 (12.81) | 1.47 (9.24) | 1.27 (8.57) | 1.12 (6.97) | 0.84 (5.27) | 0.59 (3.96) | 0.50 (3.10) |
| 1 | 218.18 | 129.9 | 7.94 (47.28) | 8.72 (57.42) | 4.95 (31.89) | 3.28 (20.51) | 2.57 (15.10) | 2.21 (13.14) | 1.48 (9.52) | 1.04 (7.12) | 0.86 (5.77) |

Table 23. Effective Resolution (Peak-to-Peak Resolution) vs. Gain and Output Data Rate, Expressed in Bits

| | ODR | Gain = 1 | | | | | | | | |
|-----------|--------|-------------|----------|----------|-----------|-----------|-----------|-----------|-----------|-------------|
| FS (Dec.) | (SPS) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 10 | 21.82 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.5) | 16 (14.8) |
| 6 | 36.36 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.8) | 16 (15.2) | 16 (14.4) |
| 5 | 43.64 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.6) | 16 (15.1) | 16 (14.3) |
| 2 | 109.1 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.4) | 16 (14.8) | 16 (14.3) | 16 (13.5) |
| 1 | 218.18 | 16 (16) | 16 (16) | 16 (16) | 16 (15.8) | 16 (15.2) | 16 (14.4) | 16 (14) | 16 (13.5) | 15.5 (12.7) |

Post Filters

Table 24. RMS Noise (Peak-to-Peak Noise) vs. Gain and Output Data Rate, Expressed in μV_{RMS} (μV_{P-P})

| | ODR | f _{3dB} | Gain = 1 | | | | | | | | |
|---------------|--------|------------------|-------------|-----------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Filter Type | (SPS) | (Hz) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| Post Filter 4 | 16.21 | 12.54 | 1.06 (7.05) | 1.34 (8.74) | 0.78 (5.02) | 0.57 (3.90) | 0.46 (2.87) | 0.39 (2.43) | 0.33 (2.03) | 0.24 (1.48) | 0.20 (1.29) |
| Post Filter 3 | 19.355 | 13.08 | 1.13 (7.55) | 1.36 (8.54) | 0.81 (5.02) | 0.57 (3.70) | 0.48 (3.08) | 0.40 (2.68) | 0.33 (2.20) | 0.24 (1.58) | 0.20 (1.37) |
| Post Filter 2 | 24 | 14.7 | 1.36 (8.94) | 1.60 (10.33) | 0.92 (6.11) | 0.64 (4.20) | 0.52 (3.34) | 0.44 (3.05) | 0.35 (2.37) | 0.26 (1.72) | 0.21 (1.43) |
| Post Filter 1 | 26.087 | 16.68 | 1.22 (8.15) | 1.53 (10.23) | 0.92 (6.11) | 0.65 (4.52) | 0.54 (3.71) | 0.45 (2.86) | 0.38 (2.33) | 0.28 (1.85) | 0.23 (1.52) |

Table 25. Effective Resolution (Peak-to-Peak Resolution) vs. Gain and Output Data Rate, Expressed in Bits

| | ODR | Gain = 1 | | | | | | | | |
|---------------|--------|-------------|----------|----------|----------|----------|-----------|-----------|-----------|------------|
| Filter Type | (SPS) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| Post Filter 4 | 16.21 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.6) | 16 (14.8) |
| Post Filter 3 | 19.355 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.6) | 16 (14.8) |
| Post Filter 2 | 24 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.5) | 16 (14.8) |
| Post Filter 1 | 26.087 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.9) | 16 (15.4) | 16 (14.6) |

1.25 V REFERENCE

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Table 26. RMS Noise (Peak-to-Peak Noise) vs. Gain and Output Data Rate, Expressed in μV_{RMS} (μV_{P-P})

| | ODR | | Gain = 1 | | | | | | | | |
|-----------|-------|-----------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| FS (Dec.) | (SPS) | f _{3dB} (Hz) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 2047 | 1.17 | 0.3 | 0.16 (0.99) | 0.21 (1.34) | 0.13 (0.82) | 0.09 (0.57) | 0.07 (0.50) | 0.06 (0.36) | 0.05 (0.33) | 0.04 (0.25) | 0.03 (0.22) |
| 480 | 5 | 1.3 | 0.33 (2.09) | 0.43 (2.88) | 0.26 (1.69) | 0.18 (1.22) | 0.15 (0.94) | 0.13 (0.83) | 0.10 (0.67) | 0.08 (0.55) | 0.06 (0.44) |
| 240 | 10 | 2.6 | 0.47 (2.98) | 0.61 (4.17) | 0.36 (2.29) | 0.25 (1.53) | 0.21 (1.42) | 0.18 (1.18) | 0.15 (1.08) | 0.11 (0.74) | 0.09 (0.58) |

analog.com Rev. A | 39 of 99

NOISE AND RESOLUTION

Table 26. RMS Noise (Peak-to-Peak Noise) vs. Gain and Output Data Rate, Expressed in μV_{RMS} (μV_{P-P}) (Continued)

| | ODR | | Gain = 1 | | | | | | | | |
|-----------|-------|-----------------------|------------------|---------------------|---------------------|--------------------|-------------------|-------------------|------------------|--------------|--------------|
| FS (Dec.) | (SPS) | f _{3dB} (Hz) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 160 | 15 | 3.92 | 0.57 (3.87) | 0.70 (4.47) | 0.44 (2.68) | 0.31 (1.97) | 0.26 (1.78) | 0.22 (1.43) | 0.19 (1.25) | 0.13 (0.90) | 0.11 (0.76) |
| 30 | 30 | 7.86 | 0.81 (5.51) | 1.03 (6.86) | 0.62 (3.70) | 0.44 (2.99) | 0.36 (2.19) | 0.31 (2.14) | 0.26 (1.66) | 0.19 (1.12) | 0.16 (0.96) |
| 18 | 50 | 13.15 | 1.07 (7.05) | 1.34 (8.54) | 0.80 (5.09) | 0.57 (3.74) | 0.49 (3.58) | 0.41 (2.71) | 0.33 (2.20) | 0.25 (1.64) | 0.21 (1.41) |
| 10 | 60 | 15.78 | 1.17 (7.50) | 1.45 (9.09) | 0.85 (5.91) | 0.63 (4.17) | 0.52 (3.23) | 0.45 (3.10) | 0.37 (2.44) | 0.27 (1.71) | 0.23 (1.57) |
| 20 | 120 | 31.8 | 1.66 (11.08) | 2.07 (14.31) | 1.26 (8.07) | 0.90 (5.71) | 0.74 (4.53) | 0.65 (4.34) | 0.53 (3.47) | 0.39 (2.41) | 0.32 (2.02) |
| 10 | 240 | 64.8 | 2.37 (15.75) | 3.07 (21.01) | 1.86 (11.47) | 1.33 (8.79) | 1.12 (7.66) | 0.99 (7.02) | 0.78 (5.07) | 0.58 (3.46) | 0.47 (2.91) |
| 5 | 480 | 133.44 | 4.23 (27.32) | 5.18 (31.84) | 3.16 (21.04) | 2.23 (13.62) | 1.95 (12.25) | 1.67 (11.30) | 1.25 (8.59) | 0.94 (5.99) | 0.78 (5.01) |
| 3 | 800 | 231.2 | 13.79 (91.65) | 14.57 (97.41) | 7.78 (48.81) | 4.82 (31.51) | 3.73 (21.97) | 3.12 (18.61) | 2.11 (13.12) | 1.53 (10.30) | 1.25 (8.08) |
| 2 | 1200 | 361.2 | 56.65 (348.62) | 58.95 (383.78) | 29.90 (170.04) | 15.07 (88.48) | 9.35 (59.43) | 6.32 (38.24) | 3.93 (25.58) | 2.62 (16.29) | 2.11 (14.12) |
| I | 2400 | 626.4 | 451.81 (2831.34) | 441.73 (2720.87) | 225.95 (1360.33) | 114.08 (712.09) | 59.38 (378.43) | 31.81 (190.83) | 16.53 (97.28) | 9.33 (58.10) | 6.16 (38.91) |

Table 27. Effective Resolution (Peak-to-Peak Resolution) vs. Gain and Output Data Rate, Expressed in Bits

| | | Gain = 1 PGA_BYP = | | | | | | | | |
|-----------|-----------|-----------------------|-------------|-------------|-------------|------------|-------------|-------------|-------------|-------------|
| FS (Dec.) | ODR (SPS) | 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 2047 | 1.17 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) |
| 480 | 5 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.5) |
| 240 | 10 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.7) | 16 (14.9) |
| 160 | 15 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.9) | 16 (15.4) | 16 (14.7) |
| 80 | 30 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.5) | 16 (14.9) | 16 (14.2) |
| 48 | 50 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.8) | 16 (15.1) | 16 (14.5) | 16 (13.8) |
| 40 | 60 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.7) | 16 (15) | 16 (14.4) | 16 (13.7) |
| 20 | 120 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.2) | 16 (14.5) | 16 (13.9) | 15.9 (13.2) |
| 10 | 240 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.4) | 16 (14.5) | 16 (13.9) | 16 (13.3) | 15.3 (12.6) |
| 5 | 480 | 16 (16) | 16 (16) | 16 (15.9) | 16 (15.4) | 16 (14.6) | 16 (13.8) | 15.9 (13.2) | 15.3 (12.6) | 14.6 (11.9) |
| 3 | 800 | 16 (14.7) | 16 (14.7) | 16 (14.6) | 16 (14.3) | 16 (13.6) | 15.6 (12.9) | 15.2 (12.5) | 14.6 (11.9) | 13.9 (11.2) |
| 2 | 1200 | 15.4 (12.7) | 15.4 (12.7) | 15.4 (12.6) | 15.3 (12.6) | 15 (12.3) | 14.6 (11.9) | 14.3 (11.6) | 13.9 (11.1) | 13.2 (10.5) |
| 1 | 2400 | 12.4 (9.7) | 12.5 (9.7) | 12.4 (9.7) | 12.4 (9.7) | 12.4 (9.6) | 12.3 (9.5) | 12.2 (9.5) | 12 (9.3) | 11.6 (8.9) |

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Table 28. RMS Noise (Peak-to-Peak Noise) vs. Gain and Output Data Rate, Expressed in μV_{RMS} (μV_{P-P})

| | ODR | | Gain = 1 | | | | | | | | |
|-----------|-------|-----------------------|----------------|-------------------|-------------------|-------------------|------------------|---------------|--------------|--------------|--------------|
| FS (Dec.) | (SPS) | f _{3dB} (Hz) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 10 | 240 | 55.68 | 2.22 (14.21) | 2.78 (18.88) | 1.71 (11.62) | 1.23 (7.99) | 1.05 (6.90) | 0.88 (5.80) | 0.72 (4.84) | 0.54 (3.29) | 0.43 (2.88) |
| 8 | 300 | 70.2 | 2.51 (15.65) | 3.12 (18.33) | 1.91 (12.20) | 1.42 (9.21) | 1.18 (7.54) | 1.02 (6.34) | 0.82 (4.99) | 0.61 (4.14) | 0.50 (3.24) |
| 4 | 600 | 144 | 3.76 (24.79) | 4.90 (33.03) | 3.14 (20.04) | 2.34 (16.72) | 2.05 (13.35) | 1.83 (11.89) | 1.39 (9.32) | 0.99 (6.47) | 0.82 (5.37) |
| 2 | 1200 | 301.2 | 6.49 (42.42) | 9.25 (60.21) | 6.45 (40.81) | 5.07 (33.67) | 4.57 (29.84) | 4.25 (28.16) | 2.86 (18.03) | 2.00 (13.35) | 1.68 (11.20) |
| 1 | 2400 | 544.8 | 36.27 (207.89) | 41.37 (247.28) | 23.57 (142.32) | 15.13 (100.89) | 12.30 (77.83) | 11.32 (71.09) | 7.06 (48.19) | 4.80 (32.89) | 3.98 (24.31) |

analog.com Rev. A | 40 of 99

NOISE AND RESOLUTION

Table 29. Effective Resolution (Peak-to-Peak Resolution) vs. Gain and Output Data Rate, Expressed in Bits

| | ODR | Gain = 1 | | | | | | | | |
|-----------|-------|-------------|-------------|-----------|-------------|-------------|-------------|-------------|-------------|-------------|
| FS (Dec.) | (SPS) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 10 | 240 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.5) | 16 (14.7) | 16 (14) | 16 (13.4) | 15.5 (12.7) |
| 8 | 300 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.3) | 16 (14.5) | 16 (13.8) | 16 (13.2) | 15.2 (12.5) |
| 4 | 600 | 16 (16) | 16 (16) | 16 (15.9) | 16 (15.3) | 16 (14.5) | 16 (13.7) | 15.8 (13.1) | 15.3 (12.6) | 14.5 (11.8) |
| 2 | 1200 | 16 (15.8) | 16 (15.3) | 16 (14.8) | 16 (14.2) | 16 (13.3) | 15.2 (12.4) | 14.7 (12) | 14.3 (11.5) | 13.5 (10.8) |
| 1 | 2400 | 16 (13.4) | 15.9 (13.2) | 15.7 (13) | 15.3 (12.6) | 14.6 (11.9) | 13.8 (11) | 13.4 (10.7) | 13 (10.3) | 12.3 (9.5) |

Sinc³ + Sinc¹ (Averaging Filter)

Table 30. RMS Noise (Peak-to-Peak Noise) vs. Gain and Output Data Rate, Expressed in μV_{RMS} (μV_{P-P})

| | ODR | | Gain = 1 | | | | | | | | |
|-----------|-------|--------------------------|----------------|-------------------|-------------------|------------------|--------------|--------------|--------------|-------------|-------------|
| FS (Dec.) | (SPS) | $f_{3dB}\left(Hz\right)$ | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 96 | 2.5 | 1.36 | 0.35 (2.09) | 0.43 (3.13) | 0.26 (1.69) | 0.19 (1.22) | 0.15 (1.02) | 0.13 (0.86) | 0.11 (0.78) | 0.08 (0.48) | 0.07 (0.44) |
| 30 | 8 | 4.36 | 0.61 (4.17) | 0.77 (4.62) | 0.47 (3.08) | 0.33 (2.19) | 0.28 (1.91) | 0.23 (1.48) | 0.19 (1.28) | 0.15 (0.98) | 0.12 (0.81) |
| 6 | 40 | 21.85 | 1.39 (9.04) | 1.78 (12.42) | 1.07 (6.66) | 0.76 (4.61) | 0.64 (4.29) | 0.53 (3.54) | 0.44 (2.79) | 0.33 (2.14) | 0.27 (1.72) |
| 5 | 48 | 26.22 | 1.57 (10.08) | 1.95 (11.72) | 1.17 (7.52) | 0.82 (5.66) | 0.71 (4.56) | 0.59 (3.96) | 0.47 (3.07) | 0.36 (2.23) | 0.30 (1.95) |
| 2 | 120 | 65.7 | 6.32 (42.07) | 6.57 (40.63) | 3.54 (22.20) | 2.09 (13.48) | 1.47 (9.39) | 1.17 (7.37) | 0.87 (5.38) | 0.64 (4.41) | 0.52 (3.37) |
| 1 | 240 | 130.8 | 45.47 (299.49) | 47.55 (293.18) | 23.49 (143.39) | 12.20 (74.61) | 6.32 (43.04) | 3.65 (24.18) | 2.11 (13.76) | 1.33 (8.83) | 1 (6.17) |

Table 31. Effective Resolution (Peak-to-Peak Resolution) vs. Gain and Output Data Rate, Expressed in Bits

| | ODR | Gain = 1 | | | | | ' | | | |
|-----------|-------|-------------|-----------|-----------|-------------|-------------|-------------|-------------|-------------|-------------|
| FS (Dec.) | (SPS) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 96 | 2.5 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.4) |
| 30 | 8 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.9) | 16 (15.3) | 16 (14.6) |
| 6 | 40 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.4) | 16 (14.7) | 16 (14.2) | 16 (13.4) |
| 5 | 48 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.3) | 16 (14.6) | 16 (14) | 16 (13.3) |
| 2 | 120 | 16 (15.9) | 16 (15.8) | 16 (15.7) | 16 (15.5) | 16 (15) | 16 (14.3) | 16 (13.7) | 15.9 (13.2) | 15.2 (12.5) |
| 1 | 240 | 15.8 (13) | 15.7 (13) | 15.7 (13) | 15.6 (12.9) | 15.6 (12.9) | 15.4 (12.7) | 15.2 (12.5) | 14.8 (12.1) | 14.3 (11.5) |

Sinc⁴ + Sinc¹ (Averaging Filter)

Table 32. RMS Noise (Peak-to-Peak Noise) vs. Gain and Output Data Rate, Expressed in μV_{RMS} (μV_{P-P})

| | ODR | f _{3dB} | Gain = 1 | | | | | | | | |
|-----------|--------|------------------|--------------|--------------|--------------|--------------|--------------|--------------|-------------|-------------|-------------|
| FS (Dec.) | (SPS) | (Hz) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 10 | 21.82 | 13.02 | 1.08 (6.80) | 1.37 (9.19) | 0.79 (4.92) | 0.57 (3.79) | 0.49 (3.38) | 0.41 (2.53) | 0.34 (2.35) | 0.25 (1.49) | 0.21 (1.36) |
| 6 | 36.36 | 21.7 | 1.39 (8.89) | 1.72 (11.13) | 1.04 (6.53) | 0.75 (4.93) | 0.62 (3.93) | 0.54 (3.38) | 0.44 (2.66) | 0.32 (1.93) | 0.27 (1.74) |
| 5 | 43.64 | 26.04 | 1.54 (9.49) | 1.89 (11.92) | 1.17 (7.47) | 0.82 (5.38) | 0.69 (4.47) | 0.58 (3.76) | 0.48 (3.01) | 0.36 (2.26) | 0.29 (1.81) |
| 2 | 109.1 | 62.25 | 2.49 (15.05) | 3.22 (21.85) | 1.99 (12.19) | 1.43 (10.28) | 1.21 (8.00) | 1.05 (7.08) | 0.82 (5.56) | 0.60 (4.01) | 0.51 (3.26) |
| 1 | 218.18 | 129.9 | 4.96 (31.89) | 6.16 (40.03) | 3.81 (24.76) | 2.62 (16.96) | 2.28 (14.48) | 1.99 (12.96) | 1.47 (9.18) | 1.04 (6.90) | 0.86 (5.31) |

Table 33. Effective Resolution (Peak-to-Peak Resolution) vs. Gain and Output Data Rate, Expressed in Bits

| | ODR | Gain = 1 | | | | | | | | |
|-----------|-------|-------------|----------|----------|----------|-----------|-----------|-----------|-----------|-------------|
| FS (Dec.) | (SPS) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 30 | 21.82 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.8) | 16 (15.1) | 16 (14.5) | 16 (13.8) |
| 6 | 36.36 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.4) | 16 (14.7) | 16 (14.2) | 16 (13.4) |
| 5 | 43.64 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.3) | 16 (14.6) | 16 (14) | 16 (13.3) |
| 2 | 109.1 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.3) | 16 (14.5) | 16 (13.8) | 16 (13.3) | 15.2 (12.5) |

analog.com Rev. A | 41 of 99

NOISE AND RESOLUTION

Table 33. Effective Resolution (Peak-to-Peak Resolution) vs. Gain and Output Data Rate, Expressed in Bits (Continued)

| | ODR | Gain = 1 | | | | | | | | |
|-----------|--------|-------------|-----------|-----------|-----------|-----------|-----------|-----------|-------------|-------------|
| FS (Dec.) | (SPS) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 1 | 218.18 | 16 (16) | 16 (15.9) | 16 (15.6) | 16 (15.1) | 16 (14.3) | 16 (13.5) | 15.7 (13) | 15.2 (12.5) | 14.5 (11.8) |

Post Filters

Table 34. RMS Noise (Peak-to-Peak Noise) vs. Gain and Output Data Rate, Expressed in μV_{RMS} (μV_{P-P})

| | ODR | f _{3dB} | Gain = 1 | | | | | | | | |
|---------------|--------|------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Filter Type | (SPS) | (Hz) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| Post Filter 4 | 16.21 | 12.54 | 1.03 (6.36) | 1.33 (8.39) | 0.79 (5.49) | 0.55 (3.6) | 0.47 (3.09) | 0.39 (2.46) | 0.33 (2.12) | 0.25 (1.62) | 0.21 (1.35) |
| Post Filter 3 | 19.355 | 13.08 | 1.09 (6.95) | 1.36 (8.34) | 0.82 (5.09) | 0.56 (3.61) | 0.48 (2.93) | 0.4 (2.69) | 0.34 (2.15) | 0.26 (1.66) | 0.21 (1.36) |
| Post Filter 2 | 24 | 14.7 | 1.18 (7.4) | 1.5 (10.33) | 0.88 (5.69) | 0.62 (3.91) | 0.51 (3.19) | 0.43 (2.72) | 0.36 (2.33) | 0.26 (1.76) | 0.22 (1.44) |
| Post Filter 1 | 26.087 | 16.68 | 1.24 (8.49) | 1.53 (9.24) | 0.9 (5.79) | 0.65 (4.32) | 0.54 (3.59) | 0.47 (3.05) | 0.39 (2.4) | 0.28 (2.02) | 0.24 (1.63) |

Table 35. Effective Resolution (Peak-to-Peak Resolution) vs. Gain and Output Data Rate, Expressed in Bits

| | ODR | Gain = 1 | | | | | | | | |
|---------------|--------|-------------|----------|----------|----------|----------|-----------|-----------|-----------|------------|
| Filter Type | (SPS) | PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| Post Filter 4 | 16.21 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.9) | 16 (15.2) | 16 (14.6) | 16 (13.8) |
| Post Filter 3 | 19.355 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.8) | 16 (15.1) | 16 (14.5) | 16 (13.8) |
| Post Filter 2 | 24 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.8) | 16 (15) | 16 (14.5) | 16 (13.7) |
| Post Filter 1 | 26.087 | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (16) | 16 (15.6) | 16 (14.9) | 16 (14.4) | 16 (13.6) |

NOISE SPECTRAL DENSITY

The noise spectral density is derived from the 2.5 V reference rms noise values for the sinc³ filter at a lower ODR, divided by 1.15 times the square root of the input bandwidth.

Table 36. Input Referred Noise Spectral Density, Expressed in nV/√Hz

| Gain = 1 | | | | | | | | |
|-------------|----------|----------|----------|----------|-----------|-----------|-----------|------------|
| PGA_BYP = 1 | Gain = 1 | Gain = 2 | Gain = 4 | Gain = 8 | Gain = 16 | Gain = 32 | Gain = 64 | Gain = 128 |
| 303 | 369 | 214 | 152 | 123 | 99 | 85 | 64 | 48 |

analog.com Rev. A | 42 of 99

THEORY OF OPERATION

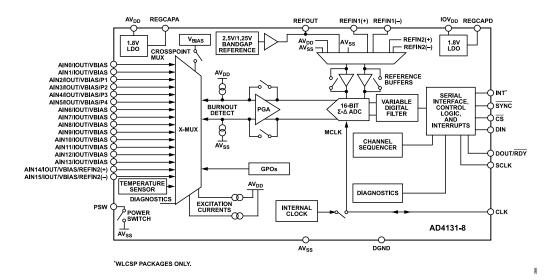


Figure 67. Detailed Block Diagram

OVERVIEW

The AD4131-8 is an ultra-low power, 16-bit ADC that incorporates a Σ - Δ modulator, an input crosspoint multiplexer (X-MUX), a PGA stage, an internal reference and reference buffers, and on-chip digital filtering, which is intended for the measurement of high dynamic range, low frequency signals, such as those in pressure transducers, weigh scales, and temperature measurement applications. Each block of the AD4131-8 and its functionality is optimized for low power operations in battery-powered applications. Included on chip is a suite of integrated functions to connect and power multiple sensors, such as excitation currents, a low-side power switch, bias voltage, and burnout currents.

ANALOG-TO-DIGITAL CONVERTER (ADC) CORE

The AD4131-8 contains a Σ - Δ -based ADC core, composed of a MASH22 Σ - Δ modulator (f_{MOD} = 38.4 kHz), followed by a digital filter. The ADC core inherently rejects frequencies at 38.4 kHz. The Σ - Δ ADC highly digital architecture is ideally suited for modern fine-line CMOS processes, thereby allowing easy addition of digital functionality without significantly increasing the cost. Using oversampling, quantization noise shaping, digital filtering, and decimation, a Σ - Δ ADC offers several advantages over the other architectures, especially for high resolution, low frequency applications. Refer to MT-022 and MT-023 for a deep dive in Σ - Δ ADC theory.

Digital Filter

The AD4131-8 offers several digital filter options. The option selected affects the input bandwidth, output data rate, achievable noise performance, settling time, and 50 Hz and 60 Hz rejection. The device filter options are listed in Table 37. See the Digital Filters section for full details.

analog.com Rev. A | 43 of 99

THEORY OF OPERATION

Table 37. AD4131-8 Filter Options

| Filter Type | FS Range (Hex) | Output Data Rate (SPS) ¹ | Comments |
|---------------------------------------|------------------|-------------------------------------|--|
| Sinc ⁴ | 0x01 to 0xA | 2400 to 240 | ADC frequency (f _{ADC}) = f _{MCLK} / 32 / FS. |
| Sinc ⁴ + Sinc ¹ | 0x01 to 0xA | 218.18 to 21.8 | Averaging filter. Sinc ⁴ plus averaging by 8. $f_{ADC} = f_{MCLK} / (32 \times FS \times (4 + AVG - 1))$, where AVG = 8. |
| Sinc ³ | 0x01 to 0x7FF | 2400 to 1.17 | $f_{ADC} = f_{MCLK}/32/FS$. |
| Sinc ³ + REJ60 | 0x01 to 0x7FF | 2400 to 1.17 | FS = 0d48 can be set to simultaneously reject 50 Hz and 60 Hz at 50 SPS ODR. |
| Sinc ³ + Sinc ¹ | 0x01 to 0x7FF | 240 to 0.117 (Dec.: 1 to 2047) | Averaging filter. Sinc ³ plus averaging by 8. Recommended for FS from 0x01 to 0xCC only (minimum ODR = 1.17). $f_{ADC} = f_{MCLK}/(32 \times FS \times (3 + AVG - 1))$, where AVG = 8. |
| Sinc ³ + Post Filters | N/A ² | 16.21, 19.355, 24, 26.087 | Low latency with good 50 Hz and 60 Hz rejection. |

¹ Assuming accurate f_{MCLK} = 76.8 kHz.

ADC MAIN CLOCK

The Σ - Δ ADC core needs a 76.8 kHz MCLK to operate the internal modulator (f_{MOD} = f_{MCLK}/2 = 38.4 kHz). The device has an internal oscillator to generate the MCLK. The internal clock is selected by default and can be made available at the CLK pin if a clock source is required for external circuitry. An external clock applied to the CLK pin can also be selected as the MCLK source for the device. Using an external clock can enable several ADCs to be driven from a common clock, allowing simultaneous conversions to be performed. The external clock can be either 76.8 kHz or 153.6 kHz when the internal divide by two option is selected.

Use the MCLK_SEL bits in the ADC_CONTROL register to select the appropriate option according to Table 38 (see the ADC Control Register section). Refer to Figure 67 for a block diagram of the AD4131-8 ADC clock connection scheme.

Table 38. MCLK Source Options

| MCLK_SEL | MCLK Source | Source Clock Frequency (kHz) |
|----------------|-----------------------|------------------------------|
| 0b00 (Default) | Internal, output off | 76.8 |
| 0b01 | Internal, output on | 76.8 |
| 0b10 | External, divider off | 76.8 |
| 0b11 | External, divider on | 153.6 |

ADC REFERENCE

The AD4131-8 requires a precision reference voltage for the ADC core. The reference source for the AD4131-8 can be selected for each ADC setup (see the ADC Configuration and Operations section for full details) using the REF_SEL bits in each the CONFIG_n register (see Table 50).

The AD4131-8 integrates a band gap voltage reference that can be configured to give a 1.25 V or a 2.5 V low noise voltage reference (see the specifications in Table 3). The internal reference is disabled by default. To enable the internal reference, set the INT_REF_EN bit in the ADC_CONTROL register to 1. The 2.5 V internal reference is selected by default. A 1 nF capacitor is required on the REFOUT pin when the internal reference is active. Note that when the AV_DD supply is set to below 2.5 V, the internal

reference of 1.25 V is selected by setting the INT_REF_VAL bit in the ADC_CONTROL register to 1. This bit has effect only when the internal reference is enabled. The internal reference value is set to 2.5 V by default.

When entering and exiting standby mode (that is, while using duty cycling mode) while using the internal reference, and providing that the reference is not loaded by any external circuitry other than its decoupling, it is recommended to set the STBY_REFHOL_EN bit to 1 in the MISC register. This enables the reference holder that is designed to reduce the supply current consumption (IDD) contribution of the internal reference continuously turning on and off. In the scenario that duty cycling is used and the internal reference is used to power a sensor, it is recommended to keep the reference on during the standby phase by enabling the STBY_REFCORE_EN bit to 1 in the MISC register. See the Standby Mode section for more details on the blocks that can be kept active when in standby during duty cycling.

An external voltage reference can be supplied at the two external reference input options: REFIN1(\pm) or REFIN2(\pm). The external reference option can be useful when ratio-metric measurement is required on some channels, such as when interfacing to an RTD temperature sensor.

Refer to Figure 67 for a simplified schematic of the AD4131-8 ADC reference connection scheme.

Reference Buffers

Reference buffers are also included on chip, and they can be used with the internal reference or an externally applied reference. The buffers bypass option allows full rail-to-rail reference input up to the analog supply value, whereas the buffers enabled option allows for a lower reference input current. Both options have similar AV_{DD} current. See Table 3 for related specifications. Reference buffers can be enabled on a per channel basis, in each CONFIG_n register.

analog.com Rev. A | 44 of 99

² N/A means not applicable.

THEORY OF OPERATION

ANALOG FRONT END

Analog Input Multiplexer

The device can have 8 differential or 16 pseudodifferential analog inputs. The AD4131-8 uses flexible multiplexing; thus, select any analog input pin as a positive input (AINP) and any analog input pin as a negative input (AINM), as described in Figure 68. This feature allows the user to perform diagnostics, such as checking that pins are connected. This feature also simplifies PCB design. For example, the same PCB can accommodate 2-wire, 3-wire, and 4-wire RTDs.

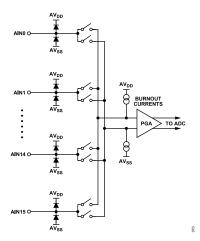


Figure 68. Analog Input Multiplexer Circuit

The on-chip multiplexer increases the channel count of the device and guarantees that all channel changes are synchronized with the conversion process.

The channel inputs are configured using the AINP_m, Bits[4:0] and the AINM_m, Bits[4:0] in the CHANNEL_m registers. The device can be configured to have 8 differential inputs, 16 pseudodifferential inputs, or a combination of both.

When using differential inputs, use adjacent analog input pins to form the input pair. Using adjacent pins minimizes any mismatch between the channels.

Excitation Currents

The device contains two excitation currents, IEXC0 and IEXC1, that can be set independently to 100 nA, 10 μ A, 20 μ A, 50 μ A, 100 μ A, 150 μ A, and 200 μ A by setting the I_OUT0_n and I_OUT1_n bitfields in the CONFIG_n registers. See Table 4 for excitation currents specifications.

IEXC0 and IEXC1 can be configured to operate on any channel by setting the I_OUT0_CH_m and I_OUT1_CH_m bitfields in the CHANNEL_m registers. In addition, both currents can be output to the same analog input pin. The user can select the front-end settling time (SETTLE n bits in the FILTER n register) when mul-

tiplexing between channels, after which the conversion process begins.

The user can decide to turn off the excitation currents automatically when the device is in standby mode by setting the STB_EN_IEXC bit to 1 in the MISC register.

Note that the on-chip reference does not need to be enabled when using the excitation currents.

Bias Voltage Generator

A bias voltage generator is included on the AD4131-8. The bias voltage is selectable on all analog input channels. It biases the selected input pin to $(AV_{DD} - AV_{SS})/2$. This function is useful in thermocouple applications, as the voltage generated by the thermocouple must be biased around some DC voltage if the ADC operates from a single power supply. The bias voltage generator is controlled using the V_BIAS bitfield in the VBIAS_CONTROL register. The power-up time of the bias voltage generator is dependent on the load capacitance. See Table 4 for more details.

Secondary Reference Input

Two of the AD4131-8 inputs can be reconfigured to become the reference inputs instead.

General-Purpose Output

The AD4131-8 has four general-purpose outputs (GPOs), the P1 to P4 pins. These outputs are enabled using the GPO_CTRL_Px bits in the IO_CONTROL register (see Table 40). The pins can be pulled high or low using the GPO_DATA_Px bits in the register; that is, the value at the pin is determined by the setting of the GPO_DATA_Px bits. These pins can be used as GPOs, referenced between AVSS and AVDD.

When AV_{SS} is tied to DGND and IOV_{DD} is tied to AV_{DD} , these pins can operate as digital outputs with logic levels determined by AV_{DD} rather than by IOV_{DD} . In this configuration, some GPOs can be repurposed for different uses. The P2 (AIN3) pin can be selected to function as the interrupt source (see the Data Ready Signal section). The P4 pin (AIN5) can be selected to flag when the device is in standby mode (see the Power-Down Modes section).

Power-Down Switch

A low-side power switch (PSW) allows the user to power-down bridges that are interfaced to the ADC. In bridge applications such as strain gauges and load cells, the bridge itself consumes the majority of the current in the system. For example, a 350 Ω load cell requires 8.6 mA of current when excited with a 3 V supply. To minimize the current consumption of the system, the bridge can be disconnected, when not being used, using the bridge power-down switch. See Table 4 for the switch specifications. The control of the PSW can be automated by using the channel sequencer. Every

analog.com Rev. A | 45 of 99

THEORY OF OPERATION

channel configuration has a dedicated PDSW_m bitfield in the CHANNEL m register.

PROGRAMMABLE GAIN AMPLIFIER

When the gain stage is enabled, the output from the multiplexer is applied to the input of the PGA. The presence of the PGA means that signals of small amplitude can be gained within the AD4131-8 and still maintain excellent noise performance. The PGA can be programmed to have a gain of 1, 2, 4, 8, 16, 32, 64, or 128 by using the PGA bits in the respective CONFIG n register.

It is also possible to bypass the PGA by enabling the PGA_BYP_n bit in each CONFIG_n register. Once this bit is set to 1, the PGA is bypassed. Therefore, the gain control is not available and a gain of 1 is used. PGA bypass mode can be used to save power and reduce the noise even further, at the expense of higher analog input

current. See the Power Specifications section and the Analog Input Currents section for further details.

The analog input range is ±V_{RFF}/gain. See Table 39.

Table 39. Absolute Input Range Examples

| PGA | 2.5 V Reference | | 1.25 V Reference | | | |
|------|-----------------|-----------|------------------|-----------|--|--|
| Gain | Unipolar | Bipolar | Unipolar | Bipolar | | |
| 1 | 0 to 2.5 V | ±2.5 V | 0 to 1.25 V | ±1.25 V | | |
| 32 | 0 to 78.12 mV | ±78.12 mV | 0 to 39.06 mV | ±39.06 mV | | |
| 128 | 0 to 19.53 mV | ±19.53 mV | 0 to 9.76 mV | ±9.76 mV | | |

For high reference values, for example, V_{REF} = AV_{DD} , the analog input range must be limited. Consult Table 2 for more details on these limits.

Table 40. IO_CONTROL Register

| Addr. | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset | RW |
|-------|----------------|--------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|--------|-----|
| 0x03 | IO_CONT ROL | [15:8] | | | | | | SYNCB_CLE AR | INT_PI | N_SEL | 0x0000 | R/W |
| | | [7:0] | GPO_DATA_ P4 | GPO_DATA_ P3 | GPO_DATA_ P2 | GPO_DATA_ P1 | GPO_CTRL_ P4 | GPO_CTRL_ P3 | GPO_CTRL_ P2 | GPO_CTRL_ P1 | | |

analog.com Rev. A | 46 of 99

THEORY OF OPERATION

OTHER FEATURES

Calibration

Both internal calibration and system calibration are available on chip; therefore, the user has the option of removing offset or gain errors internal to the device only, or removing the offset or gain errors of the complete end system. See the ADC Calibration section.

Sequencer

The AD4131-8 allows up to 16 channels, and up to eight different ADC setups to be preconfigured and selected for each channel. The sequencer automatically converts all enabled channels. See the Channel Sequencer section for full details.

Diagnostics

The AD4131-8 includes numerous diagnostics features that allow a high level of fault coverage in an application, such as:

- ▶ Reference detection
- Overvoltage/undervoltage detection
- ► ADC functionality checks
- ▶ CRC on SPI communications
- ▶ CRC on the memory map
- ▶ SPI read/write checks

See the Diagnostics section for full details.

POWER SUPPLIES

The device has two independent power supply pins: AV_{DD} and IOV_{DD} .

 $\rm AV_{DD}$ is referred to $\rm AV_{SS}$ and powers the internal analog regulator that supplies the ADC. The $\rm AV_{DD}$ – $\rm AV_{SS}$ supply range is from 1.71 V to 3.6 V.

AV $_{\rm SS}$ is either tied to DGND or it can be taken below 0 V to provide a dual power supply to the AD4131-8. For example, AV $_{\rm SS}$ can be tied to –1.8 V and AV $_{\rm DD}$ can be tied to +1.8 V, providing a ±1.8 V supply to the ADC. The AV $_{\rm SS}$ supply range is from –1.8 V to 0 V with respect to DGND.

 $\rm IOV_{DD}$ is referred to DGND and sets the interface logic levels on the SPI, and powers an internal regulator for operation of the digital processing. The digital $\rm IOV_{DD}$ supply can vary between 1.65 V to 3.6 V with respect to DGND.

The low supply range option is advantageous for battery-powered operation, with the AD4131-8 performance still achievable with a single supply for both AV_{DD} and IOV_{DD} as low as 1.71 V.

See the Power Schemes section and the Recommended Decoupling section.

Internal LDOs

The two internal LDOs power the analog and digital domains separately. A decoupling capacitor of 0.1 μ F is required on the REGCAPA and REGCAPD pins, which are the outputs of the AV_{DD} and IOV_{DD} LDOs, respectively.

Power-On Reset

The AD4131-8 is designed to generate a power-on reset (POR) signal when the IOV_{DD} voltage is first applied, as shown in Figure 69. A POR resets the state of the user configuration registers. If IOV_{DD} and the digital LDOs drop below their specified operating range, a POR occurs. A drop on AV_{DD} and the analog LDO does not trigger a reset of the device.

The POR_FLAG in the status register (see Table 47) is set to 1 if IOV_{DD} or the digital LDO supply dips below the threshold, and is cleared when the user reads the status register.

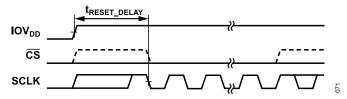


Figure 69. POR Timing Diagram

After power-on or software reset, the AD4131-8 default configuration is as follows:

- ► Channel: in the CHANNEL_0 register, the channel is enabled, AIN0 is selected as the positive input, and AIN1 is selected as the negative input. SETUP m = 0 is selected.
- ▶ ADC setup (SETUP_m bitfield): in the CONFIG_0 register, the excitation and burnout currents are off, the reference buffers are disabled, the external reference is selected, and the PGA gain is set to 1. In the FILTER_0 register, the sinc³ standalone filter is selected with FS, Bits[10:0] = 0x30.
- ▶ ADC control: in the ADC_CONTROL register (see Table 46), the AD4131-8 is in continuous conversion mode with continuous read disabled and the data coding set to offset binary, and the internal oscillator is enabled and selected as the main clock source. The internal reference is disabled, the CS pin is disabled (3-wire mode), and the status register content is not appended to the data output.
- Diagnostics: the only diagnostic enabled is the SPI_IG-NORE_ERR function.

Note that only a few of the register setting options are shown; this list is just an example. For full register information, see the AD4131-8 Registers section.

POWER-DOWN MODES

The AD4131-8 has multiple power-down modes that can be selected using the MODE bits in the ADC_CONTROL register (see

analog.com Rev. A | 47 of 99

THEORY OF OPERATION

Table 46). The MODE bits also select the different ADC conversion modes. In Table 41, only the power-down mode options are listed.

Table 41. Power-Down Mode Options

| MODE | ADC Conversion Mode |
|--------|---------------------|
| 0b0010 | Standby |
| 0b0011 | Power-down |
| 0b0100 | Idle |

Power-Down Mode

Power-down mode is the lowest power mode of the AD4131-8. All blocks are powered down, with no register information retained. To go to power-down mode, the device must be in standby mode. Otherwise, the device goes to continuous conversion mode. This procedure serves as a safety feature to prevent accidental/unwanted transitions to power-down mode.

To exit the power-down mode, the user must reset the device. See the Device Reset section.

Idle Mode

The modulator and digital filter are held in reset in idle mode. All user registers retain their content as previously configured. Note that in idle mode, there is no significant change in current consumption with respect to continuous conversion mode.

To exit idle mode, write to the MODE bits in the ADC_CONTROL register to select a different mode of operation.

Standby Mode

In standby mode and in standby during duty cycling, the register contents are retained, and the RDYB bit in the status register (see Table 47) is set to 1. The same standby signal can be driven to the P2 pin (AlN3) by setting the STBY_OUT_EN bit in the MISC register to 1.

In the MISC register, the user can select which functionality is kept enabled in standby mode, as follows:

- ▶ The diagnostic functionality can be kept enabled by setting the STBY_EN_DIAGNOSTICS bit to 1. Some diagnostics also require the internal oscillator to be enabled. Therefore, if those errors are enabled in the ERROR_EN register and STBY_EN_ DIAGNOSTICS = 1, the internal oscillator is kept enabled.
- ► The GPO signals can be kept enabled by setting the STBY GPO EN bit to 1.
- The power-down switch can be kept enabled by setting the STBY PDSW EN bit to 1.
- ► The burnout currents can be kept enabled by setting the STBY BURNOUT EN bit to 1.
- ► The VBIAS can be kept enabled by setting the STBY_VBIAS_EN bit to 1.
- ► The excitation currents can be kept enabled by setting the STBY IEXC EN bit to 1.
- ▶ The internal reference can be kept enabled by setting the STBY_REFHOL_EN bit and the STBY_INTREF_EN bit to 1.

To exit standby mode, write to the MODE bits in the ADC_CON-TROL register to select a different mode of operation. See the Out of Standby Mode Timing section for further details.

analog.com Rev. A | 48 of 99

DIGITAL INTERFACE

The AD4131-8 has a 4-wire (\$\overline{CS}\$, SCLK, DIN, and DOUT) or 3-wire (\$CLK, DIN, and DOUT) SPI that is compatible with QSPI™ and MICROWIRE™ interface standards, as well as most digital signal processors (DSPs). The interface operates in SPI Mode 3 and can be operated with \$\overline{CS}\$ tied low (3-wire). In SPI Mode 3, SCLK idles high, the falling edge of SCLK is the drive edge, and the rising edge of SCLK is the sample edge as described in Figure 70. This means that data on DIN is clocked in on the rising edge of SCLK, and data on DOUT is clocked out on the falling edge of SCLK. To readback DOUT, use the rising edge of SCLK or follow the tDOUT_VALID timing to sample the DOUT signal. The SCLK pin has a Schmitt triggered input, making the interface suitable for opto-isolated applications. Additional interface pins are INT and \$\overline{SYNC}\$.

Table 9 shows the timing specifications.

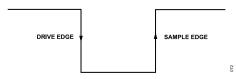


Figure 70. SPI Mode 3, SCLK Edges

The logic level of the AD4131-8 digital interface is set by the IOV_{DD} voltage, and can range from 1.65 V to 3.6 V.

ACCESSING THE REGISTER MAP

The communications register (COMMS) controls access to the full register map of the ADC. This register is an 8-bit, write only register (see Table 42). On power-up or after a software reset, the digital interface defaults to a state where it expects a write to the communications register. Therefore, all communications to the device must start with a write operation to the communications register.

The data written to the communications register determines whether the next operation is a read or write operation (R/\overline{W} bit), and which register is accessed (RS, Bits[5:0]). The MSB in the 8-bit COMMS register must be set to 0 to enable a write (\overline{WEN} bit). If \overline{WEN} is set to 1 during the transaction, the device does not clock on to subsequent bits in the register.

In situations where the interface synchronization is lost, if \overline{CS} is used, returning \overline{CS} high resets the digital interface to its default state and aborts any current operation. This operation does not reset the device registers to their default value (see the Device Reset section).

When the read or write operation to the selected register is complete, the interface returns to its default state, where it expects a write operation to the communications register.

Figure 71 and Figure 72 show writing to and reading from a register by first writing the 8-bit command to the communications register, followed by the data for the addressed register. The data length on DOUT varies from 8-bit, 16-bit, 24-bit, and 32-bit, depending on the register selected and the SPI CRC being enabled.

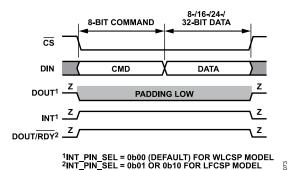


Figure 71. Writing to a Register (8-Bit Command with Register Address Followed by Data)

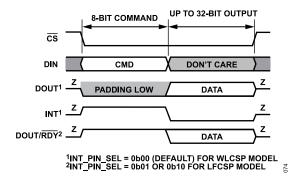


Figure 72. Reading from a Register (8-Bit Command with Register Address Followed by Data)

Device Identification

Reading the ID register is the recommended method for verifying the correct communication with the device. The ID register is a read-only register. The communication register and ID register details are described in Table 43 and in the Identification Register section.

Table 42. Communications Register

| TUDIC TE | Communicatio | no register | | | | | | | | | | |
|-----------|--------------|-------------|-------|----------|-------|-------|---------|--------|-------|-------|-------------------|----|
| Reg. | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset | RW |
| 0x00 | COMMS | [7:0] | WEN | R/W | | | RS | S[5:0] | | | 0x00 | W |
| Table 43. | ID Register | | | | | | | | | | | |
| Reg. | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset | RW |
| 0x05 | ID | [7:0] | | RESERVED | | | SILICON | l ID | MODEL | ID | 0x0X ¹ | R |

analog.com Rev. A | 49 of 99

DIGITAL INTERFACE

See the Identification Register section for details.

DEVICE RESET

The circuitry and serial interface of the AD4131-8 can be reset by writing 64 consecutive 1s to the device. This action resets the logic, the digital filter, and the analog modulator, and all on-chip registers are reset to their default values. A reset is useful if the serial interface becomes asynchronous due to noise on the SCLK line

Figure 73 shows a software reset timing diagram.

The AD4131-8 requires a minimum delay between any reset event and a register read/write transaction.

This delay is shown in Figure 73, and represented by t_{RESET_DELAY} in Table 9. If the digital host attempts to perform an SPI transaction before the device is ready, the transaction may not succeed and the SPI_IGNORE_ERR bit in the error register is set. The SPI_IGNORE_ERR is a read and write 1 to clear (R/W1C) type of bit. The POR_FLAG bit in the status register (see Table 47) is set to 1 when the reset is initiated, and then is set to 0 when the bit is read.

A reset is automatically performed at power-up as shown in Figure 69.

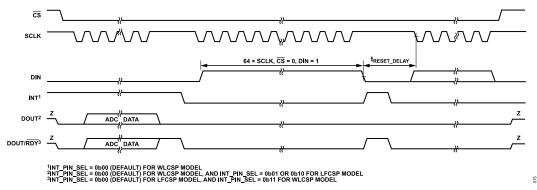


Figure 73. Software Reset Timing Diagram

analog.com Rev. A | 50 of 99

ADC CONFIGURATION AND OPERATIONS

The AD4131-8 is flexible in its configurability and modes of opera-

BIPOLAR/UNIPOLAR CONFIGURATION

The analog inputs to the AD4131-8 can accept either unipolar or bipolar input voltage ranges. Unipolar and bipolar signals on the AINP input are referenced to the voltage on the AINM input. The input voltages on AINP and AINM need to be between AV_{DD} and AV_{SS} , following the specifications in Table 2.

Data Output Coding

The bipolar bit in the ADC_CONTROL register (see Table 46) determines the data output coding of the ADC data, and how the device applies the offset and gain coefficients in the postprocessing. See the ADC Calibration section.

By default, the bipolar bit is set to 1, which corresponds to offset binary coding. This configuration is better used to represent bipolar input voltages from $-V_{REF}$ /gain to V_{REF} /gain. If the bipolar bit is set to 1 for a unipolar input configuration, the input (AINP – AINM with AINP \geq AINM) is represented by an output code between 0x8000 (zero scale) and 0xFFFF (full scale).

When the bipolar bit is set to 0, the data output coding changes to natural (straight) binary. This configuration is better used to represent unipolar input voltages from 0 V to V_{REF} /gain. If the bipolar bit is set to 0 for a bipolar input configuration, all cases where AINP < AINM are clamped at 0x0000 (zero scale).

Table 44 shows the data output coding options and respective output code equations for any analog input voltage.

Table 44. ADC Data Output Coding Options

| Bipolar Bit | Data Output Coding | Output Code Equation ¹ |
|---------------|--------------------|--|
| 0b0 | Straight binary | Code = $(2^N \times V_{IN} \times Gain)/V_{REF}$ |
| 0b1 (default) | Offset binary | Code = $2^{N-1} \times ((V_{IN} \times Gain/V_{REF}) + 1)$ |

N = 16, V_{IN} is the differential input voltage, and Gain is the gain setting (1 to 128).

Table 45 shows the expected correspondence between input signals and the relative output coding depending on the choice for the bipolar bit in the ADC CONTROL register.

Table 45. Ideal Output Codes for a Given Input Differential Signal

| • | | |
|-----------------------|-------------------|-------------------|
| AINP - AINM | Bipolar Bit = 0b0 | Bipolar Bit = 0b1 |
| Negative Full Scale | 0x0000 | 0x0000 |
| Zero Scale | 0x0000 | 0x8000 |
| Mid Scale | 0x8000 | N/A ¹ |
| (Positive) Full Scale | 0xFFFF | 0xFFFF |

¹ N/A means not applicable.

STATUS BITS

The contents of the status register (see Table 47) can be appended to each conversion on the AD4131-8. This function is useful if several channels are enabled. Each time a conversion is output, the contents of the status register are appended and the format for reading the data register becomes: DATA[15:0], STATUS[7:0]. The four LSBs of the status register (CH_ACTIVE bitfield) indicate to which channel the conversion corresponds. In addition, the user can check the POR_FLAG bit and determine if any errors are being flagged through the MAIN_ERR bit. To append the status register contents to every conversion, set the DATA_STATUS bit in the ADC_CONTROL register is set to 1 (see Table 46).

Table 46. ADC CONTROL Register

| Addr. | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset | RW |
|-------|-----------------|--------|----------|--------------------|-----------------|------------------|---------------|-----------------|--------|----------------|--------|-----|
| 0x01 | ADC_CON TROL | [15:8] | RESERVED | BIPOLAR | INT_REF_VA L | DOUT_DIS_ DEL | CONT_REA D | DATA_STAT US | CSB_EN | INT_REF_E N | 0x4000 | R/W |
| | | [7:0] | RESERVED | DUTY_CY C_RATIO | | MODE | | CLK_ | SEL | | | |

Table 47. Status Register

| Addr. | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset | RW |
|-------|--------|-------|-------|----------|----------|----------|-------|-------|--------|-------|-------|----|
| 0x00 | STATUS | [7:0] | RDY | MAIN_ERR | RESERVED | POR_FLAG | | | ACTIVE | | 0x10 | R |

Table 48. CHANNEL 0 Register

| Addr. | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset | RW |
|-----------------|---------------|---------|----------|------------|---------|-------|--------|----------------|---------|-------------|-----------------------|-----|
| 0x09 to 0x18 | CHANNEL _0 | [23:16] | ENABLE_m | | SETUP_m | | PDSW_m | THRES_EN_ m | , | AINP_m[4:3] | 0xXXXXXX ¹ | R/W |
| | | [15:8] | | AINP_m[2:0 | | | | AINM_m | | | | |
| | | [7:0] | | I_OUT | 1_CH_m | | | I_OU | T0_CH_m | | | |

The CHANNEL 0 default value is 0x800100. The default value of all other channels is 0x000100.

analog.com Rev. A | 51 of 99

ADC CONFIGURATION AND OPERATIONS

Table 49. CHANNEL m Register (m = 1 to 15)

| Addr. | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset | RW |
|-----------------|--------------------------------|---------|----------|-------------|---------|-------|-------|----------|-------|-------------|-----------------------|-----|
| 0x09 to 0x18 | CHANNEL _m (m = 1 to 15) | [23:16] | ENABLE_m | | SETUP_m | | RES | RESERVED | | AINP_m[4:3] | 0xXXXXXX ¹ | R/W |
| | | [15:8] | | AINP_m[2:0] | | | | AINM_m | | | | |
| | | [7:0] | | | | RESE | RVED | | | | | |

The CHANNEL_0 default value is 0x800100. The default value of all other channels is 0x000100.

CHANNEL SEQUENCER

The AD4131-8 allows up to 16 channels to be configured and enabled in the CHANNEL_m registers. Each enabled channel becomes part of an automatic sequence that can be left running while the host processor sleeps.

The CHANNEL m registers allow the user to do the following:

- Select the plus and minus inputs (AINP_m and AINM_m bitfields)
- Assign the excitation currents to specific pins (I_OUT0_CH_0 and I_OUT1_CH_1 bitfields)
- ▶ Select the ADC setup (SETUP m bitfield)
- ► Enable the power-down switch and thresholds (PDSW_m and THRES EN m bitfields)
- ▶ Enable the channel to become part of the sequence (ENA-BLE_m bitfield).

See Table 48 for details.

When multiple channels are enabled with different configurations selected, the AD4131-8 automatically cycles through the channels in all conversion modes. Sequencing starts from the lowest enabled channel in increasing order up to the largest enabled channel. When each enabled channel is selected, the time required to start the first conversion is equal to the front-end settling time for the selected channel (32 MCLKs).

analog.com Rev. A | 52 of 99

ADC CONFIGURATION AND OPERATIONS

ADC Setups

For each channel, a predefined ADC setup can be selected (SET-UP_m bits in the CHANNEL_m registers). The AD4131-8 allows up to eight different ADC setups, with each ADC setup consisting of configuration, filter, gain, and offset settings.

For example, SETUP_m = 0 (ADC Setup 0) consists of the CONFIG_0 register, FILTER_0 register, OFFSET_0 register, and GAIN_0 register. Figure 74 shows the grouping of these registers. Table 50 through Table 53 show the four registers that are associated with each ADC setup.

Table 50. CONFIG n Register (n = 0 to 7)

| Addr. | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset | RW |
|-----------------|------------------------------|--------|-----------------------------------|-------|-------|----------|-------|-------|---------------|--------|-------|----|
| 0x19 to 0x20 | CONFIG_ n (n = 0 to 7) | [15:8] | I_OUT1_n | | | I_OUT0_n | | BURNO | OUT_n | 0x0000 | R/W | |
| | | [7:0] | REF_BUFP_ REF_BUFM REF_SEL_n n _n | | | | PGA_n | | PGA_BYP_ n | | | |

Table 51. FILTER n Register (n = 0 to 7)

| Addr. | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset | RW |
|-----------------|-----------------------------|---------|-------|-----------------------------------|-------|-------|-------|-------|----------|-------|-------|----|
| 0x21 to 0x28 | FILTER_n (n = 0 to 7) | [23:16] | | RESERVED (| | | | | 0x002030 | R/W | | |
| | | [15:8] | | FILTER_MODE_n RESERVED FS_n[10:8] | | | | | | | | |
| | | [7:0] | | FS_n[7:0] | | | | | | | | |

Table 52. OFFSET n Register (n = 0 to 7)

| Addr. | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset | RW |
|-----------------|------------------------------|--------|-------|-------|-------|-------|-----------|-------|-------|-------|--------|-----|
| 0x29 to 0x30 | OFFSET_ n (n = 0 to 7) | [15:8] | | | | OFFSE | T_n[15:8] | | | | 0x8000 | R/W |
| | | [7:0] | | | | OFFSI | ET_n[7:0] | | | | | |

Table 53. $GAIN_n$ Register (n = 0 to 7)

| Addr. | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset | RW |
|-----------------|------------------------|--------|-------|--------------|-------|-------|----------|-------|--------|-------|-------|----|
| 0x31 to 0x38 | GAIN_n (n = 0 to 7) | [15:8] | | GAIN_n[15:8] | | | | | 0xXXXX | R/W | | |
| | | [7:0] | | | | GAIN | I_n[7:0] | | | | | |

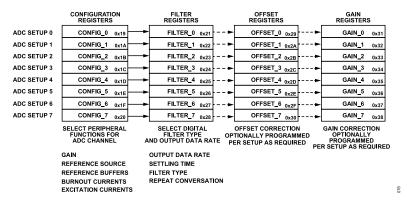


Figure 74. ADC Setup Register Grouping

analog.com Rev. A | 53 of 99

ADC CONFIGURATION AND OPERATIONS

Configuration Registers

The CONFIG in registers allow the user to do the following:

- Set the PGA gain (PGA n bitfield)
- ▶ Set the PGA mode (PGA BYP n bitfield)
- ▶ Select the reference source (REF SEL n bitfield)
- ► Enable the reference buffers (REF_BUFP_n and REF_BUFM_n bitfields)
- ▶ Enable and select the burnout currents (BURNOUT n bitfield)
- ► Enable and select the excitation currents (I_OUT1_n and I_OUT2_n bitfields)

See Table 50 for details.

Filter Registers

The FILTER n registers allow the user to do the following:

- Select the digital filter at the output of the ADC modulator (FILTER MODE n bitfield)
- ▶ Select the FS value applied to the filter (FS n, Bits[10:0])
- Select how many times to convert on this ADC setup, from 1 to 32 times (REPEAT n bitfield)
- ▶ Set the front-end settling time (SETTLE_n bitfield), to allow the sensor output to reach a settled value before conversion starts.

See Table 51 for details.

Offset and Gain Registers

Offset and gain settings are used to make adjustments to the data output after a calibration on the channel associated to that ADC setup is performed. Programming the gain and offset registers is optional for any use case, as indicated by the dashed lines between the register blocks in Figure 74. If an internal or system offset or full-scale calibration is performed, the gain and offset registers for the selected channel are automatically updated. See the ADC Calibration section for more details. See Table 52 and Table 53.

ADC CONVERSION MODES

There are multiple conversion modes available on the AD4131-8 that can be selected using the MODE bits in the ADC_CONTROL register (see Table 46). The MODE bits also select the different power-down modes. In Table 54, only the ADC conversion mode options are listed.

Table 54. ADC Conversion Mode Options

| MODE | ADC Conversion Mode |
|------------------|--------------------------------|
| 0b0000 (Default) | Continuous conversion |
| 0b0001 | Single sequence |
| 0b1001 | Duty cycling |
| 0b1010 | Single sequence + idle by SYNC |
| 0b1011 | Single sequence + STBY by SYNC |

Continuous Conversion Mode

Continuous conversion mode is the default mode. The ADC continuously converts on each enabled channel. When the sequence is complete, the ADC starts again with the lowest enabled channel.

Single Sequence Modes

In single sequence mode, the AD4131-8 performs a single sequence of conversions and is placed in standby mode after the conversions are complete. If more than one channel is enabled, the ADC automatically sequences through the enabled channels once, before entering standby mode. Select MODE = 0b0001 to enable the single sequence mode. When the AD4131-8 is converting in single sequence mode, SPI writes are ignored.

The single sequence conversion can also be controlled externally using the \$\overline{SYNC}\$ pin. Select MODE = 0b1010 in the ADC_CONTROL register to enable the single sequence + idle by \$\overline{SYNC}\$ mode. In this mode, the \$\overline{SYNC}\$ pin can be pulsed low to take the device out of idle mode and initiate a new single sequence. In idle mode, the modulator and digital filter are held in reset. Select MODE = 0b1011 in the ADC_CONTROL register to enable the single sequence + STBY by \$\overline{SYNC}\$ mode. In this mode, the SYNC pin can be pulsed low to take the device out of standby and initiate a new sequence of conversions. In standby, the register content is retained. See the \$\overline{System Synchronization section}

Note that the time in between \$\overline{SYNC}\$ pin pulses must be greater than the single sequence conversions time to allow the device to go into idle or standby mode in between \$\overline{SYNC}\$ pin pulses and avoid timing issues, as shown in Figure 75 or Figure 77. The \$\overline{SYNC}\$ pin rate can be used to determine the sample rate per channel in the sequence. See the \$\overline{System Synchronization section.}

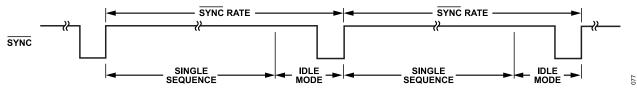


Figure 75. Example of Single Sequence + Idle by SYNC Mode Diagram

analog.com Rev. A | 54 of 99

ADC CONFIGURATION AND OPERATIONS

¹DIAGRAM NOT TO SCALE

| DUTY_CYC_ | ~25% ~75% ACTIVE TIME STANDBY TIME | | ~25% | ~75% |
|---------------------------|------------------------------------|----------------------------|--------------------------|----------------------------|
| RATIO = 1/4 | | | ACTIVE TIME | STANDBY TIME |
| DUTY_CYC_ RATIO = 1/16 | ~6.25% ACTIVE TIME | ~93.75% STANDBY TIME | ~6.25% ACTIVE TIME | ~93.75% STANDBY TIME |

078

Figure 76. Duty Cycling Mode Diagram

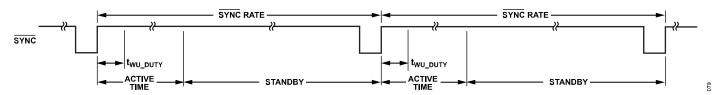


Figure 77. Example of Single Sequence + STBY by SYNC Mode Diagram

analog.com Rev. A | 55 of 99

ADC CONFIGURATION AND OPERATIONS

Duty Cycling Mode

In duty cycling mode, the device continuously cycles autonomously between active and standby modes for added savings in power consumption. The ADC converts on each enabled channel and then enters standby mode. When a cycle is complete, the cycle begins again with an ADC conversion on the lowest enabled channel. Set the MODE bitfield in the ADC_CONTROL register to 1001 to enable autonomous duty cycling mode. In this mode, the duty cycling ratio is set to 1/4 by default, which means that the device is active ~25% of the time and in standby the rest of the time. The autonomous duty cycle ratio can be changed to 1/16 by setting the DUTY_CYC_RATIO bitfield value in the ADC_CONTROL register to 1. See Figure 76.

When using the internal reference for conversions on some or all of the channels in the duty cycling sequence, it is recommended to set the STBY_REFHOL_EN bit to 1 in the MISC register, to reduce the impact of the internal reference continuously turning on and off. See the Standby Mode section for more details on the blocks that can be kept active when in standby during duty cycling.

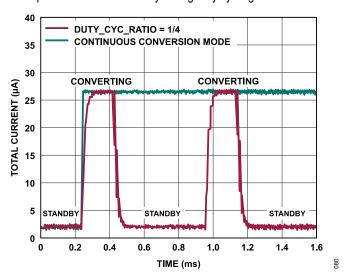


Figure 78. Example of Duty Cycling Mode vs. Continuous Conversion Mode Current Consumption

DATA READY SIGNAL

When an ADC conversion completes, the RDYB bit in the status register (see Table 47) changes from 1 to 0. A data ready signal indicating that the ADC result is in the data register and ready to be readback can also be generated internally. By default, the AD4131-8 for the LFCSP devices, the data output pin shares this functionality (DOUT/RDY) while the WLCSP has a dedicated INT pin for the data ready signal. The data ready signal returns high after a read of the ADC.

If the ADC result in the data register is not read, the data ready signal stays low until the next conversion is about to become

available. The minimum data ready high time if data ready is low and the next conversion is available is called t_{RDYH} and can be found in Table 9 and Figure 9.

When the continuous read mode is disabled (see the Continuous Read Mode section), the same data can be read again, if required, while the data ready signal is high, although subsequent reads must not occur close to the next output update. When continuous read mode is enabled, an ADC result can be read only once.

CONTINUOUS READ MODE

Continuous read mode is a different interface mode to access ADC data. In continuous read mode, it is not required to write to the COMMS register to read the data register. In this mode, the data ready signal acts as a framing signal for the output data. SCLKs are ignored until the data ready signal goes low to indicate the end of a conversion. Apply the required number of SCLKs after the data ready signal goes low to read the conversion result in the data register. When the conversion result is read, the data ready signal returns high until the next conversion result is available. In this mode, the data can be read only once. Ensure that each sample data is read before the next conversion is complete. If the user has not read the previous conversion result before the completion of the next conversion, or if insufficient serial clocks are applied to read the result, the serial output register is reset when the next conversion is complete, and the new conversion result is placed in the output serial register.

To enable continuous read mode, set the CONT_READ bit in the ADC_CONTROL register (see Table 46). When this bit is set, the only serial interface operations possible are reads from the data register. Therefore, the write to this register is the last in the sequence of configuration writes to the device.

To exit continuous read mode, write a read data command (0x42) while the data ready signal is low. If CRC is enabled, a presumed CRC command byte of 0x42 precedes the data and must be considered when validating CRC, but no CRC is needed when sending the 0x42 command. Alternatively, to exit continuous read mode, apply a software reset, that is, 64 SCLKs with $\overline{\text{CS}}$ = 0 and DIN = 1 (see Figure 73). This resets the ADC and all register contents. These are the only commands that the interface recognizes after it is placed in continuous read mode. DIN must be held low in continuous read mode until an instruction is to be written to the device.

If multiple ADC channels are enabled, each channel is output in turn, with the status register content being appended to the data if DATA_STATUS bit is set in the ADC_CONTROL register. The status register includes the channel to which the conversion corresponds.

analog.com Rev. A | 56 of 99

ADC CONFIGURATION AND OPERATIONS

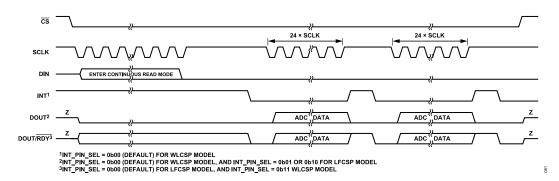


Figure 79. Enter Continuous Read Mode Diagram (DATA_STATUS = 0)

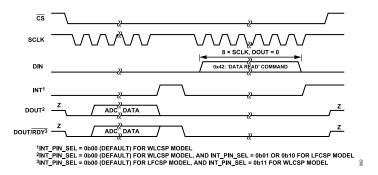


Figure 80. Exit Continuous Read Mode Diagram (CRC Disabled)

analog.com Rev. A | 57 of 99

ADC CONFIGURATION AND OPERATIONS

SYSTEM SYNCHRONIZATION

The SYNC pin input can facilitate several operations. By default, if held low, this pin can keep the modulator, the digital filter, and the calibration control logic in a reset state, without affecting any of the configuration conditions on the device. This allows the user to start gathering samples of the analog input from a known point in time, that is, the rising edge of SYNC. Take SYNC low for at least t_{SYNC PW} to implement the synchronization function (see the Timing Specifications section). SYNC does not affect the digital interface but does reset the data ready signal to a high state if it is low. A falling edge on the SYNC pin resets the digital filter and the analog modulator and places the AD4131-8 into a consistent, known state. While the SYNC pin is low, the AD4131-8 is maintained in this state. On the SYNC rising edge, the modulator and filter exit this reset state, and the device starts to gather input samples again. The SYNC pin is sampled on the falling edge of MCLK. Therefore, for applications where deterministic timing is required, it is recommended that the SYNC pin changes value on the external MCLK (CLK) rising edge.

Initiate Conversions

The SYNC pin can be used as a start conversion command. Hold SYNC pin low at power-up and while configuring the AD4131-8. Then, when ready, use the rising edge of SYNC to start the conversion or series of conversions depending on the ADC mode selected. The falling edges of the data ready signal indicate when each conversion is complete, and the ADC result can be read from the data register.

Synchronize Multiple AD4131-8 Devices

The \$\overline{SYNC}\$ pin can be used to synchronize multiple AD4131-8 devices operated from a common external MCLK, so that their data registers are updated simultaneously. This functionality is available at power-up by default. A low pulse on the \$\overline{SYNC}\$ pin connected to multiple devices is normally issued after each AD4131-8 performs its own calibration or has calibration coefficients loaded into its calibration registers. The conversions from the AD4131-8 devices are then synchronized.

The device exits reset on the MCLK falling edge following the SYNC low to high transition. Therefore, when multiple devices are being synchronized, pull the SYNC pin high on the MCLK rising edge to ensure that all devices begin sampling on the MCLK falling edge. If the SYNC pin is not taken high in sufficient time, it is possible to have a difference of one main clock cycle between the devices; that is, the instant at which conversions are available differs from device to device by a maximum of one main clock cycle.

Other Synchronization Modes

The SYNC pin functionality can be changed to take the device out of idle when in single sequence + idle by SYNC mode, or take the

device out of standby when in single sequence + STBY by SYNC mode. See the ADC Conversion Modes section for more details.

ADC CALIBRATION

After each conversion, the ADC conversion result is scaled using the ADC calibration coefficients stored in the OFFSET_n and GAIN_n registers before being written to the data register. The postprocessing time needed for this activity is called digital postprocessing (DPP) time. The default value of the OFFSET_n registers is 0x8000 and the nominal value of the GAIN_n registers is 0x5555.

Both internal calibration and system calibration are available in the AD4131-8 to update the OFFSET_n and GAIN_n registers. Therefore, the user has the option of removing offset or gain errors internal to the device only and removing the offset or gain errors of the complete end system.

The AD4131-8 provides four calibration modes as shown in Table 55 that can be used to eliminate the offset and gain errors on a per ADC setup basis.

Table 55. ADC Calibration Mode Options

| MODE | ADC Calibration Mode |
|--------|--|
| 0b0101 | Internal offset calibration (zero scale) |
| 0b0110 | Internal gain calibration (full scale) |
| 0b0111 | System offset calibration (zero scale) |
| 0b1000 | System gain calibration (full scale) |

An internal or system offset calibration reduces the offset error to the order of the noise. The gain error is factory calibrated at ambient temperature and at a gain of 1 with PGA_BYP_n = 0. Therefore, internal gain calibrations at a gain of 1 with PGA_BYP_n = 0 are not supported on the AD4131-8. For other gain values, a system gain calibration reduces the gain error to the order of the noise.

Only one channel can be active during calibration. From an operational point of view, treat a calibration like another ADC conversion. Set the system software to monitor the RDYB bit in the status register (see Table 47) or the data ready signal to determine the end of a calibration via a polling sequence or an interrupt driven routine. To start a calibration, write the relevant value to the MODE bits in the ADC_CONTROL register (see Table 46). The data ready signal goes high and the RDYB bit in the status register is set to 1 when the calibration initiates. When the calibration is complete, the content of the corresponding OFFSET_n or GAIN_n registers is updated, the RDYB bit in the status register is set to 0, the data ready signal returns low (if \overline{CS} is low), and the AD4131-8 reverts to idle mode.

A calibration can be performed at any output data rate. Using lower output data rates results in better calibration accuracy also for higher output data rates. A new calibration is required for a given channel if the reference source or the gain for that channel is changed (using the PGA_n bitfields of the CONFIG_n registers).

The following equations show the calculations that are used to scale data based on offset and gain calibration coefficients.

analog.com Rev. A | 58 of 99

ADC CONFIGURATION AND OPERATIONS

In unipolar mode (bipolar bit = 0b0 in the ADC CONTROL register):

$$DATA = \left(\frac{0.75 \times V_{IN}}{V_{REF}} \times 2^{N-1} - (OFFSET_n - 0x8000)\right) \times \frac{GAIN_n}{0x4000} \times 2$$

In bipolar mode (bipolar bit = 0b1 in the ADC CONTROL register):

$$DATA = \left(\frac{0.75 \times V_{IN}}{V_{REF}} \times 2^{N-1} - (OFFSET_n - 0x8000)\right) \times \frac{GAIN_n}{0x4000} + 0x8000$$

where:

DATA is the code written in the data register after postprocessing. V_{IN} is the differential voltage at the input of the converted channel (AINP – AINM).

N is the number of bits of the ADC (16).

OFFSET_n is the hexadecimal code written in the relative OFF-SET_n register of the converted channel.

GAIN_n is the hexadecimal code written in the relative GAIN_n register of the converted channel.

The AD4131-8 provides the user with access to the on-chip calibration registers, allowing the microprocessor to read the calibration coefficients of the device or to write its own calibration coefficients. A read or write of the OFFSET_n and GAIN_n registers can be performed at any time except during an internal or system calibration. The values in the calibration registers are 16 bits wide. The input span and offset of the device can also be manipulated using these registers. See the System Calibration Span and Offset Limits section for more details.

The AD4131-8 can run background checks during calibration. To enable this functionality, set the ADC_ERR_EN bit in the ER-ROR_EN register to 1. If an error occurs, the ADC_ERR bit in the error register is set. See the ADC Errors section for more details.

If the user is concerned about verifying that a valid reference is in place every time a calibration is performed, check the status of the REF_DETECT_ERR bit at the end of the calibration cycle.

Internal Gain Calibration

To perform an internal gain calibration, a full-scale input voltage generated internally, is automatically connected to the PGA inputs. A gain calibration is recommended each time the gain of a channel is changed to minimize the full-scale error caused by the new gain setting. When performing internal calibrations, the internal gain calibration must be performed before the internal offset calibration. Therefore, write the value 0x8000 to the OFFSET_n register of the selected channel before performing the internal gain calibration, which ensures that the OFFSET_n register is at its default value. If the reference voltage is higher than 2 V, set the CAL_RANGE_X2 bit in the MISC register to 1 to improve the outcome of the internal gain calibration. The AD4131-8 is factory calibrated at ambient temperature and with a gain of 1 with PGA_BYP_n = 0, and the

resulting gain coefficients are loaded to the GAIN_n registers of the device as default value. The device does not support further internal gain calibrations at a gain of 1 (PGA_BYP_n = 0). An internal gain calibration requires a time equal to four first conversions of the selected configuration on that channel to be completed.

Internal Offset Calibration

During an internal offset calibration, the selected positive analog input pin is disconnected, and it is connected internally to the selected negative analog input pin. For this reason, it is necessary to ensure that the voltage on the selected negative analog input pin does not exceed the allowed limits and is free from excessive noise and interference. When performing internal calibrations, the internal gain calibration must be performed before the internal offset calibration. An internal offset calibration requires a time equal to the first conversion of the selected configuration on that channel to be completed.

System Offset Calibration

A system offset calibration expects the system zero-scale voltages to be applied to the ADC pins before enabling the calibration mode. As a result, offset errors external to the ADC are removed. When performing system calibrations, system offset calibration must be performed before the system gain calibration. Internal calibrations must be performed before completing system calibrations. A system offset calibration requires a time equal to the first conversion of the selected configuration on that channel to be completed.

System Gain Calibration

A system gain calibration expects the system full-scale voltages to be applied to the ADC pins before enabling the calibration mode. As a result, gain errors external to the ADC are removed. When performing system calibrations, system offset calibration must be performed before the system gain calibration. Internal calibrations must be performed before completing system calibrations. A system gain calibration requires a time equal to the first conversion of the selected configuration on that channel to be completed.

System Calibration Span and Offset Limits

System calibration can be used to compensate for offset or gain errors in the external circuit and to manipulate the input span and offset of the device. Whenever system calibration is performed, the amount of input offset and span adjustments that can be accommodated is limited.

The input span is the difference between the input voltage that corresponds to full code and the input voltage that corresponds to zero code. The range of input span achievable with system calibration has a minimum value of 0.8 × V_{REF} /gain and a maximum value of 2.1 × V_{REF} /gain.

analog.com Rev. A | 59 of 99

ADC CONFIGURATION AND OPERATIONS

The input span and offset adjustment must also account for the limitation on the positive full code voltage (1.05 × $V_{REF}/gain$) and negative zero code voltage (-1.05 × $V_{REF}/gain$). See Table 2.

Therefore, in determining the limits for system offset (zero scale) and gain (full scale) calibrations, the user must ensure that the offset after adjustment plus the maximum positive span range after adjustment does not exceed $1.05 \times V_{RFF}/gain$.

The amount of offset and span adjustment that can be accommodated depends also on whether the configuration is unipolar or bipolar. This is best illustrated by looking at a few examples.

If the device is used in unipolar configuration (AINP \geq AINM), with a required span of 0.8 × V_{REF}/gain, the offset range that the system calibration can handle is from $-1.05 \times V_{REF}$ /gain to $+0.25 \times V_{REF}$ /gain, as shown in Figure 81.

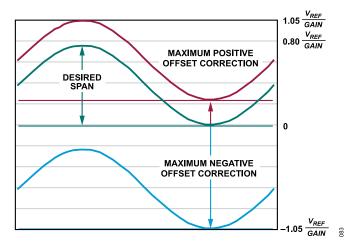


Figure 81. Example of Unipolar Span and Offset Calibration Limits

If the device is used in unipolar configuration with a required span of $V_{REF}/gain$, the offset range that the system calibration can handle is from $-1.05 \times V_{REF}/gain$ to $+0.05 \times V_{REF}/gain$. Similarly, if the device is used in unipolar configuration and required to remove an offset of $0.2 \times V_{REF}/gain$, the span range that the system calibration can handle is $0.85 \times V_{REF}/gain$.

If the device is used in bipolar configuration, with a required span of $\pm 0.4 \times V_{REF}/gain$, the offset range that the system calibration can handle is from $-0.65 \times V_{REF}/gain$ to $+0.65 \times V_{REF}/gain$, as shown in Figure 82.

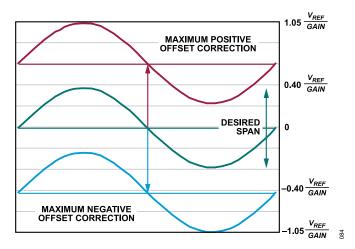


Figure 82. Example of Bipolar Span and Offset Calibration Limits

If the device is used in bipolar configuration with a required span of $\pm V_{REF}/gain$, the offset range the system calibration can handle is from $-0.05 \times V_{REF}/gain$ to $+0.05 \times V_{REF}/gain$. Similarly, if the device is used in bipolar configuration and required to remove an offset of $\pm 0.2 \times V_{REF}/gain$, the span range that the system calibration can handle is $\pm 0.85 \times V_{REF}/gain$.

analog.com Rev. A | 60 of 99

DIGITAL FILTERS

The AD4131-8 offers great flexibility in the digital filter scheme. The device has several filter options. The option selected affects the output data rate, first conversion time, input bandwidth, and 50 Hz and 60 Hz rejection. The FILTER_MODE_n bits in each FILTER_n register select between the filter types as shown in Table 57.

Depending on the filter selected, only certain FS values are allowed. The FS value determines the output data rate for all filters except the post filters. See Table 57 for a list of allowed FS values for the correspondent selected filter. See the Output Data Rate section for more details.

SINC³ AND SINC⁴ FILTERS

When the AD4131-8 is powered up, the sinc³ filter is selected by default. This filter allows the full range of ODR values, gives good noise performance, short first conversion time, and can offer 50 Hz and 60 Hz (±1 Hz) rejection.

A sinc⁴ filter can be used instead of the sinc³ filter. This filter is only available for ODR from 240 SPS to 2.4 kSPS. Therefore, the filter cannot achieve natural 50 Hz and/or 60 Hz rejection, but the filter has excellent noise performance with a slightly longer conversion time.

By programming the correct FS, the sinc standalone filters can achieve good rejection at the respective notch frequency (f_{NOTCH_STD}). The sinc³ and sinc⁴ filters place the first notch at

$$f_{NOTCH\ STD} = f_{MCLK}/(32 \times FS[10:0])$$

where:

 f_{MCLK} is the main clock frequency (76.8 kHz). FS[10:0] is the decimal equivalent of the FS_n bits in the FILTER_n register.

AVERAGING FILTERS

In averaging mode, a sinc¹ filter is included after the sinc³ or sinc⁴ filter. The sinc¹ filter averages by 8 (average). Both standalone

filters can be used in averaging mode selecting sinc³ + sinc¹ or sinc⁴ + sinc¹ in the FILTER_MODE_n bitfield of the FILTER_n register. The sinc¹ filter places additional notches starting at

 $f_{NOTCH AVG} = f_{NOTCH STD}/Avg$

where:

 f_{NOTCH_STD} is the first notch from sinc³ or sinc⁴ standalone filters. $Avg = \overline{8}$.

In averaging mode, there is almost no difference in the first conversion time on a new channel and subsequent conversions time on the same channel. The conversion time is near constant when converting on a single channel or when converting on several channels using the same filter.

POST FILTERS

The post filters can be applied after the sinc³ filter to provide rejection of 50 Hz and 60 Hz simultaneously and allow the user to trade off first conversion time and rejection. Each post filter operates at a specific ODR and can achieve simultaneous 50 Hz and 60 Hz rejection, as shown in Table 56. These filters can be selected in each FILTER_MODE_n bitfield. The FS, Bits[10:0] do not influence the ODR when the post filters are selected.

Table 56. Post Filters: Output Data Rate and Rejection

| Post Filter | ODR (SPS) | Rejection ¹ |
|-------------|-----------|----------------------------------|
| 1 | 26.087 | 53 dB at 50 Hz, 58 dB at 60 Hz |
| 2 | 24 | 70 dB at 50 Hz, 70 dB at 60 Hz |
| 3 | 19.355 | 99 dB at 50 Hz, 103 dB at 60 Hz |
| 4 | 16.21 | 103 dB at 50 Hz, 109 dB at 60 Hz |

 $^{^{1}~}$ The 50 Hz/60 Hz rejection is measured with a stable f_{MCLK} = 76.8 kHz, in a band of ± 0.5 Hz around 50 Hz and 60 Hz.

| Table 57. FILTER MODE n Bits and Filter | Table 57. | FILTER MC | DE n Bits | and Filter | Types |
|---|-----------|-----------|-----------|------------|-------|
|---|-----------|-----------|-----------|------------|-------|

| FILTER_ | | | | |
|----------------|---------------------------------------|------------------------------------|-----------------|--|
| MODE_n | Filter Type | FS Range (Hex) | ODR Range (SPS) | Comments |
| 0000 | Sinc ⁴ | 0x01 to 0xA (Dec.: 1 to 10) | 2400 to 240 | Excellent noise performance, long first conversion time, no natural 50/60 Hz rejection. FS > 0d10 is forced to FS = 0d10. |
| 0001 | Sinc ⁴ + sinc ¹ | 0x01 to 0xA (Dec.: 1 to 10) | 218.18 to 21.8 | Sinc ⁴ plus averaging by 8 filter. No first conversion delay. FS > 0d10 is forced to FS = 0d10. |
| 0010 (Default) | Sinc ³ | 0x01 to 0x7FF (Dec.: 1 to 2047) | 2400 to 1.17 | Good noise performance, moderate 50 Hz/ 60 Hz rejection, moderate first conversion time. |
| 0011 | Sinc ³ + REJ60 | 0x01 to 0x7FF (Dec.: 1 to 2047) | 2400 to 1.17 | With FS = 0d48, achieves simultaneous 50 Hz and 60 Hz rejection at 50 SPS ODR. |
| 0100 | Sinc ³ + sinc ¹ | 0x01 to 0x7FF (Dec.: 1 to 2047) | 240 to 0.117 | Sinc ³ plus averaging by 8 filter. No first conversion delay. Recommended for FS from 0x01 to 0xCC only (minimum ODR = 1.17). |
| 0101 | Sinc ³ + Post Filter 1 | Not applicable | 26.087 | |
| 0110 | Sinc ³ + Post Filter 2 | Not applicable | 24 | No first conversion delay, good 50 Hz and 60 Hz rejection. FS value does not |
| 0111 | Sinc ³ + Post Filter 3 | Not applicable | 19.355 | apply. |
| 1000 | Sinc ³ + Post Filter 4 | Not applicable | 16.21 | |

analog.com Rev. A | 61 of 99

DIGITAL FILTERS

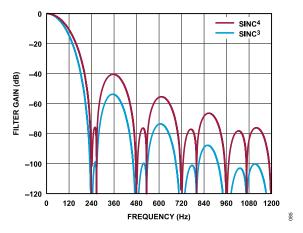


Figure 83. Sinc³ and Sinc⁴ Filter Response (FS = 0d10)

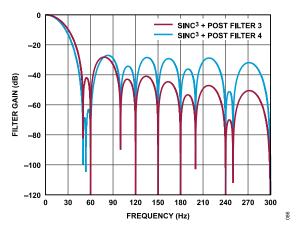


Figure 84. Post Filter 1 and Post Filter 2 Response

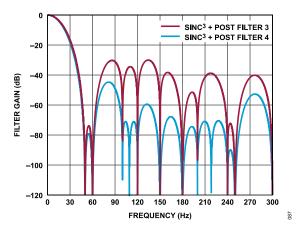


Figure 85. Post Filter 3 and Post Filter 4 Response

OUTPUT DATA RATE

The ODR is the rate at which ADC conversions are available on a single settled channel when the ADC is continuously converting. The ODR corresponds, for example, to the case where the

REPEAT_n function (CONFIG_n register) is used, or when in continuous conversion mode with only one channel enabled. When expressed in Hz, the ODR is called f_{ADC} (f_{ADC} = 1 Hz, ODR = 1 SPS), where:

 $f_{ADC} = 1/t_{CNV}$

where:

 t_{CNV} is the conversion time on a settled channel (after the first conversion on a new channel for subsequent conversions on the same channel, that channel is considered settled).

 t_{CNV} is also the time between subsequent data ready signal high to low transitions on a settled channel.

The DPP time needed for each conversion is already accounted for in the t_{CNV} for a settled channel.

Table 58. Conversion Time and ODR on Settled Channels

| Filter Type | t _{CNV} (MCLK Cycles) ¹ | ODR (SPS) ¹ |
|---------------------------------------|---|------------------------|
| Sinc ⁴ | 32 × FS | 2400/FS |
| Sinc ⁴ + Sinc ¹ | 352 × FS | 218.18/FS |
| Sinc ³ | 32 × FS | 2400/FS |
| Sinc ³ + REJ60 | 32 × FS | 2400/FS |
| Sinc ³ + Sinc ¹ | 320 × FS | 240/FS |
| Sinc ³ + Post Filter 1 | 2944 | 26.087 |
| Sinc ³ + Post Filter 2 | 3200 | 24 |
| Sinc ³ + Post Filter 3 | 3968 | 19.355 |
| Sinc ³ + Post Filter 4 | 4736 | 16.21 |

¹ FS is the decimal equivalent of the FS, Bits[10:0] binary value.

Filters Bandwidth

The 3 dB bandwidth (f_{3dB}) depends on the type of filter selected and its settings. See the Noise and Resolution section for a list of f_{3dB} values for different FS values. Table 57 lists the allowed FS values for each filter type.

Step Change on a Single Channel

When conversions are performed on a single channel and a step change occurs, the ADC does not detect the change in the analog input straight away, but it continues to output conversions at the programmed output data rate as shown in Figure 86. The filter type determines how many conversions are needed before the output data accurately reflects the analog input.

Table 59 shows the minimum number of conversions needed to settle a step change when converting the same channel. This number applies if the step change is synchronized with the conversion. If the step change occurs while the ADC is processing a conversion, the ADC takes an additional conversion after the step change to generate a fully settled result.

analog.com Rev. A | 62 of 99

DIGITAL FILTERS

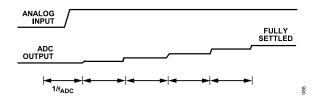


Figure 86. Effect of an Asynchronous Step Change in the Analog Input on the ADC Output

Table 59. Number of Intermediate Conversions Needed to Settle a Step Change when Converting the Same Channel

| Filter Type | Minimum | Maximum |
|---|---------|---------|
| Sinc ⁴ | 3 | 4 |
| Sinc ³ and sinc ³ + REJ60 | 2 | 3 |
| Sinc ⁴ + sinc ¹ and sinc ³ + sinc ¹ | 1 | 2 |
| Sinc ³ + post filters | 0 | 1 |

50 HZ AND 60 HZ REJECTION

By programming the correct FS, the standalone sinc filters can achieve good rejection at the respective notch frequency (f_{NOTCH_STD}). The sinc⁴ filter has limited FS options and cannot achieve natural 50 Hz and/or 60 Hz rejection.

See the Rejection Specifications section.

Sinc³ and Sinc³ + REJ60 Rejection

By programming the FS to 0d48 for a sinc³ filter, it is possible to achieve a notch at 50 Hz. ODR in this case is 50 SPS.

Sinc³ simultaneous 50 Hz/60 Hz rejection is also achieved when FS, Bits[10:0] is set to 0d240. Notches are placed at 10 Hz and multiples of 10 Hz, thereby giving simultaneous 50 Hz and 60 Hz rejection. ODR in this case is 10 SPS. See Table 60 and Figure 87.

Table 60. Sinc³ Filter Rejection Performance

| Filter Type | FS (Dec.) | ODR (SPS) | Rejection (dB) ¹ |
|---------------------------|-----------|-----------|-----------------------------|
| Sinc ³ | 240 | 10 | 100 (50 Hz and 60 Hz) |
| | 48 | 50 | 95 (50 Hz only) |
| | 40 | 60 | 98 (60 Hz only) |
| Sinc ³ + REJ60 | 48 | 50 | 80 (50 Hz) |
| | | | 65 (60 Hz) |

The 50 Hz/60 Hz rejection is measured with a stable f_{MCLK} = 76.8 kHz, in a band of ±1 Hz around 50 Hz and/or 60 Hz.

For the sinc³ filter, there is the option to select additional rejection by setting FILTER_TYPE to sinc³ + REJ60 (0b0011). When sinc³ + REJ60 filter is selected, an additional notch is added at 6/5 of the main notch:

 $f_{NOTCH_REJ60} = 6/5 \times f_{NOTCH_STD}$

where $f_{NOTCH\ STD}$ is the first notch from sinc³ filter.

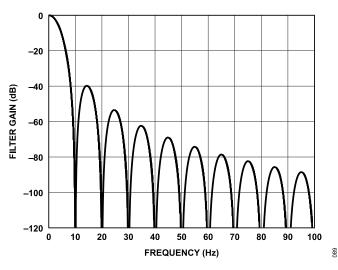


Figure 87. Simultaneous 50 Hz and 60 Hz Rejection for Sinc³ with ODR = 10 SPS

If the FS value for sinc³ + REJ60 filter is selected to be 0d48 for an ODR = 50 SPS, the first main notch is a 50 Hz and the first additional notch is at 60 Hz. This configuration allows to achieve simultaneous 50 Hz and 60 Hz rejection. Figure 88 shows the frequency response of the sinc³ filter with this configuration.

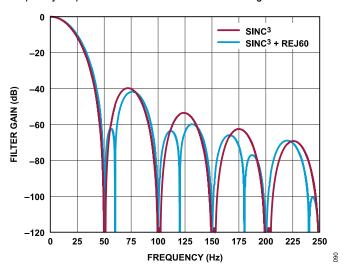


Figure 88. Sinc³ and Sinc³ + REJ60 Filter Response (50 SPS ODR)

analog.com Rev. A | 63 of 99

DIGITAL FILTERS

Post Filters Rejection

Post filters offer good simultaneous rejection at 50 Hz and 60 Hz. See Table 56 and the Rejection Specifications section.

Averaging Filters Rejection

The sinc¹ filter places additional notches at multiples of:

 $f_{NOTCH AVG} = f_{NOTCH STD}/Avg$

where:

 f_{NOTCH_STD} is the first notch from the sinc³ or sinc⁴ filter. Avg is the averaging factor (average = 8).

So, programming the FS to 0d6 for the sinc⁴ + sinc¹ or sinc³ + sinc¹ averaging filter, to achieve a f_{NOTCH_STD} at 400 Hz, the sinc¹ filter places an f_{NOTCH_AVG} at 50 Hz. This can be achieved with both the sinc⁴ + sinc¹ and sinc³ + sinc¹ filters. See Figure 89 and Table 61.

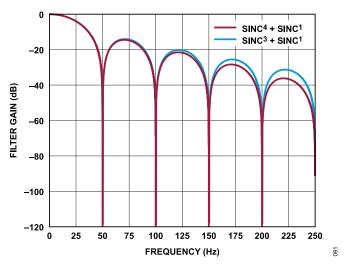


Figure 89. Sinc³ + Sinc¹ and Sinc⁴ + Sinc¹ Filter Response (FS = 6)

Table 61. Averaging Filters Rejection Performance

| Filter Type | FS (Dec.) | ODR (SPS) | Rejection (dB) ¹ |
|---------------------------------------|-----------|-----------|-----------------------------|
| Sinc ³ + sinc ¹ | 6 | 40 | 40 (50 Hz only) |
| | 5 | 48 | 42 (60 Hz only) |
| Sinc ⁴ + sinc ¹ | 6 | 36.36 | 40 (50 Hz only) |
| | 5 | 43.64 | 42 (60 Hz only) |

The 50 Hz/60 Hz rejection is measured with a stable f_{MCLK} = 76.8 kHz, in a band of ±0.5 Hz around 50 Hz and/or 60 Hz.

SEQUENCER

When multiple channels are enabled, the on-chip sequencer is automatically used. The device automatically sequences between all enabled channels.

First Conversion on a New Channel

When a channel change occurs, the modulator and filter reset, the X-MUX needs to switch to the new channel, and the new filter

needs to settle before being able to generate the first conversion result.

In each specific application, a user might want to allow an adjustable front-end settling time (SETTLE_n bits in the FILTER_n registers) to allow the excitation current to settle or a sensor to power up. This time cannot be less than 32 MCLK cycles to allow for the X-MUX to settle. In addition,

- Sinc⁴ filter requires 4 times t_{CNV} and a certain processing time due to FS value to output the first result.
- ► Sinc³ and sinc³ + REJ60 filters require 3 times t_{CNV} and a certain processing time due to FS value to output the first result.
- Averaging and post filters require the same t_{CNV} and a certain processing time due to FS value to output the first result. These filters operate with a minimum first conversion delay with respect to subsequent conversions, compared to standalone filters.

The subsequent conversions on the same channel occur in t_{CNV} = 1/ t_{ADC} , and the processing time is already accounted for. There is always a delay in the first data ready event on a new channel with respect to the subsequent data ready events on the same channel.

The predefined front-end settling time (t_{SETTLE}), the ideal first conversion time, and the processing time add up to determine the conversion time of the first conversion:

$$t_{1st_CNV} = t_{SETTLE} + t_{1st_CNV_IDEAL} + DPP Time$$

where

 t_{1st_CNV} is the first conversion time on a new channel. t_{SETTLE} is the front-end settling time before the first conversion on a new channel due to the SETTLE_n bits selection, as per Table 62. $t_{1st_CNV_IDEAL}$ is the ideal conversion time on a new channel. For the standalone filters, the first conversion time differs from the settled conversion time as shown in Table 63.

DPP Time is the digital postprocessing time expressed in MCLK cycles and it depends on the filter type and FS value, except for the post filters where it is a constant, as per Table 64.

Table 62. Programmable t_{SETTLE} Values

| MCLK Cycles Before First | | |
|--------------------------|-------------------|---------------------|
| SETTLE_n | Conversion Starts | t _{SETTLE} |
| 0b000 (Default) | 32 | 416.6 µs |
| 0b001 | 64 | 833.3 µs |
| 0b010 | 128 | 1.66 ms |
| 0b011 | 256 | 3.33 ms |
| 0b100 | 512 | 6.66 ms |
| 0b101 | 1024 | 13.33 ms |
| 0b110 | 2048 | 26.66 ms |
| 0b111 | 4096 | 53.33 ms |

Table 63. Conversion and First Conversion Time (MCLK Cycles)

| t _{CNV} (MCLK Cycles) | t _{1st_CNV_IDEAL} (MCLK Cycles) |
|--------------------------------|---|
| 32 × FS | 4 × t _{CNV} |
| | |

analog.com Rev. A | 64 of 99

DIGITAL FILTERS

Table 63. Conversion and First Conversion Time (MCLK Cycles) (Continued)

| Filter Type ¹ | t _{CNV} (MCLK Cycles) | t _{1st_CNV_IDEAL} (MCLK Cycles) |
|---------------------------------------|--------------------------------|---|
| Sinc ⁴ + Sinc ¹ | 352 × FS | t _{CNV} |
| Sinc ³ | 32 × FS | 3 × t _{CNV} |
| Sinc ³ + REJ60 | 32 × FS | 3 × t _{CNV} |
| Sinc ³ + Sinc ¹ | 320 × FS | t _{CNV} |
| Sinc ³ + Post Filter 1 | 2944 | t _{CNV} |
| Sinc ³ + Post Filter 2 | 3200 | t _{CNV} |
| Sinc ³ + Post Filter 3 | 3968 | t _{CNV} |
| Sinc ³ + Post Filter 4 | 4736 | t _{CNV} |

¹ FS is the decimal equivalent of the FS, Bits[10:0] binary value.

Table 64. DPP Time (MCLK Cycles)

| • | | |
|---------------------------------------|---------------------------------|--------|
| Filter Type | $FS^1 = 1 \text{ (or } FS = 0)$ | FS > 1 |
| Sinc ⁴ | 28 (364.6 µs) | 62 |
| Sinc ⁴ + Sinc ¹ | 62 (807.3 µs) | 62 |
| Sinc ³ | 28 | 62 |
| Sinc ³ + REJ60 | 28 | 62 |
| Sinc ³ + Sinc ¹ | 62 | 62 |
| Sinc ³ + Post Filters | 69 (898.4 µs) | 69 |

¹ FS is the decimal equivalent of the FS, Bits[10:0] binary value.

pleted, whereas the data ready signal high to low transitions always follow the additional DPP time needed to postprocess the converted data. In practice, there is an overlap of the new channel t_{SETTLE} and the previous channel DPP time. Therefore, the conversion time of the current channel (intended as the time between two data ready signal high to low transitions) can be calculated as per $t_{\text{1st_CNV}}$ on that channel minus the DPP time of the previous channel.

A special case (shown in Figure 90) occurs if all channels in the sequence share the same ADC Setup n (in particular FILTER_MODE_n and FS_n bitfields in the FILTER_n register), and only one sample per channel is collected before switching to the next channel. In this case, after the first conversion, the same conversion output data rate (1CNV_ODR) settles to a fixed value determined by $1/t_{1CNV}$, where:

In this configuration, when continuous conversion mode is enabled, it is possible to calculate the sample rate per channel by dividing the 1CNV_ODR by the number of enabled channels sharing the same configuration in the sequence.

Note that the filter behavior is still dictated by the FILTER_MODE_n and FS_n bitfields. Therefore, the filter profile and rejection does not change with the 1CNV ODR or sample rate per channel values.

Sequencer Timing

When in a sequence, different channels can have different configurations. A channel switch occurs after the actual conversion is com-

Table 65. First Conversion Time and Conversion Time on a Settled Channel, by Filter Types¹

| Filter Type | t _{1st_CNV} | t _{CNV} |
|---|--|--|
| Sinc ⁴ | t _{SETTLE} + (4 × 32 × FS + DPP Time)/f _{MCLK} | (32 × FS)/f _{MCLK} |
| Sinc ⁴ + sinc ¹ | t _{SETTLE} + ((4 + Avg - 1) × 32 × FS + DPP Time)/f _{MCLK} | $((4 + Avg - 1) \times 32 \times FS)/f_{MCLK}$ |
| Sinc ³ and sinc ³ + REJ60 | t _{SETTLE} + (3 × 32 × FS + DPP Time)/f _{MCLK} | (32 × FS)/f _{MCLK} |
| Sinc ³ + sinc ¹ | t _{SETTLE} + ((3 + Avg - 1) × 32 × FS + DPP Time)/f _{MCLK} | $((3 + Avg - 1) \times 32 \times FS)/f_{MCLK}$ |
| Sinc ³ + Post Filter 1 | t _{SETTLE} + 38.33 ms + DPP Time/f _{MCLK} | 38.33 ms |
| Sinc ³ + Post Filter 2 | t _{SETTLE} + 41.67 ms + DPP Time/f _{MCLK} | 41.67 ms |
| Sinc ³ + Post Filter 3 | t _{SETTLE} + 51.67 ms + DPP Time/f _{MCLK} | 51.67 ms |
| Sinc ³ + Post Filter 4 | t _{SETTLE} + 61.67 ms + DPP Time/f _{MCLK} | 61.67 ms |

t_{SETTLE} is the front-end settling time of a new channel due to the SETTLE_n bits selection. f_{MCLK} is the main clock frequency (76.8 kHz). Avg is 8. FS is the decimal equivalent of the FS, Bits[10:0] in the filter register. DPP Time is the digital postprocessing time expressed in MCLK cycles.

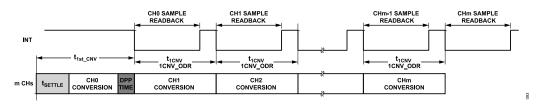


Figure 90. Example of Sequencing Through Multiple Channels with Same Configuration

analog.com Rev. A | 65 of 99

DIGITAL FILTERS

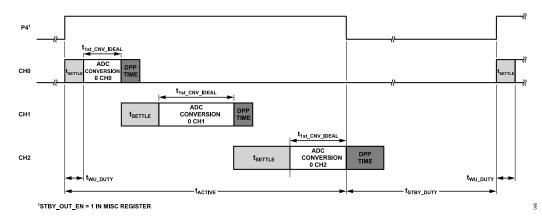


Figure 91. Example of Autonomous Duty Cycling Mode

Duty Cycling Mode Timing

The autonomous duty cycling mode on the AD4131-8 uses the conversion time of the sequence and the DUTY_CYC_RATIO bitfield settings to calculate the standby time.

The effective active time depends on the enabled channels in the sequence and their chosen configuration as follows:

$$t_{ACTIVE} - \sum_{0}^{n} \left(t_{SETTLEn} + t_{1st_CNV_IDEAL} \right)$$

where

 $t_{ACT/VE}$ is the effective active time during duty cycling. n is the number of channels enabled.

 t_{SETTLE} is the front-end settling time before the first conversion on a new channel due to the SETTLE_n bits selection, as per Table 62. $t_{1st_CNV_IDEAL}$ is the ideal conversion time on a new channel. For the standalone filters, the first conversion time differs from the settled conversion time, as shown in Table 63. See Figure 91.

DPP time does not contribute to the effective active time in duty cycling mode. This applies also to the DPP time associated with the last enabled channel. The duty cycling wake-up time (t_{WU_DUTY}) does not affect the active time and can be visualized as overlapping with the first t_{SETTLE} of the active sequence, as shown in Figure 91.

The standby time during autonomous duty cycling mode corresponds to the P4 pin low in Figure 91 and is calculated by the device as follows:

$$t_{STBY_DUTY} = \left(Standby \ Ratio \times \sum_{0}^{n} t_{1st_CNV_IDEALn}\right).$$
 $-t_{WU\ DUTY}$

where:

 t_{STBY_DUTY} is the time that the device spends in standby when the autonomous duty cycling mode is enabled.

Standby Ratio is 3 for 1/4 duty cycle and 15 for 1/16 duty cycle, depending on the DUTY_CYC_RATIO bit in the ADC_CONTROL register.

n is the number of channels enabled.

 $t_{1st_CNV_IDEAL}$ is the ideal conversion time on a new channel. For the standalone filters, the first conversion time differs from the settled conversion time as shown in Table 63.

t_{WU DUTY} is the duty cycling wake-up time (see Table 9).

Out of Standby Mode Timing

By default, the internal oscillator is powered down in the standby mode, and reenabled when exiting the standby mode. The internal oscillator takes some time to wake up and settle to the correct frequency, as shown in Figure 92 (see also Table 7). t_{SETTLE} can be used to adjust the time allowed for the input signal to settle before the signal acquisition starts.

When the internal oscillator is kept alive in the standby mode, the standby mode wake-up time corresponds to $t_{WU,STBY}$ in Table 9.

The internal oscillator is kept alive by default when selecting the duty cycling mode.

analog.com Rev. A | 66 of 99

DIGITAL FILTERS

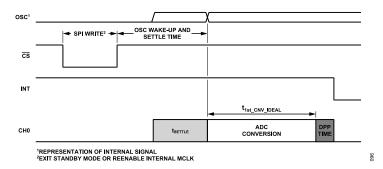


Figure 92. Out of Standby Mode Diagram

analog.com Rev. A | 67 of 99

DIAGNOSTICS

The AD4131-8 has numerous diagnostic functions on chip. Use these features to ensure among others:

- Read/write operations are to valid registers only
- Only valid data is written to the on-chip registers
- ▶ The external reference, if used, is present
- ▶ The ADC modulator and filter are working within specification

SIGNAL CHAIN CHECK

Functions such as the reference and power supply voltages can be selected as inputs to the ADC. The AD4131-8 can therefore check the voltages connected to the device. The AD4131-8 also generates an internal signal of around 10 mV that can be applied internally to a channel by selecting the V_MV_P to V_MV_M option in the CHANNEL_m register. The PGA can be checked using this function. As the PGA setting is increased, for example, the signal as a percent of the analog input range is reduced by a factor of two. This allows the user to check that the PGA is functioning correctly.

REFERENCE DETECTION

The AD4131-8 includes on-chip circuitry (simplified in Figure 93) to detect if there is a valid reference for conversions or calibrations when the user selects an external reference as the reference source. This feature is valuable in applications such as RTDs or strain gauges where the reference is derived externally.

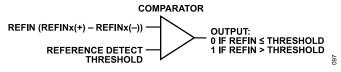


Figure 93. Reference Detect Circuitry

The reference detect threshold value can be found in Table 5. This feature is enabled when the REF_DETECT_ERR_EN bit in the ERROR_EN register is set to 1. If the voltage between the selected REFINx(+) and REFINx(-) pins goes below the threshold in Table 5, or either the REFINx(+) or REFINx(-) inputs are open circuit, the AD4131-8 detects that it no longer has a valid reference. In this case, the REF_DETECT_ERR bit in the error register is set to 1. The MAIN_ERR bit in the status register is also set to 1 (see Table 47).

If the user is concerned about verifying that a valid reference is in place every time a calibration is performed, check the status of the REF_DETECT_ERR bit at the end of the calibration cycle.

The reference detect flag may be set when the device exits of standby mode. Therefore, read the error register after exiting standby mode and write 1 to clear the REF DETECT ERR bit if set.

ADC ERRORS

The ADC conversion process and calibration process can also be monitored by the AD4131-8. These diagnostics check the analog input used as well as the modulator and digital filter during

conversions or calibration. The functions can be enabled using the ADC_ERR_EN bit in the ERROR_EN register. With these functions enabled, the ADC_ERR bit is set to 1 if an error occurs.

The ADC ERR flag is set for one or more of the following:

- Conversion error when there is an overflow or underflow in the digital filter. In this case, the ADC conversion also clamps to all 0s or all 1s.
- Modulator saturation error when the modulator outputs 20 consecutive 1s or 0s.
- Calibration error when during offset calibration, the resulting offset coefficients are outside the 0x07FF to 0xF7FF range. In this case, the OFFSET_n register is not updated and the ADC_ERR flag is set to 1. Also, during a gain calibration, overflow of the digital filter is checked. If an overflow occurs, the error flag is set to 1, and the GAIN n register is not updated.

The ADC_ERR flag is updated with the update of the data register and can be cleared only by writing a 1 to it.

OVERVOLTAGE/UNDERVOLTAGE DETECTION

The overvoltage/undervoltage monitors check the absolute voltage on the AINx analog input pins and the REFINx input pins.

For the AINx pins, the absolute voltage must be within specification to meet the data sheet specifications. If the ADC is operated outside the data sheet limits, linearity degrades. Figure 94 shows the simplified block diagram of the AINx circuitry to detect overvoltage and undervoltage.

The positive (AINP) and negative (AINM) analog inputs can be separately checked for overvoltages and undervoltages. The AINP_OV_UV_ERR_EN and AINM_OV_UV_ERR_EN bits in the ERROR_EN register enable the overvoltage/undervoltage diagnostics respectively on AINP and AINM. An overvoltage is flagged when the voltage on AINx exceeds ${\rm AV}_{\rm DD}$ while an undervoltage is flagged when the voltage on AINx goes below ${\rm AV}_{\rm SS}$.

The error flags are AINP_OV_UV_ERR and AINM_OV_UV_ERR bits in the error register and they flag an overvoltage and/or undervoltage error on any enabled AINP and AINM respectively.

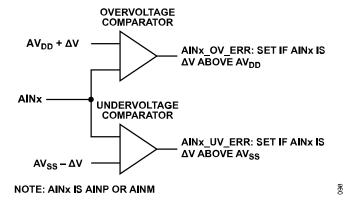


Figure 94. Analog Input Overvoltage/Undervoltage Monitors

analog.com Rev. A | 68 of 99

DIAGNOSTICS

The ΔV threshold value can be found in Table 5.

The external reference voltage can also be monitored for overvoltage/undervoltage enabling the REF_OV_UV_ERR_EN bit in the ERROR_EN register. An overvoltage is flagged when the voltage on REFINx(+) exceeds AV_{DD} while an undervoltage is flagged when the voltage on REFINx(-) goes below AV_{SS}. The error flag REF_OV_UV_ERR in the error register is set to 1 in any of the two conditions.

When this function is enabled, the corresponding flags can be set in the error register. These bits are R/W1C.

POWER SUPPLY MONITORS

Along with converting external voltages, the ADC can monitor the voltage on the AV_{DD} pin and the IOV_{DD} pin. When the inputs of AV_{DD} to AV_{SS} or IOV_{DD} to DGND are selected, the voltage (AV $_{DD}$ to AV $_{SS}$ or IOV $_{DD}$ to DGND) is internally attenuated by 6, and the resulting voltage is applied to the $\Sigma\text{-}\Delta$ modulator. This is useful to monitor variations in the power supply voltage.

MAIN CLOCK COUNTER

A stable MCLK to the ADC is important as the output data rate, filter first conversion time, and the filter notch frequencies are dependent on the main clock. The AD4131-8 allows the user to monitor the main clock. When the MCLK_CNT_EN bit in the ERROR_EN register is set, the MCLK_COUNT register increments by 1 every 131 main clock cycles. The user can monitor this register over a fixed period. The main clock frequency can be determined from the result in the MCLK_COUNT register. The MCLK_COUNT register wraps around after it reaches its maximum value.

SPI DIAGNOSTICS

SPI Clock Counter

The SPI SCLK counter counts the number of SCLK pulses used in each read and write operation. $\overline{\text{CS}}$ must frame every read and write operation when this function is used. All read and write operations are multiples of eight SCLK pulses. If the SCLK counter counts the SCLK pulses and the result is not a multiple of eight, an error is flagged. The SPI_SCLK_CNT_ERR bit in the error register is set to 1. If a write operation is being performed and the SCLK contains an insufficient number of SCLK pulses, the value is not written to the addressed register and the write operation is aborted.

The SCLK counter is enabled by setting the SPI_SCLK_CNT_ERR_EN bit in the ERROR_EN register.

SPI Read/Write Errors

Along with the SCLK counter, the AD4131-8 can also check the read and write operations to ensure that valid registers are being addressed.

When the SPI_READ_ERR_EN bit in the ERROR_EN register is set to 1, attempts to read registers at addresses not listed in Table

66 cause the SPI_READ_ERR bit to be set to 1 and the readback data for that register is all 0s.

When the SPI_WRITE_ERR_EN bit in the ERROR_EN register is set to 1, attempts to write to read-only registers and to registers at addresses not listed in Table 66 cause the SPI_WRITE_ERR bit to be set to 1, and the write transaction is aborted.

This function, along with the SCLK counter and the CRC protection, makes the serial interface more robust. Invalid registers are not written to or read from. An incorrect number of SCLK pulses can cause the serial interface to go asynchronous and incorrect registers to be accessed. The AD4131-8 protects against these issues via the diagnostics.

SPI Ignore Error

At certain times, the on-chip registers are not accessible. During power-up, when the on-chip registers are set to their default values, they cannot be accessed via SPI. The user must wait t_{RESET_DELAY} until this operation is complete before writing to registers. When offset or gain calibrations are being performed, registers cannot be accessed. When in single sequence mode, during conversion and before the last conversion finishes, registers cannot be accessed.

The SPI_IGNORE_ERR bit in the error register indicates when the on-chip registers cannot be written to. This diagnostic is enabled by default. The function can be disabled using the SPI_IGNORE_ERR_EN bit in the ERROR_EN register.

Any write operations performed when SPI_IGNORE_ERR is set to 1 in the error register are ignored. This bit is R/W1C.

CRC PROTECTION

The AD4131-8 features optional CRC to provide error detection on interface transactions, memory map content, and read-only memory (ROM) content.

CRC Calculation

The AD4131-8 uses the CRC-8 standard with the following polynomial:

$$x^8 + x^2 + x + 1$$

To generate the checksum, the data is left shifted by eight bits to create a number ending in eight Logic 0s. The polynomial is aligned so that its MSB is adjacent to the leftmost Logic 1 of the data. An XOR (exclusive OR) function is applied to the data to produce a new, shorter number. The polynomial is again aligned so that its MSB is adjacent to the leftmost Logic 1 of the new result, and the procedure is repeated. This process is repeated until the original data is reduced to a value less than the polynomial. This is the 8-bit checksum.

analog.com Rev. A | 69 of 99

DIAGNOSTICS

SPI CRC Protection

The AD4131-8 has a CRC mode that can be used to improve interface robustness. Using the CRC ensures that only valid data is written to a register and allows data read from a register to be validated. If an error occurs during a register write, the CRC_ERR bit is set to 1 in the error register and the write transaction is aborted. However, to ensure that the register write was successful, read back the register and verify the checksum. The CRC_ERR_EN bit in the ERROR_EN register enables and disables the SPI CRC.

The SPI checksum is appended to the end of each read and write transaction. For a write transaction, the checksum is calculated using the 8-bit command word and the 8-bit to 24-bit data. For a read transaction, the checksum is calculated using the 8-bit command word and the 8-bit to 32-bit data output. Figure 95 and Figure 96 show SPI write and read transactions with CRC enabled, respectively.

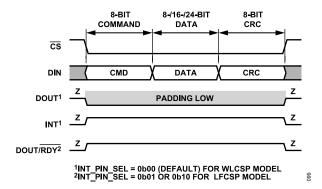
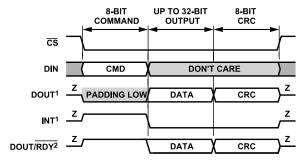


Figure 95. SPI Write Transaction with CRC



1INT_PIN_SEL = 0b00 (DEFAULT) FOR WLCSP MODEL 2INT_PIN_SEL = 0b01 OR 0b10 FOR LFCSP MODEL

Figure 96. SPI Read Transaction with CRC

If SPI CRC is enabled when continuous read mode is active, there is an implied read data command of 0x42 before every data transmission that must be accounted for when calculating the checksum value. This ensures a nonzero checksum value even if the ADC data equals 0x0000.

Memory Map CRC Protection

For added robustness, a CRC calculation is performed on the on-chip registers as well. The status register, data register, ID register, error register, and MCLK_COUNT register are not included in this check because their contents change continuously, or they are read-only registers. The CRC is performed at a rate of 1/300 seconds. Each time that the memory map is accessed, the CRC is recalculated. Events that cause the CRC to be recalculated are as follows:

- ▶ A user write command
- ► An offset/full-scale calibration
- When the device is operated in single sequence mode and the ADC goes into standby mode following the completion of the conversion
- When exiting continuous read mode (the CONT_READ bit in the ADC CONTROL register is set to 0)

The memory map CRC function is enabled by setting the MM_CRC_ERR_EN bit in the ERROR_EN register to 1. If an error occurs, the MM_CRC_ERR bit in the error register is set to 1.

ROM CRC Protection

On power-up, all registers are set to default values. These default values are held in ROM. For added robustness, at power-up, a CRC calculation is performed on the ROM contents as well.

The ROM CRC function is enabled by setting the ROM_CRC_ ERR_EN bit in the ERROR_EN register to 1. If an error occurs, the ROM_CRC_ERR bit in the error register is set to 1.

When this function is enabled, the internal main clock, if enabled, remains active in the standby mode.

BURNOUT CURRENTS

The AD4131-8 contains two constant current generators that can be programmed to 0.5 μ A, 2 μ A, or 4 μ A. One generator sources current from AV_{DD} to AINP, and one sinks current from AINM to AV_{SS}, as shown in Figure 97. These currents enable open wire detection to check if a sensor is connected.

analog.com Rev. A | 70 of 99

100

DIAGNOSTICS

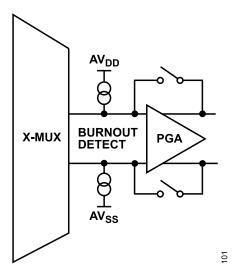


Figure 97. Burnout Currents

The currents are switched to the selected analog input pair. Both currents are either on or off. The burnout bits in the configuration register enable/disable the burnout currents along with setting the amplitude. Use these currents to verify that an external transducer is still operational before attempting to take measurements on that channel. After the burnout currents are turned on, they flow in the external transducer circuit, and a measurement of the input voltage on the analog input channel can be taken.

If the resulting voltage measured is near full scale, the user must verify why this is the case. A near full-scale reading can mean that the front-end sensor is open circuit. It can also mean that the front-end sensor is overloaded and is justified in outputting full scale, or that the reference may be absent and the REF_DETECT_ERR bit is set, thus clamping the data to all 1s. When a conversion is close to full scale, the user must check these three cases before making a judgment.

If the voltage measured is 0 V, it may indicate that the transducer has short circuited.

For normal operations, these burnout currents are turned off by setting the burnout bits to zero. The current sources work over the normal absolute input voltage range specifications with buffers on.

TEMPERATURE SENSOR

The AD4131-8 has an integrated temperature sensor that is useful to monitor the die temperature at which the device is operating. This can be used for diagnostic purposes or as an indicator of when the application circuit needs to rerun a calibration routine to take into account a shift in operating temperature.

The temperature sensor is accessible through the X-MUX as an internal channel and can be selected using the AINP, Bits[4:0] and AINM, Bits[4:0] in each CHANNEL m register.

The equation for the temperature sensor is as follows:

Temperature (°C) = (Conversion (μ V) / Sensitivity (μ V/K)) – 273.15

Conversion (μ V) is the conversion result from the temperature sensor converted to Volts using the equations in Table 44. Sensitivity (V/°C) is the sensitivity of the temperature sensor. The nominal sensitivity can be found in Table 5.

To improve the temperature sensor accuracy, operate the device in a known temperature (25°C) and take a conversion as a reference point. The difference between the nominal sensitivity and the one measured for the device can be used to calibrate the temperature sensor to higher accuracy.

The temperature sensor specifications can be found in Table 5 and Figure 55. See the Terminology section.

DIAGNOSTICS AND STANDBY MODE

The diagnostic functionality can be disabled when in standby mode by setting the STB_EN_DIAGNOSTICS bit in the MISC register to 1. Some diagnostics also require the internal oscillator to be enabled. Therefore, if those errors are enabled in the ERROR_EN register and the STB_EN_DIAGNOSTICS = 1, the internal oscillator is kept enabled. See the Standby Mode section.

analog.com Rev. A | 71 of 99

APPLICATIONS INFORMATION

POWER SCHEMES

The AD4131-8 allows for different power schemes depending on the requirements.

Single-Supply Operation (AV_{SS} = DGND)

When the AD4131-8 is powered from a single supply that is connected to AV_{DD} and IOV_{DD} , AV_{SS} and DGND can be shorted together on one single ground plane. With this setup, an external level shifting circuit is required when using truly bipolar inputs to shift the common-mode voltage. Recommended regulators include the ADP150, which has a 3.3 V output and low quiescent current.

When AV_{DD} and IOV_{DD} are connected to the same source, their minimum value is limited by the minimum AV_{DD} = 1.71 V.

Split Supply Operation (AV_{SS} ≠ DGND)

The AD4131-8 can operate with AV_{SS} set to a negative voltage, allowing true bipolar inputs to be applied. This allows a truly fully differential input signal centered around 0 V to be applied to the AD4131-8 without the need for an external level shifting circuit. For example, with a 3.6 V split supply, AV_{DD} = +1.8 V and AV_{SS} = -1.8 V. In this use case, the AD4131-8 internally level shifts the signals, allowing the digital output to function between DGND (nominally 0 V) and IOV_{DD}.

When using a split supply for AV_{DD} and AV_{SS}, the absolute maximum ratings must be considered (see the Absolute Maximum Ratings section).

Keep in mind that when $AV_{SS} \neq DGND$, the GPOs cannot be used as digital output pins.

Separate Positive Supplies Operation

When trying to minimize the power consumption, AV_{DD} and IOV_{DD} can be connected to separate sources to be independently lowered to their minimum values. AV_{DD} can be as low as 1.71 V, while IOV_{DD} can be as low as 1.65 V. For example, IOV_{DD} can be powered by the same source of the processor interface, while AV_{DD} can have its own source.

RECOMMENDED DECOUPLING

Good decoupling is important when using high resolution ADCs. The AD4131-8 has two power supply pins, AV_{DD} and IOV_{DD} . The AV_{DD} pin is referenced to AV_{SS} , and the IOV_{DD} pin is referenced to DGND. Decouple AV_{DD} with a 1 μF tantalum capacitor in parallel with a 0.1 μF capacitor to AV_{SS} . Decouple IOV_{DD} with a 1 μF tantalum capacitor in parallel with a 0.1 μF capacitor to DGND. Place the 0.1 μF capacitors as close as possible to the device on each supply, ideally right up against the device. All analog inputs must be decoupled to AV_{SS} . If an external reference is used, decouple the REFINx(+) and REFINx(-) pins to AV_{SS} .

The AD4131-8 also has two on-board LDO regulators, one that regulates the AV_{DD} supply and one that regulates the IOV_{DD} supply. For the REGCAPA pin, it is recommended to add a 0.1 μ F capacitor to AV_{SS}. Similarly, for the REGCAPD pin, it is recommended to add a 0.1 μ F capacitor to DGND.

INPUT FILTERS

An external antialiasing filter is required to reject any interference at the modulator frequency ($f_{MOD} = f_{MCLK}/2 = 38.4 \text{ kHz}$) and multiples of the modulator frequency. In addition, some filtering may be needed for electromagnetic interference (EMI) purposes. The analog inputs are buffered, and the reference inputs can be buffered, which allows the user to connect any RC combination to the reference or analog input pins.

MICROPROCESSOR INTERFACING

Microprocessor interfacing to the AD4131-8 is through a serial bus that uses a standard protocol compatible with DSPs and microcontrollers. The communications channel requires a 4-wire serial interface consisting of a clock signal, a data input signal, a data output signal, and a synchronization signal.

The SPI of the AD4131-8 is designed to be easily connected to industry-standard DSPs and microcontrollers. Figure 98 shows the AD4131-8 connected to the MAX32670. The MAX32670 has an integrated SPI port that can be connected directly to the SPI pins of the AD4131-8.

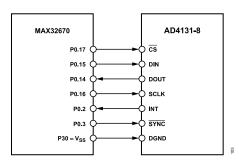


Figure 98. Example of MAX32670 μC SPI Connection to AD4131-8

Digital Pins

It is recommended that a weak pull-up resistor to IOV_{DD} is placed on \overline{CS} (when in use), \overline{SYNC} , and SCLK lines to keep the interface disabled while powering up the device. It is recommended that a weak pull-down resistor is placed on the DIN line.

UNUSED PINS

When not in use, the following digital pins must be treated with care. Connect $\overline{\text{SYNC}}$ to IOVDD directly or with a weak pull-up resistor. Connect $\overline{\text{CS}}$ and CLK to DGND with a weak pull-down resistor.

When not in use, the analog pins (AINx, REFINx(±), REFOUT, PSW) can be left electrically floating, but must be soldered to the PCB for mechanical stability.

analog.com Rev. A | 72 of 99

APPLICATIONS INFORMATION

POWER-UP AND INITIALIZATION

Power up the AD4131-8 by following the recommended power supply sequencing as follows: DGND, AV_{SS} (if different from DGND), IOV_{DD} , AV_{DD} , REFINx(+) and REFINx(-), AINx, Digital Inputs. See also the Digital Pins section.

Upon power-up, wait for the t_{RESET_DELAY} timing before attempting an SPI transaction (see the Power-On Reset section). The device has a power-on reset function. However, any glitches during power-up can cause corruption of the registers. Therefore, a reset in the initialization routine is advisable. Write 64 consecutive ones to the device to perform a software reset (see the Device Reset section). If the digital host attempts to perform an SPI transaction before the device is ready, the transaction is invalid and the SPI_IGNORE_ERR bit in the ERROR register is set. The SPI_IGNORE_ERR is an R/W1C type of bit.

After the device initializes, the digital interface can be accessed to configure the device, including selecting the reference scheme according to the application. Regardless of the voltage reference scheme used, it is recommended to let the voltage reference settle after configuring the device to ensure it achieves its specifications.

The recommended configuration flow is as follows:

- Select Interface mode: write to ADC_CONTROL register (select 3-wire or 4-wire mode, clock source, enable CRC, data + status, and so on).
- 2. Setup configuration: Eight possible ADC setup options. Write to the CONFIG_n and FILTER_n registers (select configuration, filter order, output data rate, and so on).
- Channel configuration: write to the CHANNEL_m registers (select positive and negative input and setup for each ADC channel, enable open wire detection in GPIO configuration, and so on).
- 4. Setup ADC mode: write to the ADC_CONTROL register (select ADC operating mode, clock source, enable CRC, data + status, and so on) to start conversions.

LAYOUT AND GROUNDING

The analog inputs and reference inputs are differential and, therefore, most of the voltages in the analog modulator are common-mode voltages. The high common-mode rejection of the device removes common-mode noise on these inputs. The analog and digital supplies to the AD4131-8 are independent and separately pinned out to minimize coupling between the analog and digital sections of the device. The digital filter provides rejection of broadband noise on the power supplies, except at integer multiples of the main clock frequency.

The digital filter also removes noise from the analog and reference inputs, provided that these noise sources do not saturate the analog modulator. As a result, the AD4131-8 is more immune to noise interference than a conventional high resolution converter. However, given that the resolution of the AD4131-8 is high and

the noise levels from the converter are so low, care must be taken regarding grounding and layout.

The PCB that houses the ADC must be designed so that the analog and digital sections are separated and confined to certain areas of the board. A minimum etch technique is generally best for ground planes because it results in the best shielding.

In any layout, the user must keep in mind the flow of currents in the system, ensuring that the paths for all return currents are as close as possible to the paths the currents took to reach their destinations.

Place the decoupling capacitors as close to the package as possible (ideally directly against the device).

Avoid running digital lines under the device because this couples noise onto the die and allows the analog ground plane to run under the AD4131-8 to prevent noise coupling. The power supply lines to the AD4131-8 must use as wide a trace as possible to provide low impedance paths and reduce glitches on the power supply line. Shield fast switching signals like clocks with digital ground to prevent radiating noise to other sections of the board and never run clock signals near the analog inputs. Avoid crossover of digital and analog signals. Run traces on opposite sides of the board at right angles to each other. This reduces the effects of feedthrough on the board. A microstrip technique is by far the best but is not always possible with a double-sided board. In this technique, the component side of the board is dedicated to ground planes, whereas signals are placed on the solder side.

If using the AD4131-8 with split supply operation, a separate plane must be used for AV_{SS} .

ASSEMBLY GUIDELINES

For the WLCSP, heat is transferred through the solder balls to the PCB. Thermal impedance is dependent on PCB construction. More copper layers and ground through remove heat more effectively.

The PCB level reliability of the device is directly linked to the PCB type and design used. Using a PCB material that matches the coefficient of thermal expansion (CTE) of the silicon (for example, ceramic) provides the optimal mechanical performance. For organic material PCBs (for example, FR4) where the CTE is different from that of the silicon, the use of underfill can increase the mechanical performance. For organic PCB thickness >0.8 mm, consider using underfill. Give particular attention to the underfill material selection to match the material properties with the application use conditions.

Consider using low alpha material in the system assembly to reduce the soft error rate (SER).

The AN-617 Application Note provides information on PCB layout and assembly for the WLCSP.

The AN-772 Application Note provides information on PCB layout and assembly for the LFCSP.

analog.com Rev. A | 73 of 99

AD4131-8 REGISTERS

The AD4131-8 has programmable user configuration registers that are used to configure the device. Table 66 contains the complete list of the AD4131-8 user configuration registers. Table 66 shows a complete list of the user configuration registers. See the AD4131-8 Register Summary and Registers Details sections for details about the functions of each of the bits. The access column specifies whether the register comprises only read-only bits (R) or a mix of read only and read/write bits (R/W). Read-only bits cannot be overwritten by an SPI write transaction, whereas read/write bits can. Table 66 also shows if each register is a single byte or multibyte register. See the Digital Interface section for a detailed description of how to communicate with the AD4131-8.

Table 66. User Configuration Register Names and Descriptions¹

| Address | Name | Description | Length | Reset | Access |
|-------------------|-------------------------|---|-------------|-----------------------|--------|
| N/A ² | COMMS | Communication register | Single byte | N/A | W |
| 0x00 | STATUS | Status register | Single byte | 0x10 | R |
| 0x01 | ADC_CONTROL | ADC control register | Two bytes | 0x4000 | R/W |
| 0x02 | DATA | Data register | Two bytes | 0x0000 | R |
| 0x03 | IO_CONTROL | Input/output control register | Two bytes | 0x0000 | R/W |
| 0x04 | VBIAS_CONTROL | VBIAS control register | Two bytes | 0x0000 | R/W |
| 0x05 | ID | Identification register | Single byte | 0x0X ³ | R |
| 0x06 | ERROR | Error register | Two bytes | 0x0000 | R/W |
| 0x07 | ERROR_EN | Error enable register | Two bytes | 0x0040 | R/W |
| 0x08 | MCLK_COUNT | MCLK count register | Single byte | 0x00 | R |
| 0x09 to 0x18 by 1 | CHANNEL_m (m = 0 to 15) | Channel m configuration registers | Three bytes | 0xXXXXXX ⁴ | R/W |
| 0x19 to 0x20 by 1 | CONFIG_n (n = 0 to 7) | Configuration registers (ADC Setup n) | Two bytes | 0x0000 | R/W |
| 0x21 to 0x28 by 1 | FILTER_n (n = 0 to 7) | Filter configuration registers (ADCs Setup n) | Three bytes | 0x002030 | R/W |
| 0x29 to 0x30 by 1 | OFFSET_n (n = 0 to 7) | Offset registers (ADC Setup n) | Two bytes | 0x8000 | R/W |
| 0x31 to 0x38 by 1 | GAIN_n (n = 0 to 7) | Gain registers (ADC Setup n) | Two bytes | 0xXXXX ⁵ | R/W |
| 0x39 | MISC | Miscellaneous register | Two bytes | 0x0000 | R/W |

¹ Blank cells are not applicable.

AD4131-8 REGISTER SUMMARY

Table 67. User Configuration Register Summary¹

| Addr. | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset | R/W |
|------------------|-------------------|--------|-----------------|--------------------|-----------------|------------------|-----------------|------------------|-----------------|-----------------|--------|-----|
| N/A ² | COMMS | [7:0] | WEN | R/W | | | RS[| 5:0] | | | N/A | W |
| 0x00 | STATUS | [7:0] | RDY | MAIN_ERR | RESERVED | | | | | 0x10 | R | |
| 0x01 | ADC_CON TROL | [15:8] | RESERVED | BIPOLAR | INT_REF_VA L | DOUT_DIS_ DEL | CONT_REA D | DATA_STA- TUS | CSB_EN | INT_REF_ EN | 0x4000 | R/W |
| | | [7:0] | RESERVED | DUTY_CY C_RATIO | | MC | DDE | | CLK | _SEL | | |
| 0x02 | DATA | [15:8] | | DATA[15:8] | | | | | | 0x0000 | R | |
| | | [7:0] | | | | DATA | [7:0] | | | | | |
| 0x03 | IO_CONTR OL | [15:8] | | | | RESE | RVED | | | | 0x0000 | R/W |
| | | [7:0] | GPO_DATA _P4 | GPO_DATA_ P3 | GPO_DATA _P2 | GPO_DATA_ P1 | GPO_CTRL _P4 | GPO_CTRL _P3 | GPO_CTRL_ P2 | GPO_CTRL _P1 | | |
| 0x04 | VBIAS_CO NTROL | [15:8] | VBIAS_15 | VBIAS_14 | VBIAS_13 | VBIAS_12 | VBIAS_11 | VBIAS_10 | VBIAS_9 | VBIAS_8 | 0x0000 | R/W |

analog.com Rev. A | 74 of 99

² N/A means not applicable.

³ See the Identification Register section for details.

⁴ CHANNEL 0 default value is 0x800100. All other channels default value is 0x000100.

Nominal value: 0x5555. The AD4131-8 is factory calibrated at ambient temperature and with a gain of 1 and PGA_BYP_n = 0, and the resulting gain coefficient is loaded to the GAIN in registers of the device as default value.

AD4131-8 REGISTERS

Table 67. User Configuration Register Summary¹ (Continued)

| Addr. | Name | Bits | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset | R/W |
|--------------------|--------------------------|---------|-----------------------------|---------------------------|-------------------------|---------------------|-----------------------|-----------------------|----------------------|---------------------------|-----------------------|-----|
| | | [7:0] | VBIAS_7 | VBIAS_6 | VBIAS_5 | VBIAS_4 | VBIAS_3 | VBIAS_2 | VBIAS_1 | VBIAS_0 | | |
| 0x05 | ID | [7:0] | | RES | ERVED | | SILIC | CON_ID | MODE | EL_ID | 0x0X ³ | R |
| 0x06 | ERROR | [15:8] | | RESE | ERVED | | AINP_OV_U V_ERR | AINM_OV_U V_ERR | REF_OV_UV _ERR | REF_DETE CT_ERR | 0x0000 | R/W |
| | | [7:0] | ADC_ERR | SPI_IGNO RE_ERR | SPI_SCLK_C NT_ERR | SPI_READ_ ERR | SPI_WRITE _ERR | SPI_CRC_E RR | MM_CRC_E RR | ROM_CRC _ERR | | |
| 0x07 | ER- ROR_EN | [15:8] | | RESERVED | | MCLK_CNT _EN | AINP_OV_U V_ERR_EN | AINM_OV_U V_ERR_EN | REF_OV_UV _ERR_EN | REF_DETE CT_ERR_E N | 0x0040 | R/W |
| | | [7:0] | ADC_ERR_E N | SPI_IGNO RE_ERR_E N | SPI_SCLK_C NT_ERR_EN | SPI_READ_ ERR_EN | SPI_WRITE _ERR_EN | SPI_CRC_E RR_EN | MM_CRC_E RR_EN | ROM_CRC _ERR_EN | | |
| 80x0 | MCLK_CO UNT | [7:0] | | , | | MCLK_ | COUNT | | | | 0x00 | R |
| 0x09 | CHANNEL _0 | [23:16] | ENABLE_0 | | SETUP_0 | | PDSW_0 | RESERVED | AINP_ | 0[4:3] | 0xXXXXXX ⁴ | R/W |
| | | [15:8] | | AINP_0[2:0] | | | AINM_0 | | | | | |
| | | [7:0] | | I_OUT | 1_CH_0 | | | I_OUT(|)_CH_0 | | | |
| 0x10 to 0x18 | _m (m = 1 | [23:16] | ENABLE_m | | SETUP_m | | PDSW_m | RESERVED | AINP_ | m[4:3] | 0xXXXXXX ⁵ | R/W |
| | | [15:8] | | AINP_m[2:0] | | | ' | AINM_m | | | - | |
| | | [7:0] | | | | RESE | RVED | | | | | |
| 0x19 | CONFIG_n | [15:8] | I_OUT1_n | | | | | | | | | |
| to 0x20 | (n = 0 to 7) | [7:0] | REF_BUFP_ n | REF_BUF M_n | | | | | | | | |
| 0x21 to 0x28 | FILTER_n (n = 0 to 7) | [23:16] | | | | RESE | RVED | | | | 0x002030 | R/W |
| | | [15:8] | | FILTER | _MODE_n | | RESERVED | | FS_n[10:8] | | - | |
| | | [7:0] | | | | FS_r | n[7:0] | | | | | |
| 0x29 to 0x30 | OFFSET_n (n = 0 to 7) | [15:8] | | | | OFFSET | _n[15:8] | | | | 0x8000 | R/W |
| | | [7:0] | | | | OFFSE | T_n[7:0] | | | | - | |
| 0x31 to 0x38 | GAIN_n (n = 0 to 7) | [15:8] | | | | GAIN_ | n[[15:8] | | | | 0xXXXX ⁶ | R/W |
| | | [7:0] | | | | GAIN | _n[7:0] | | | | - | |
| 0x39 | MISC | [15:8] | RESERVED | PD_ALDO | CAL_RANGE _X2 | | RES | ERVED | | STBY_OUT _EN | 0x0000 | R/W |
| | | [7:0] | STBY_DIAG NOSTICS_E N | STBY_GP O_EN | STBY_PDSW _EN | STBY_BUR NOUT_EN | STBY_VBIA S_EN | STBY_IEXC _EN | STBY_REFH OL_EN | STBY_INT REF_EN | | |

¹ Blank cells are not applicable.

analog.com Rev. A | 75 of 99

² N/A means not applicable.

³ See Identification Register section for details.

⁴ CHANNEL_0 default value is 0x800100.

AD4131-8 REGISTERS

- $^{5}\,\,$ CHANNEL_0 default value is 0x800100. All other channels default value is 0x000100.
- Nominal value: 0x5555. The AD4131-8 is factory calibrated at ambient temperature and with a Gain of 1 and PGA_BYP_n = 0, and the resulting gain coefficient is loaded to the GAIN_n registers of the device as default value.

REGISTERS DETAILS

Communication Register

Address: N/A, Reset: 0x10, Name: COMMS

All communications to the device must start with a write operation to the communications register.

Table 68. Bit Descriptions for COMMS Register

| Bits | Bit Name | Settings | Description |
|------|----------|----------|---|
| 7 | WEN | | Write Enable Bit. A 0 must be written to this bit so that the write to the communications register occurs. If a 1 is the first bit written, the device does not clock on to subsequent bits in the register. It stays at this bit location until a 0 is written to this bit. As soon as a 0 is written to the WEN bit, the next seven bits are loaded to the communications register. |
| | | 0 | Communication Allowed. |
| | | 1 | No Communication Allowed. |
| 6 | R/W | | A 0 in this bit location indicates that the next operation is a write to a specified register. A 1 in this position indicates that the next operation is a read from the designated register. |
| | | 0 | Write Operation. |
| | | 1 | Read Operation. |
| 5:0 | RS[5:0] | | Register address bits. These address bits select which registers of the device are being selected during this serial interface communication. See Table 67 for a list of all registers and relative addresses. |

analog.com Rev. A | 76 of 99

AD4131-8 REGISTERS

Status Register

Address: 0x00, Reset: 0x10, Name: STATUS

ADC and interface status information register.

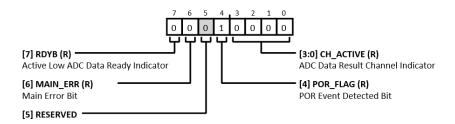


Figure 99.

Table 69. Bit Descriptions for Status Register

| 3its | Bit Name | Settings | Description | Reset | Acces |
|-------|-----------|----------|---|-------|-------|
| | RDYB | | Active Low ADC Data Ready Indicator. The RDYB bit is used to indicate availability of ADC data. Because the RDYB bit is treated as an interrupt event, when it is set to 0, the data ready pin goes low. Conversely, the data ready pin automatically clears (goes high) when the RDYB bit is set to 1. | 0x0 | R |
| | | 0 | ADC Data Ready. The RDYB bit is set to 0 when the ADC writes a new result to the DATA register, or in any ADC calibration mode when the ADC writes to the OFFSET_n and GAIN_n registers. The RDYB bit is set back to 1 automatically by a read of the data register. A read of OFFSET_n register or GAIN_n register does not affect this bit. | | |
| | | 1 | Data Not Ready. The RDYB bit is set to 1 to indicate that the ADC is placed into idle or standby mode, to indicate a new calibration started, or to indicate that a new conversion started and new data is not yet available. The RDYB bit is set to 1 in continuous conversion mode. Asserting the \$\overline{SYNC}\$ pin (taking it low) also sets the RDYB bit to 1 if the data register is not read after a conversion result. The RDYB bit is set to 1 four MCLK cycles before the next conversion result is written to indicate that the data register is about to be updated, and therefore, is not read. If the data register is being read when an ADC result is written, that write is aborted. There is no mixing of data values, but one ADC conversion is missed. | | |
| | MAIN_ERR | | Main Error Bit. This bit is set when any of the errors in the error register are set to 1. This bit is automatically cleared once there are no errors in the error register. | 0x0 | R |
| | | 0 | No Error Detected. | | |
| | | 1 | Main Error Detected. | | |
| | RESERVED | | Reserved. | 0x0 | R |
| 1 | POR_FLAG | | POR Event Detected Bit. A POR is triggered at power-up or when the IOV _{DD} and/or digital LDO power supply dips below the threshold value. This bit is set to 1 when a POR event occurs and is cleared when the user reads the status register. | 0x1 | R |
| | | 0 | No POR Event Detected. | | |
| | | 1 | POR Event Detected. | | |
| [3:0] | CH_ACTIVE | | ADC Data Result Channel Indicator. These bits indicate which channel is active for the ADC conversion whose result is currently in the data register. This may be different from the channel currently being converted. These values are a direct map from the CHANNEL_m register currently active. CHANNEL_0 results in CH_ACTIVE = 0b0000 while CHANNEL_15 results in CH_ACTIVE = 0b1111. | 0x0 | R |

analog.com Rev. A | 77 of 99

AD4131-8 REGISTERS

ADC Control Register

Address: 0x01, Reset: 0x4000, Name: ADC_CONTROL

Controls the operation mode of the ADC.

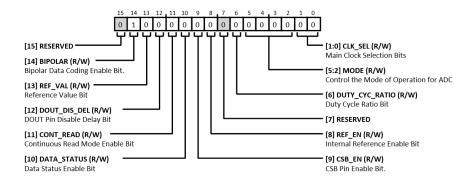


Figure 100.

Table 70. Bit Descriptions for ADC_CONTROL Register

| Bits | Bit Name | Settings | Description | Reset | Access |
|------|--------------|----------|--|-------|--------|
| 15 | RESERVED | | Reserved. | 0x0 | R |
| 14 | BIPOLAR | | Bipolar Data Coding Enable Bit. Set the output coding of the ADC. This is a digital correction—the ADC conversion is performed on a bipolar input span. | 0x1 | R/W |
| | | 0 | Straight Binary (Unipolar) Coding. Input range: 0 V to V _{REF} /gain. | | |
| | | | V _{REF} /gain: 0xFFFF 0: 0x0000 | | |
| | | 1 | Offset Binary (Bipolar) Coding. Input range: -V _{REF} /gain to V _{REF} /gain | | |
| | | | V _{REF} /gain: 0xFFFF | | |
| | | | 0: 0x8000 | | |
| | | | -V _{REF} /gain: 0x0000 | | |
| 13 I | INT_REF_VAL | | Internal Reference Value Bit. Specifies the voltage of the internal precision reference. This bit must be used in conjunction with the INT_REF_EN bit in this same register. | 0x0 | R/W |
| | | 0 | 2.5 V. | | |
| | | 1 | 1.25 V. | | |
| 12 | DOUT_DIS_DEL | | DOUT (WLCSP) or DOUT/RDY (LFCSP) Pin Disable Delay Bit. This bit controls the SCLK inactive edge to the DOUT pin disable time when the CSB_EN bit is set to 0 in the ADC_CONTROL register. | 0x0 | R/W |
| | | 0 | Delay = 10 ns. | | |
| | | 1 | Delay = 100 ns. | | |
| 11 | CONT_READ | | Continuous Read Mode Enable Bit. This bit enables the continuous read of the data register. In continuous read mode, it is not required to write to the COMMS register before reading ADC data. Instead, apply the required number of SCLKs after the data ready signal goes low. The data ready signal acts as a framing signal during continuous read. SCLKs are ignored until the data ready signal goes low. This means that each ADC result can be read once. In addition, if a read is still in progress four MCLK cycles before the next conversion, the read is abandoned, and the data ready signal is deasserted (set high). If CRC is active, it is possible to determine that a read is not valid. To exit continuous read mode, issue a software reset command (64 1s) or write a read data command (0x42). No CRC is required if CRC is enabled. | 0x0 | R/W |
| | | 0 | Continuous Read Mode Disabled. | | |

analog.com Rev. A | 78 of 99

AD4131-8 REGISTERS

Table 70. Bit Descriptions for ADC_CONTROL Register (Continued)

| Bits | Bit Name | Settings | Description | Reset | Access |
|------|----------------|----------|--|-------|--------|
| | | 1 | Continuous Read Mode Enabled. | | |
| 0 | DATA_STATUS | | Data Status Enable Bit. When this bit is set to 1, the status register content is appended to the data register output so that the channel status information is transmitted with the data. Thus, the format for reading the data register becomes (DATA, Bits[23:0], STATUS, Bits[7:0]). This aids in identifying the channel associated with the conversion being read in the data register, as well as correlate statuses | 0x0 | R/W |
| | | | with the data being read. | | |
| | | 0 | | | |
| | CSB_EN | ' | Solution Appendict to Bata. Solution Specification Bata. Solution Specification Bata. Solution Specification Bata. | 0x0 | R/W |
| | | 1 | CS Pin Functionality Disabled. SPI interface in 3-wire mode. The interface is reset on last rising edge of SCLK. Therefore, when reading from the device, the DOUT pin (WLCSP) is disabled on the last rising edge of SCLK or DOUT/RDY pin (LFCSP) switches from data output to data ready functionality on last rising edge of SCLK (assuming that data ready signal is configured to be sent out to the DOUT (WLCSP) or DOUT/RDY (LFCSP) pin). This timing can be changed through the DOUT_DIS_DEL bit in the ADC_CONTROL register. Attention must be paid to supply the correct number of clocks for the appropriate register in a write or read command. Register sizes can be 8-bit/16-bit/24-bit and enabling CRC and appending statuses in some cases also increases the data width. The \overline{CS} pin must be connected low to keep the DOUT (WLCSP) or DOUT/\overline{RDY} (LFCSP) pin. \overline{CS} Pin Functionality Enabled. SPI interface in 4-wire mode. The interface is reset on the rising edge of \overline{CS}. Therefore, when reading from the device, the DOUT(WLCSP) or DOUT/\overline{RDY} (LFCSP) pin switches from data output functionality to data ready interrupt functionality on the rising edge of \overline{CS} (assuming that the data ready signal is configured to be sent out to the DOUT (WLCSP) or DOUT/\overline{RDY} (LFCSP) pin). The user can enable the SPI_WRITE_ERR bit, SPI_READ_ERR bit, and SPI_SCLK_CNT_ERR bit, as these are only valid when \overline{CS} is enabled. When \overline{CS} is high, the DOUT | | |
| | INT_REF_EN | | (WLCSP) or DOUT/RDY (LFCSP) pin is tristated. Internal Reference Enable Bit. When the internal precision reference is enabled, the value seen at the REFOUT pin depends on the setting of INT_REF_VAL bit in this same register. | 0x0 | R/W |
| | | 0 | | | |
| | | 1 | Internal Reference Enabled. | | |
| | RESERVED | | Reserved. | 0x0 | R |
| | DUTY_CYC_RATIO | 0 | | 0x0 | R/W |
| 5:2] | MODE | | Control the Mode of Operation for ADC. | 0x0 | R/W |
| , | | 0000 | · | J GAG | |
| | | 0001 | | | |
| | | 0010 | | | |
| | | 0011 | · | | |
| | | 0100 | Idle Mode. The digital filter and the modulator are held in reset. There is no change to anything else. | | |
| | | 0101 | Internal Offset Calibration (Zero Scale). The device returns to idle mode once calibration is completed. | | |
| | | 0110 | | | |
| | | 0111 | System Offset Calibration (Zero Scale). The device returns to idle mode once calibration is completed. | | |

analog.com Rev. A | 79 of 99

AD4131-8 REGISTERS

Table 70. Bit Descriptions for ADC CONTROL Register (Continued)

| Bits | Bit Name | Settings | Description | Reset | Access |
|------|----------|--------------|--|-------|--------|
| | | 1000 | System Gain Calibration (Full Scale). The device returns to idle mode once calibration is completed. | | |
| | | 1001 | Duty Cycling Mode. The device cycles between converting the selected sequence and standby based on the DUTY_CYC_RATIO bit in this register. | | |
| | | 1010 | Single Sequence + idle by $\overline{\text{SYNC}}$ Mode. The device cycles between converting the selected sequence and idle mode based on the $\overline{\text{SYNC}}$ pin pulses from high to low. | | |
| | | 1011 | Single Sequence + STBY by SYNC Mode. The device cycles between converting the selected sequence and standby based on the SYNC pin pulses from high to low. | | |
| | | 1100 to 1111 | Reserved. | | |
| 1:0] | MCLK_SEL | | Main Clock Selection Bits. | 0x0 | R/W |
| | | 00 | Internal 76.8 kHz-Output Off. Internal clock used as clock source, but not available at the CLK pin. | | |
| | | 01 | Internal 76.8 kHz-Output On. Internal clock used as clock source, and available at the CLK pin. | | |
| | | 10 | External 76.8 kHz. External CLK pin used as clock source. | | |
| | | 11 | External 153.6 kHz. External CLK pin used as clock source after being divided by 2 internally. | | |

ADC Conversion Result Register

Address: 0x02, Reset: 0x0000, Name: DATA

Stores latest ADC result.

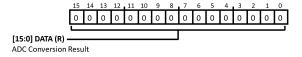


Figure 101.

Table 71. Bit Descriptions for DATA Register

| Bits | Bit Name | Settings | Description | Reset | Access |
|--------|----------|----------|--|-------|--------|
| [15:0] | DATA | | ADC Conversion Result. This register contains the result of the latest ADC conversion. | 0x0 | R |

Input/Output Control Register

Address: 0x03, Reset: 0x0000, Name: IO_CONTROL

Controls some of the input/output ports.

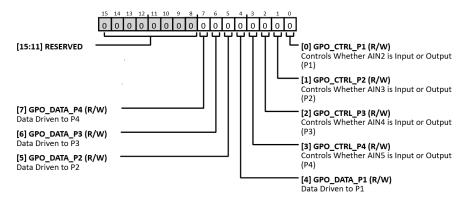


Figure 102.

analog.com Rev. A | 80 of 99

AD4131-8 REGISTERS

Table 72. Bit Descriptions for IO_CONTROL Register

| Bits | Bit Name | Settings | Description | Reset | Access |
|--------|-------------|----------|---|-------|--------|
| [15:8] | RESERVED | | Reserved. | 0x0 | R |
| 7 | GPO_DATA_P4 | | Data Driven to P4. When the pin is configured as an output in GPO_CTRL_P4. | 0x0 | R/W |
| 6 | GPO_DATA_P3 | | Data Driven to P3. When the pin is configured as an output in GPO_CTRL_P3. | 0x0 | R/W |
| 5 | GPO_DATA_P2 | | Data Driven to P2. When the pin is configured as an output in GPO_CTRL_P2. | 0x0 | R/W |
| 4 | GPO_DATA_P1 | | Data Driven to P1. When the pin is configured as an output in GPO_CTRL_P1. | 0x0 | R/W |
| 3 | GPO_CTRL_P4 | | Controls Whether AIN5 is Input or Output (P4). Functions as standby pin (through the STBY_OUT_EN bit in the MISC register), takes highest priority, and overrides its other functions. | 0x0 | R/W |
| | | 0 | GPIO Has Specific Input Function. | | |
| | | 1 | GPIO Functions as Output. | | |
| 2 | GPO_CTRL_P3 | | Controls Whether AIN4 is Input or Output (P3). | 0x0 | R/W |
| | | 0 | GPIO Has Specific Input Function. | | |
| | | 1 | GPIO Functions as Output. | | |
| 1 | GPO_CTRL_P2 | | Controls Whether AIN3 is Input or Output (P2). Functions as an interrupt pin (through the INT_PIN_SEL bit of the IO_CONTROL Register), takes highest priority, and overrides its other functions. | 0x0 | R/W |
| | | 0 | GPIO Has Specific Input Function. | | |
| | | 1 | GPIO Functions as Output. | | |
| 0 | GPO_CTRL_P1 | | Controls Whether AIN2 is Input or Output (P1). | 0x0 | R/W |
| | | 0 | GPIO Has Specific Input Function. | | |
| | | 1 | GPIO Functions as Output. | | |

analog.com Rev. A | 81 of 99

AD4131-8 REGISTERS

VBIAS Control Register

Address: 0x04, Reset: 0x0000, Name: VBIAS_CONTROL

Select output VBIAS on the analog input pins.

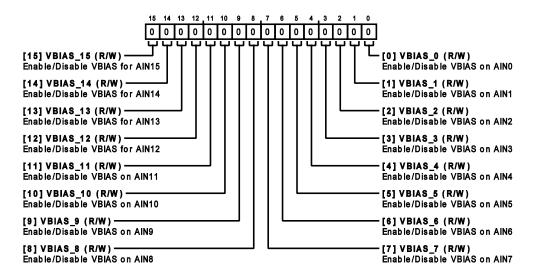


Figure 103.

Table 73. Bit Descriptions for VBIAS_CONTROL Register

| Bits | Bit Name | Settings | Description | Reset | Access |
|------|----------|----------|---------------------------------|-------|--------|
| 15 | VBIAS_15 | | Enable/Disable VBIAS for AIN15. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
| 14 | VBIAS_14 | | Enable/Disable VBIAS for AIN14. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
| 13 | VBIAS_13 | | Enable/Disable VBIAS for AIN13. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
| 12 | VBIAS_12 | | Enable/Disable VBIAS for AIN12. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
| 11 | VBIAS_11 | | Enable/Disable VBIAS on AIN11. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
| 10 | VBIAS_10 | | Enable/Disable VBIAS on AIN10. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
| 9 | VBIAS_9 | | Enable/Disable VBIAS on AIN9. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
| 8 | VBIAS_8 | | Enable/Disable VBIAS on AIN8. | 0x0 | R/W |

analog.com Rev. A | 82 of 99

AD4131-8 REGISTERS

Table 73. Bit Descriptions for VBIAS_CONTROL Register (Continued)

| Bits | Bit Name | Settings | Description | Reset | Access |
|------|----------|----------|-------------------------------|-------|--------|
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
| 7 | VBIAS_7 | | Enable/Disable VBIAS on AIN7. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
| 3 | VBIAS_6 | | Enable/Disable VBIAS on AIN6. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
| 5 | VBIAS_5 | | Enable/Disable VBIAS on AIN5. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
| | VBIAS_4 | | Enable/Disable VBIAS on AIN4. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
| } | VBIAS_3 | | Enable/Disable VBIAS on AIN3. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
| | VBIAS_2 | | Enable/Disable VBIAS on AIN2. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
| | VBIAS_1 | | Enable/Disable VBIAS on AIN1. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |
|) | VBIAS_0 | | Enable/Disable VBIAS on AIN0. | 0x0 | R/W |
| | | 0 | VBIAS Disabled on This Pin. | | |
| | | 1 | VBIAS Enabled on This Pin. | | |

analog.com Rev. A | 83 of 99

AD4131-8 REGISTERS

Identification Register

Address: 0x05, Reset: 0x0X, Name: ID

Returns an 8-bit ID of the device.

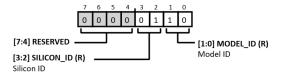


Figure 104.

Table 74. Bit Descriptions for ID Register

| Bits | Bit Name | Settings | Description | Reset | Access |
|-------|------------|----------|--|-------|--------|
| [7:4] | RESERVED | | Reserved. | 0x0 | R |
| [3:2] | SILICON_ID | | Silicon ID. | 0x1 | R |
| [1:0] | MODEL_ID | | 16-Bit WLCSP Model ID. These bits are set by default for each model and are read only. | 0xXX | R |
| | | 00 | 24-Bit WLCSP | | |
| | | 01 | 24-Bit LFCSP | | |
| | | 10 | 16-Bit WLCSP | | |
| | | 11 | 16-Bit LFCSP | | |

Error Register

Address: 0x06, Reset: 0x0000, Name: ERROR

Each error bit in this register must be enabled in the ERROR_EN register to work as expected. All bits in this register are R/W1C.

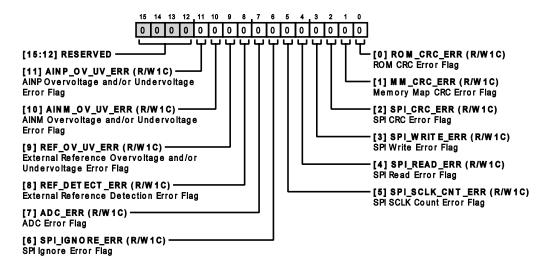


Figure 105.

Table 75. Bit Descriptions for ERROR Register

| Bits | Bit Name | Settings | Description | Reset | Access |
|---------|----------|----------|-------------|-------|--------|
| [15:12] | RESERVED | | Reserved. | 0x0 | R |

analog.com Rev. A | 84 of 99

AD4131-8 REGISTERS

Table 75. Bit Descriptions for ERROR Register (Continued)

| Bits | Bit Name | Settings | Description | Reset | Access |
|------|------------------|----------|---|-------|--------|
| 11 | AINP_OV_UV_ERR | | AINP Overvoltage and/or Undervoltage Error Flag. When set, this bit indicates that an overvoltage and/or undervoltage error on AINP is detected. Enable this error flag in the ERROR_EN register. | 0x0 | R/W1C |
| | | 0 | No Error Detected. | | |
| | | 1 | AINP OV/UV Error Detected. | | |
| 10 | AINM_OV_UV_ERR | | AINM Overvoltage and/or Undervoltage Error Flag. When set, this bit indicates that an overvoltage and/or undervoltage error on AINM is detected. Enable this error flag in the ERROR_EN register. | 0x0 | R/W1C |
| | | 0 | No Error Detected. | | |
| | | 1 | AINM OV/UV Error Detected. | | |
| 1 | REF_OV_UV_ERR | | External Reference Overvoltage and/or Undervoltage Error Flag. When set, this bit indicates that an overvoltage and/or undervoltage is detected on the external reference. Enable this error flag in the ERROR_EN register. | 0x0 | R/W1C |
| | | 0 | No Error Detected. | | |
| | | 1 | REFIN OV/UV Error Detected. | | |
| } | REF_DETECT_ERR | | External Reference Detection Error Flag. When set, this bit indicates that the external reference voltage (REFINx(+) – REFINx(-)) is less than the threshold. Enable this error flag in the ERROR_EN register. | 0x0 | R/W1C |
| | | 0 | No Error Detected. | | |
| | | 1 | REFIN Error Detected. | | |
| 7 | ADC_ERR | | ADC Error Flag. This error sets when one of the following ADC conversion/calibration errors is detected: ADC conversion result is clamped at positive full scale; ADC conversion result is clamped at negative full scale; ADC offset/gain calibration result outside specified range; modulator is in saturation. Enable this error flag in the ERROR_EN register. | 0x0 | R/W1C |
| | | 0 | No Error Detected. | | |
| | | 1 | ADC Error Detected. | | |
| | SPI_IGNORE_ERR | | SPI Ignore Error Flag. When set, this bit indicates that an SPI access is made at a time when it is ignored (such as while the ROM content is being downloaded). Enable this error flag in the ERROR_EN register. | 0x0 | R/W1C |
| | | 0 | No Error Detected. | | |
| | | 1 | SPI Error Detected. | | |
| | SPI_SCLK_CNT_ERR | | SPI SCLK Count Error Flag. When set, this bit indicates that the SCLKs on a given SPI frame are not multiples of eight. Enable this error flag in the ERROR_EN register. | 0x0 | R/W1C |
| | | 0 | No Error Detected. | | |
| | | 1 | SCLK Count Error Detected. | | |
| | SPI_READ_ERR | | SPI Read Error Flag. When set, this bit indicates that an SPI read is performed on an invalid address. Enable this error flag in the ERROR_EN register. | 0x0 | R/W1C |
| | | 0 | No Error Detected. | | |
| | | 1 | SPI Read Error Detected. | | |
| | SPI_WRITE_ERR | | SPI Write Error Flag. When set, this bit indicates that an SPI write is performed on an invalid address. Enable this error flag in the ERROR_EN register. | 0x0 | R/W1C |
| | | 0 | No Error Detected. | | |
| | | 1 | SPI Write Error Detected. | | |
| | SPI_CRC_ERR | | SPI CRC Error Flag. When set, this bit indicates that a CRC error on the SPI communication is detected. Enable this error flag in the ERROR_EN register. | 0x0 | R/W1C |
| | 1 | 0 | No Error Detected. | I | 1 |

analog.com Rev. A | 85 of 99

AD4131-8 REGISTERS

Table 75. Bit Descriptions for ERROR Register (Continued)

| Bits | Bit Name | Settings | Description | Reset | Access |
|------|-------------|----------|---|-------|--------|
| | | 1 | SPI CRC Error Detected. | | |
| 1 | MM_CRC_ERR | | Memory Map CRC Error Flag. When this error is enabled, periodic CRC checks on the memory map are performed. When set, this bit indicates that a change in the memory map contents (without actual writes) is detected. Enable this error flag in the ERROR_EN register. | 0x0 | R/W1C |
| | | 0 | No Error Detected. | | |
| | | 1 | Memory Map CRC Error Detected. | | |
|) | ROM_CRC_ERR | | ROM CRC Error Flag. A CRC calculation is performed on the ROM contents upon power-up. When set, this bit indicates that the ROM contents changed. Enable this error flag in the ERROR_EN register. | 0x0 | R/W1C |
| | | 0 | No Error Detected. | | |
| | | 1 | ROM CRC Error Detected. | | |

Error Enable Register

Address: 0x07, Reset: 0x0040, Name: ERROR_EN

Each bit in this register enables a flag in the error register.

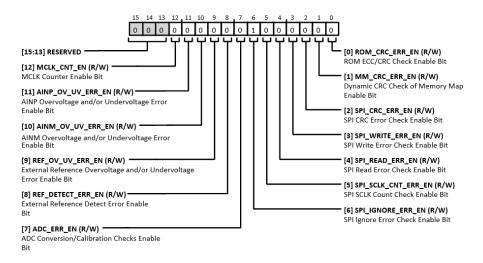


Figure 106.

Table 76. Bit Descriptions for ERROR_EN Register

| Bits | Bit Name | Settings | Description | Reset | Access |
|---------|-------------------|----------|---|-------|--------|
| [15:13] | RESERVED | | Reserved. | 0x0 | R |
| 12 | MCLK_CNT_EN | | MCLK Counter Enable Bit. The counter value is reported via the MCLK_COUNT register. | 0x0 | R/W |
| | | 0 | MCLK Counter Disabled. | | |
| | | 1 | MCLK Counter Enabled. | | |
| 11 | AINP_OV_UV_ERR_EN | | AINP Overvoltage and/or Undervoltage Error Enable Bit. When set to 1, this bit enables the AINP overvoltage error seen in the error register. | 0x0 | R/W |
| | | 0 | AINP OV/UV Error Disabled. | | |
| | | 1 | AINP OV/UV Error Enabled. | | |

analog.com Rev. A | 86 of 99

AD4131-8 REGISTERS

Table 76. Bit Descriptions for ERROR_EN Register (Continued)

| Bits | Bit Name | Settings | Description | Reset | Access |
|------|---------------------|----------|--|-------|--------|
| 10 | AINM_OV_UV_ERR_EN | | AINM Overvoltage and/or Undervoltage Error Enable Bit. When set to 1, this bit enables the AINM overvoltage/undervoltage error seen in the error register. | 0x0 | R/W |
| | | 0 | AINM OV/UV Error Disabled. | | |
| | | 1 | AINM OV/UV Error Enabled. | | |
| 9 | REF_OV_UV_ERR_EN | | External Reference Overvoltage and/or Undervoltage Error Enable Bit. When set to 1, this bit enables the external reference overvoltage/undervoltage error seen in the error register. | 0x0 | R/W |
| | | 0 | REFIN OV/UV Error Disabled. | | |
| | | 1 | REFIN OV/UV Error Enabled. | | |
| 8 | REF_DETECT_ERR_EN | | External Reference Detect Error Enable Bit. When set to 1, this bit enables the external reference error seen in the error register. | 0x0 | R/W |
| | | 0 | REFIN Error Disabled. | | |
| | | 1 | REFIN Error Enabled. | | |
| 7 | ADC_ERR_EN | | ADC Conversion/Calibration Checks Enable Bit. When set to 1, this bit enables ADC_ERR seen in the error register. | 0x0 | R/W |
| | | 0 | ADC Error Disabled. | | |
| | | 1 | ADC Error Enabled. | | |
| 6 | SPI_IGNORE_ERR_EN | | SPI Ignore Error Check Enable Bit. Enabled by default. The error is reported via the SPI_IGNORE_ERR in the error register. An error is flagged if the user writes to the memory map during power-up while fuses are copied across, or if the user writes to the memory map while offset or gain calibration is performed. | 0x1 | R/W |
| | | 0 | SPI Ignore Error Disabled. | | |
| | | 1 | SPI Ignore Error Enabled. | | |
| 5 | SPI_SCLK_CNT_ERR_EN | 0 | SPI SCLK Count Check Enable Bit. To enable this function, CSB_EN must also be set to 1 in ADC_CONTROL. The SPI SCLK counter counts the number of SCLK pulses used in each read and write operation. Solution is used. All read and write operations are multiples of eight SCLK pulses. If the SCLK counter counts the SCLK pulses and the result is not a multiple of eight, an error is flagged; the SPI_SCLK_CNT_ERR bit in the error register is set. If a write operation is performed, and the SCLK contains an insufficient number of SCLK pulses, the value is not written to the addressed register and the write operation is aborted. SPI SCLK Error Disabled. SPI SCLK Error Enabled. | 0x0 | R/W |
| 4 | SPI_READ_ERR_EN | 0 | SPI Read Error Check Enable Bit. To enable this function, CSB_EN must also be set to 1 in ADC_CONTROL. The error is reported via SPI_READ_ERR in the error register. The SPI_READ_ERR bit is flagged if the user attempts to read an invalid address. SPI Read Error Disabled. SPI Read Error Enabled. | 0x0 | R/W |
| 2 | SPI WRITE ERR EN | 1 | | ۸۷۸ | R/W |
| 3 | SPI_WKIIE_ERK_EN | | SPI Write Error Check Enable Bit. To enable this function, CSB_EN must also be a 1 in ADC_CONTROL. The error is reported via SPI_WRITE_ERR in the error register. The SPI_WRITE_ERR bit is flagged if the user attempts to write to either an invalid or read-only address. | 0x0 | IK/VV |
| | | 0 | SPI Write Error Disabled. | | |
| | | 1 | SPI Write Error Enabled. | | |
| 2 | SPI_CRC_ERR_EN | | SPI CRC Error Check Enable Bit. Using the checksum ensures that only valid data is written to a register and allows data read from a register to be validated. If an error | 0x0 | R/W |

analog.com Rev. A | 87 of 99

AD4131-8 REGISTERS

Table 76. Bit Descriptions for ERROR_EN Register (Continued)

| Bits | Bit Name | Settings | Description | Reset | Access |
|------|----------------|----------|---|-------|--------|
| | | | occurs during a register write, the CRC_ERR bit is set in the error register. However, to ensure that the register write is successful, read back the register and verify the checksum. | | |
| | | 0 | SPI CRC Check is Disabled. | | |
| | | 1 | SPI CRC Check is Enabled. | | |
| 1 | MM_CRC_ERR_EN | | Dynamic CRC Check of Memory Map Enable Bit. The error is reported via MM_CRC_ERR in the error register. Memory map CRC is performed on all memory map contents except for read-only registers (for example, status, data, and MCLK_COUNT). The CRC is performed every 426.6 µs (2.4 kHz). Any future memory write to memory map recalculates CRC. This happens for following cases: user write; offset/gain calibration; when the MODE bits change from single sequence to idle at the end of single sequence mode conversions; when exiting continuous read mode, the CONT_READ bit changes to 0 in ADC_CONTROL. | 0x0 | R/W |
| | | 0 | MM CRC Check Disabled. | | |
| | | 1 | MM CRC Check Enabled. | | |
| 0 | ROM_CRC_ERR_EN | | ROM ECC/CRC Check Enable Bit. ROM CRC is always performed on power-up and this bit enables reporting of error. The error is reported via ROM_CRC_ERR in the error register. | 0x0 | R/W |
| | | 0 | ROM CRC/ECC Check Disabled. | | |
| | | 1 | ROM CRC/ECC Check Enabled. | | |

MCLK Counter Register

Address: 0x08, Reset: 0x00, Name: MCLK_COUNT

Returns the MCLK count value when functionality is enabled.

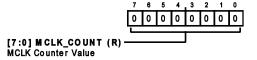


Figure 107.

Table 77. Bit Descriptions for MCLK_COUNT Register

| Bits | Bit Name | Settings | Description | Reset | Access |
|-------|------------|----------|---|-------|--------|
| [7:0] | MCLK_COUNT | | MCLK Counter Value. This register allows the user to determine the frequency of the internal/external oscillator. Internally a clock counter increments every 131 pulses of the main clock (f _{MCLK} = 76.8 kHz), giving it an update rate of 586.26 Hz. The 8-bit counter wraps around on reaching its maximum value. Enable the MCLK counter functionality using the MCLK_CNT_EN bit in the ERROR_EN register. | 0x00 | R |

analog.com Rev. A | 88 of 99

AD4131-8 REGISTERS

Channel 0 and m Configuration Registers (m = 1 to 15)

Address: 0x09 to 0x18 (in Increments of 1), Reset: 0x800100 (CHANNEL_0), 0x000100 (All Other Channels), Name: CHANNEL_m (m = 1 to 15)

These registers enable channels in the automated sequence, select plus and minus inputs and determine the availability of excitation currents on specific inputs. They also select the ADC Setup 'n' associated with each channel. An ADC setup is made up of configuration, filter, offset, and gain registers.

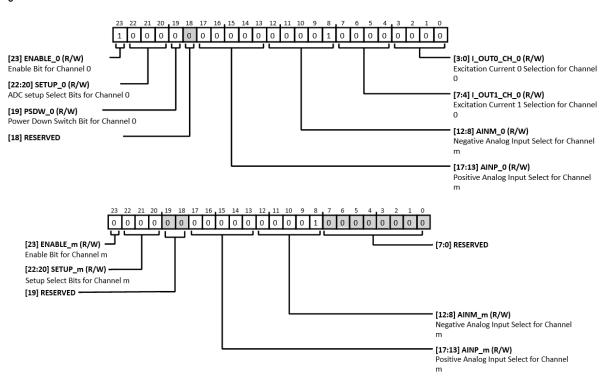


Figure 108.

Table 78. Bit Descriptions for CHANNEL_0 and CHANNEL_m Registers

| Bits | Bit Name | Settings | Description | Reset | Access |
|---------|----------|----------|--|------------------------------------|--------|
| 23 | ENABLE_m | 0 | Enable Bit for Channel m. This bit enables the relative channel to take part in the sequence. By default, only the ENABLE_0 bit for CHANNEL_0 is set to 1, and all the other ENABLE_m bits are set to 0. The order of conversions starts with the lowest enabled channel, then cycles through successively higher channel numbers, before wrapping around to the lowest channel again. When the ADC writes a result for a particular channel, the four LSBs of the status register are set to the channel number (range: 0 to 15). This allows to identify the channel that corresponds to the data being read. Channel Disabled. | 0x1 (CHANNEL_0) 0x0 (CHANNEL_m) | R/W |
| | | 1 | Channel Enabled. | | |
| [22:20] | SETUP_m | | ADC Setup Select Bits for Channel m. An ADC setup comprises a set of four corresponding registers: (CONFIG_n, FILTER_n, OFFSET_n, and GAIN_n). For example, if a channel has a SETUP_m value of 0, its settings come from CONFIG_0, FILTER_0, OFFSET_0, and GAIN_0. All channels can use the same setup, in which case the same 3-bit value is written to these bits on all active channels, or up to eight channels can be configured differently. | 0x0 | R/W |
| | | 0 | ADC Setup 0. CONFIG_0/FILTER_0/OFFSET_0/GAIN_0 configuration used to configure ADC for this channel. | | |

analog.com Rev. A | 89 of 99

AD4131-8 REGISTERS

Table 78. Bit Descriptions for CHANNEL_0 and CHANNEL_m Registers (Continued)

| Bits | Bit Name | Settings | Description | Reset | Access |
|---------|-----------------------------------|----------|---|-------|--------|
| | | 1 | ADC Setup 1. CONFIG_1/FILTER_1/OFFSET_1/GAIN_1 configuration used to configure ADC for this channel. | | |
| | | 2 | ADC Setup 2. CONFIG_2/FILTER_2/OFFSET_2/GAIN_2 configuration used to configure ADC for this channel. | | |
| | | 3 | ADC Setup 3. CONFIG_3/FILTER_3/OFFSET_3/GAIN_3 configuration used to configure ADC for this channel. | | |
| | | 4 | ADC Setup 4. CONFIG_4/FILTER_4/OFFSET_4/GAIN_4 configuration used to configure ADC for this channel. | | |
| | | 5 | ADC Setup 5. CONFIG_5/FILTER_5/OFFSET_5/GAIN_5 configuration used to configure ADC for this channel. | | |
| | | 6 | ADC Setup 6. CONFIG_6/FILTER_6/OFFSET_6/GAIN_6 configuration used to configure ADC for this channel. | | |
| | | 7 | ADC Setup 7. CONFIG_7/FILTER_7/OFFSET_7/GAIN_7 configuration used to configure ADC for this channel. | | |
| 19 | PDSW_m (CHANNEL_0) RESERVED | | Power-Down Switch Bit for Channel m. This bit enables the option to connect the PSW pin to AV _{SS} on a per-channel basis, except when the device is in power-down or standby mode. If this bit is 1, the power-down switch is enabled for this channel, and anything connected to the | 0x0 | R/W |
| | (CHANNEL_m) | | PSW pin is shorted to AV _{SS} . In power-down mode, the switch is opened automatically (that is, disabled). While the device is in standby mode, the functionality of this bit is disabled if the STBY_PDSW_EN bit in the MISC register is set to 0. | | |
| | | 0 | Power-Down Switch Off. The power-down switch is always disabled for this channel. | | |
| | | 1 | Power-Down Switch On. This allows the PSW pin to sink current. | | |
| 18 | RESERVED | | Reserved. | 0x0 | R |
| [17:13] | AINP_m | | Positive Analog Input Select for Channel m. These bits select which of the analog inputs is connected to the positive input for this channel. | 0x0 | R/W |
| | | 00000 | AINO. | | |
| | | 00001 | AIN1. | | |
| | | 00010 | AIN2. | | |
| | | 00011 | AIN3. | | |
| | | 00100 | AIN4. | | |
| | | 00101 | AIN5. | | |
| | | 00110 | AIN6. | | |
| | | 00111 | AIN7. | | |
| | | 01000 | AIN8. | | |
| | | 01001 | AIN9. | | |
| | | 01010 | AIN10. | | |
| | | 01011 | AIN11. | | |
| | | 01100 | AIN12. | | |
| | | 01101 | AIN13. | | |
| | | 01110 | AIN14. | | |
| | | 01111 | AIN15. | | |
| | | 10000 | Temperature Sensor. | | |
| | | 10001 | AV _{SS} . | | |
| | | 10001 | Internal Reference. | | |
| | | 10010 | DGND. | | |
| | | | | | |
| | | 10100 | $(AV_{DD} - AV_{SS})/6+$. Use in conjunction with $(AV_{DD} - AVSS)/6-$ to monitor supply $AV_{DD} - AV_{SS}$. | | |

analog.com Rev. A | 90 of 99

AD4131-8 REGISTERS

Table 78. Bit Descriptions for CHANNEL_0 and CHANNEL_m Registers (Continued)

| Bits | Bit Name | Settings | Description | Reset | Access |
|--------|----------|----------|---|-------|--------|
| | | 10101 | $(AV_{DD} - AV_{SS})/6$ Use in conjunction with $(AV_{DD} - AV_{SS})/6$ + to monitor supply $AV_{DD} - AV_{SS}$. | | |
| | | 10110 | $(IOV_{DD} - DGND)/6+$. Use in conjunction with $(IOV_{DD} - DGND)/6-$ to monitor $IOV_{DD} - DGND$. | | |
| | | 10111 | $(IOV_{DD} - DGND)/6-$. Use in conjunction with $(IOV_{DD} - DGND)/6+$ to monitor $IOV_{DD} - DGND$. | | |
| | | 11000 | (ALDO – AV _{SS})/6+. Use in conjunction with (ALDO – AVSS)/6– to monitor the analog LDO. | | |
| | | 11001 | (ALDO – AV _{SS})/6 Use in conjunction with (ALDO – AVSS)/6+ to monitor the analog LDO. | | |
| | | 11010 | (DLDO - DGND)/6+. Use in conjunction with (DLDO - DGND)/6- to monitor the digital LDO. | | |
| | | 11011 | (DLDO - DGND)/6 Use in conjunction with (DLDO - DGND)/6+ to monitor the digital LDO. | | |
| | | 11100 | V_MV_P. Use in conjunction with V_MV_M to apply a tens of mV _{P-P} signal to the ADC. | | |
| | | 11101 | V_MV_M. Use in conjunction with V_MV_P to apply a tens of mV _{P-P} signal to the ADC | | |
| | | 11110 | Reserved. | | |
| | | 11111 | Reserved. | | |
| [12:8] | AINM_m | | Negative Analog Input Select for Channel m. These bits select which of the analog inputs is connected to the negative input for this channel. | 0x1 | R/W |
| | | 00000 | AINO. | | |
| | | 00001 | AIN1. | | |
| | | 00010 | AIN2. | | |
| | | 00011 | AIN3. | | |
| | | 00100 | AIN4. | | |
| | | 00101 | AIN5. | | |
| | | 00110 | AIN6. | | |
| | | 00111 | AIN7. | | |
| | | 01000 | AIN8. | | |
| | | 01001 | AIN9. | | |
| | | 01010 | AIN10. | | |
| | | 01011 | AIN11. | | |
| | | 01100 | AIN12. | | |
| | | 01101 | AIN13. | | |
| | | 01110 | AIN14. | | |
| | | 01111 | AIN15. | | |
| | | 10000 | Temperature Sensor. | | |
| | | 10001 | AV _{SS} . | | |
| | | 10010 | Internal Reference. | | |
| | | 10011 | DGND. | | |
| | | 10100 | $(AV_{DD} - AV_{SS})/6+$. Use in conjunction with $(AV_{DD} - AV_{SS})/6-$ to monitor supply $AV_{DD} - AV_{SS}$. | | |
| | | 10101 | $(AV_{DD} - AV_{SS})/6-$. Use in conjunction with $(AV_{DD} - AV_{SS})/6+$ to monitor supply $AV_{DD} - AV_{SS}$. | | |
| | | 10110 | (IOV _{DD} - DGND)/6+. Use in conjunction with (IOV _{DD} - DGND)/6- to monitor IOV _{DD} - DGND. | | |
| | | 10111 | (IOV _{DD} - DGND)/6 Use in conjunction with (IOV _{DD} - DGND)/6+ to monitor IOV _{DD} - DGND. | | |
| | | 11000 | (ALDO – AV _{SS})/6+. Use in conjunction with (ALDO – AV _{SS})/6– to monitor the analog LDO. | | |
| | | 11001 | (ALDO – AV _{SS})/6 Use in conjunction with (ALDO – AV _{SS})/6+ to monitor the analog LDO. | | |
| | | 11010 | (DLDO – DGND)/6+. Use in conjunction with (DLDO – DGND)/6– to monitor the digital LDO. | | |
| | | 11011 | (DLDO – DGND)/6–. Use in conjunction with (DLDO – DGND)/6+ to monitor the digital LDO. | | |
| | | 11100 | V_MV_P. Use in conjunction with V_MV_M to apply a tens of mV _{P-P} signal to the ADC. | | |
| | | 11101 | V_MV_M. Use in conjunction with V_MV_P to apply a tens of mV _{P.P} signal to the ADC. | | |
| | | 11110 | Reserved. | | |

analog.com Rev. A | 91 of 99

AD4131-8 REGISTERS

Table 78. Bit Descriptions for CHANNEL_0 and CHANNEL_m Registers (Continued)

| Bits | Bit Name | Settings | Description | Reset | Access |
|-------|---|----------|---|-------|--------|
| | | 11111 | Reserved. | | |
| [7:4] | I_OUT1_CH_m | | Excitation Current 1 Selection for Channel m. | 0x0 | R/W |
| | (CHANNEL_0) | | | | |
| | RESERVED (CHANNEL_m) | | | | |
| | (OII) WIVEL_III) | 0000 | I_OUT1 is available on AIN0. | | |
| | | 0001 | I_OUT1 is available on AIN1. | | |
| | | 0010 | I OUT1 is available on AIN2. | | |
| | | 0011 | I_OUT1 is available on AIN3. | | |
| | | 0100 | I_OUT1 is available on AIN4. | | |
| | | 0101 | I OUT1 is available on AIN5. | | |
| | | 0110 | I_OUT1 is available on AIN6. | | |
| | | 0111 | I_OUT1 is available on AIN7. | | |
| | | 1000 | I_OUT1 is available on AIN8. | | |
| | | 1001 | I_OUT1 is available on AIN9. | | |
| | | 1010 | I_OUT1 is available on AIN10. | | |
| | | 1011 | I_OUT1 is available on AIN11. | | |
| | | 1100 | I_OUT1 is available on AIN12. | | |
| | | 1101 | I_OUT1 is available on AIN13. | | |
| | | 1110 | I_OUT1 is available on AIN14. | | |
| | | 1111 | I_OUT1 is available on AIN15. | | |
| [3:0] | I_OUT0_CH_m (CHANNEL_0) RESERVED (CHANNEL_m) | | Excitation Current 0 Selection for Channel m. | 0x0 | R/W |
| | _ / | 0000 | I_OUT0 is available on AIN0. | | |
| | | 0001 | I OUT0 is available on AIN1. | | |
| | | 0010 | I_OUT0 is available on AIN2. | | |
| | | 0011 | I_OUT0 is available on AIN3. | | |
| | | 0100 | I_OUT0 is available on AIN4. | | |
| | | 0101 | I_OUT0 is available on AIN5. | | |
| | | 0110 | I_OUT0 is available on AIN6. | | |
| | | 0111 | I_OUT0 is available on AIN7. | | |
| | | 1000 | I_OUT0 is available on AIN8. | | |
| | | 1001 | I_OUT0 is available on AIN9. | | |
| | | 1010 | I_OUT0 is available on AIN10. | | |
| | | 1011 | I_OUT0 is available on AIN11. | | |
| | | 1100 | I_OUT0 is available on AIN12. | | |
| | | 1101 | I_OUT0 is available on AIN13. | | |
| | | 1110 | I_OUT0 is available on AIN14. | | |
| | | 1111 | I_OUT0 is available on AIN15. | | |

analog.com Rev. A | 92 of 99

AD4131-8 REGISTERS

Configuration n Registers (n = 0 to 7)

Address: 0x19 to 0x20 (in Increments of 1), Reset: 0x0000, Name: CONFIG_n (n = 0 to 7)

These registers allow the user to configure excitation currents and burnout current values, reference mode and buffers, and the PGA mode for up to seven different ADC setups to be selected in the CHANNEL_m registers.

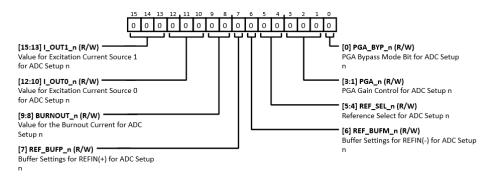


Figure 109.

Table 79. Bit Descriptions for CONFIG n Registers

| Bits | Bit Name | Settings | Description | Reset | Access |
|---------|------------|----------|--|-------|--------|
| [15:13] | I_OUT1_n | | Value for Excitation Current Source 1 for ADC Setup n. | 0x0 | R/W |
| | | 000 | Off. | | |
| | | 001 | 10 μΑ. | | |
| | | 010 | 20 μA. | | |
| | | 011 | 50 μΑ. | | |
| | | 100 | 100 μΑ. | | |
| | | 101 | 150 μΑ. | | |
| | | 110 | 200 μΑ. | | |
| | | 111 | 100 nA | | |
| [12:10] | I_OUT0_n | | Value for Excitation Current Source 0 for ADC Setup n. | 0x0 | R/W |
| | | 000 | Off. | | |
| | | 001 | 10 μΑ. | | |
| | | 010 | 20 μΑ. | | |
| | | 011 | 50 μΑ. | | |
| | | 100 | 100 μΑ. | | |
| | | 101 | 150 μΑ. | | |
| | | 110 | 200 μΑ. | | |
| | | 111 | 100 nA | | |
| [9:8] | BURNOUT_n | | Value for the Burnout Current for ADC Setup n. | 0x0 | R/W |
| | | 00 | Burnout Current Off. | | |
| | | 01 | Burnout Current = 0.5 μA. | | |
| | | 10 | Burnout Current = 2 μA. | | |
| | | 11 | Burnout Current = 4 μA. | | |
| 7 | REF_BUFP_n | | Buffer Settings for REFIN(+) for ADC setup n. | 0x0 | R/W |
| | | 0 | Buffer Bypass on REFIN(+). | | |
| | | 1 | Buffer ON for REFIN(+). | | |
| 6 | REF_BUFM_n | | Buffer Settings for REFIN(-) for ADC setup n. | 0x0 | R/W |

analog.com Rev. A | 93 of 99

AD4131-8 REGISTERS

Table 79. Bit Descriptions for CONFIG_n Registers (Continued)

| Bits | Bit Name | Settings | Description | Reset | Access |
|-------|-----------|----------|---|-------|--------|
| | | 0 | Buffer Bypass on REFIN(-). | | |
| | | 1 | Buffer ON for REFIN(-). | | |
| [5:4] | REF_SEL_n | | Reference Select for ADC setup n. | 0x0 | R/W |
| | | 00 | REFIN1(+), REFIN1(-). | | |
| | | 01 | REFIN2(+), REFIN2(-) | | |
| | | 10 | REFOUT, AV _{SS} . Internal reference. | | |
| | | 11 | AV_{DD} , AV_{SS} . | | |
| [3:1] | PGA_n | | PGA Gain Control, for ADC setup n. Controls the gain of the PGA. If PGA_BYP_n of the same CONFIG_n register is set, the PGA_n bits are ignored, and the gain is fixed at 1. | 0x0 | R/W |
| | | 000 | Gain = 1. | | |
| | | 001 | Gain = 2. | | |
| | | 010 | Gain = 4. | | |
| | | 011 | Gain = 8. | | |
| | | 100 | Gain = 16. | | |
| | | 101 | Gain = 32. | | |
| | | 110 | Gain = 64. | | |
| | | 111 | Gain = 128. | | |
| 0 | PGA_BYP_n | | PGA Bypass Mode Bit. When this bit is set, the PGA is on bypass mode and the settings in the PGA field of the same CONFIG_n register are ignored. | 0x0 | R/W |
| | | 0 | PGA Bypass Disabled. | | |
| | | 1 | PGA Bypass Enabled. | | |

analog.com Rev. A | 94 of 99

AD4131-8 REGISTERS

Filter n Registers (n = 0 to 7)

Address: 0x21 to 0x28 (in Increments of 1), Reset: 0x002030, Name: FILTER_n (n = 0 to 7)

These registers allow the user to configure up to seven different options for the digital filter to be selected in the CHANNEL_0 and CHANNEL_m registers by specifying the SETUP_m bitfields.

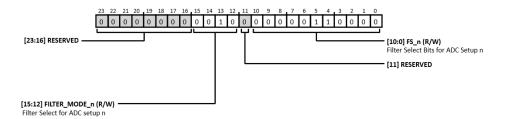


Figure 110.

Table 80. Bit Descriptions for FILTER n Registers

| Bits | Bit Name | Settings | Description | Reset | Access |
|--------|---------------|--------------|--|-------|--------|
| 23:16] | RESERVED | | Reserved. | 0x0 | R |
| 15:12] | FILTER_MODE_n | | Filter Select for ADC Setup n. | 0x2 | R/W |
| | | 0000 | Sinc ⁴ . Sinc ⁴ standalone filter | | |
| | | 0001 | Sinc ⁴ + sinc ¹ . Sinc ⁴ averaging mode filter. | | |
| | | 0010 | Sinc ³ . Sinc ³ standalone filter | | |
| | | 0011 | Sinc ³ + REJ60. This enables the generation of an additional notch at 6/5 of the main notch frequency. If the first main notch is set at 50 Hz (FS = 48), this mode enables simultaneous 50 Hz/60 Hz rejection at a 50 SPS update rate. | | |
| | | 0100 | Sinc ³ + sinc ¹ . Sinc ³ averaging mode filter. | | |
| | | 0101 | Sinc ³ + Post Filter 1. ODR (Hz) = 26.087 SPS. | | |
| | | 0110 | Sinc ³ + Post Filter 2. ODR (Hz) = 24 SPS. | | |
| | | 0111 | Sinc ³ + Post Filter 3. ODR (Hz) = 19.355 SPS. | | |
| | | 1000 | Sinc ³ + Post Filter 4. ODR (Hz) = 16.21 SPS. | | |
| | | 1001 to 1111 | Reserved. | | |
| 1 | RESERVED | | Reserved. | 0x0 | R |
| 10:0] | FS_n | | Filter Select Bits for ADC Setup n. These bits control the output data rate (ODR) of the ADC for ADC setup n. FS = 0 is treated as FS = 1. | 0x30 | R/W |

Offset n Registers (n = 0 to 7)

Address: 0x29 to 0x30 (in Increments of 1), Reset: 0x8000, Name: OFFSET_n (n = 0 to 7)

These registers store the result of offset calibration for the corresponding ADC Setup n selected in the CHANNEL m registers.

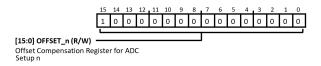


Figure 111.

analog.com Rev. A | 95 of 99

AD4131-8 REGISTERS

Table 81. Bit Descriptions for OFFSET_n Registers

| Bits | Bit Name | Settings | Description | Reset | Access |
|--------|----------|----------|--|--------|--------|
| [15:0] | OFFSET_n | | Offset Compensation Register for ADC Setup n. The results of an internal or system offset calibration gets written into the OFFSET_n register indicated by the SETUP_m bits in the CHANNEL_m register of the active channel. Only one channel can be active during a calibration. The default/reset value of the OFFSET_n registers is 0x8000. | 0x8000 | R/W |

Gain n Registers (n = 0 to 7)

Address: 0x31 to 0x38 (in increments of 1), Reset: 0xXXXX, Name: GAIN_n (n = 0 to 7)

These registers store the result of gain calibration for the corresponding ADC Setup n selected in the CHANNEL_m registers.

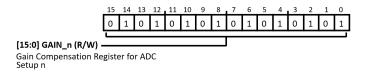


Figure 112.

Table 82. Bit Descriptions for GAIN_n Registers

| Bits | Bit Name | Settings | Description | Reset | Access |
|--------|----------|----------|--|--------|--------|
| [15:0] | GAIN_n | | Gain Compensation Register for ADC Setup n. The results of an internal or system gain calibration get written into the GAIN_n register indicated by the Setup n bits in the CHANNEL_m register of the active channel. Only one channel can be active during a calibration. The nominal value of the GAIN_n registers is 0x5555. The device is factory calibrated at ambient temperature and with a gain of 1 and PGA_BYP_n = 0, and the resulting gain coefficient is loaded to the GAIN_n registers of the device as default/reset value. | 0xXXXX | R/W |

analog.com Rev. A | 96 of 99

AD4131-8 REGISTERS

Miscellaneous Register

Address: 0x39, Reset: 0x0000, Name: MISC

Includes settings for oscillator, LDO, calibration and standby mode configuration.

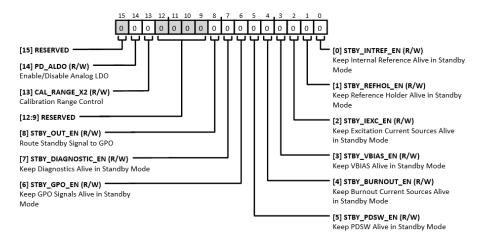


Figure 113.

Table 83. Bit Descriptions for MISC Register

| Bits | Bit Name | Settings | Description | Reset | Access |
|--------|---------------------|----------|---|-------|--------|
| 15 | RESERVED | | Reserved. Always write 0 to this bit. | 0x0 | R/W |
| 14 | PD_ALDO | | Enable/Disable Analog LDO. | 0x0 | R/W |
| | | 0 | Analog LDO On. | | |
| | | 1 | Analog LDO Off. | | |
| 13 | CAL_RANGE_X2 | | Calibration Range Control. This bit can be used for internal gain calibrations when the reference is higher than 2 V. When set to 1, this bit doubles the resistive string output voltage and improves the outcome of internal gain calibration. | 0x0 | R/W |
| | | 0 | Disabled. | | |
| | | 1 | Enabled. | | |
| [12:9] | RESERVED | | Reserved. | 0x0 | R |
| 8 | STBY_OUT_EN | | Route Standby Signal to GPO. When set to 1, values for GPO_CTRL_P4 and GPO_DATA_P4 are ignored, and the active low standby signal gets driven on the P4. When the device is in standby, the P4 pin is low. When the device is converting, the P4 pin is high. When STBY_OUT_EN is set to 1, GPO_CTRL_P4 and GPO_DATA_P4 determine if P4 is enabled and its value, respectively. | 0x0 | R/W |
| | | 0 | No Signal to P4 (AIN5). | | |
| | | 1 | Standby Signal to P4 (AIN5). | | |
| 7 | STBY_DIAGNOSTICS_EN | | Keep Diagnostics Alive in Standby Mode. Diagnostics remain active in standby mode if enabled via the ERROR_EN register. Certain errors like the overvoltage/undervoltage detection errors (refer to the ERROR_EN register) require an oscillator to be running to function properly. When in standby mode, however, the internal oscillator can be turned off to save power if there is no enabled feature that makes use of it. Setting this bit compels the device to keep the internal oscillator alive, provided the appropriate errors are also enabled (for example, at least one overvoltage/undervoltage error), and that the user selected to operate with the internal oscillator per the CLK_SEL bits of the ADC CONTROL register. | 0x0 | R/W |

analog.com Rev. A | 97 of 99

AD4131-8 REGISTERS

Table 83. Bit Descriptions for MISC Register (Continued)

| Bits | Bit Name | Settings | Description | Reset | Access |
|------|-----------------|----------|---|-------|--------|
| | | 0 | Diagnostics Disabled in Standby Mode. | | |
| | | 1 | Diagnostics Enabled in Standby Mode. | | |
| 6 | STBY_GPO_EN | | Keep GPO Signals Alive in Standby Mode. GPOs remain active in standby mode if enabled via the IO_CONTROL register | 0x0 | R/W |
| | | 0 | GPO Disabled in Standby Mode. | | |
| | | 1 | GPO Enabled in Standby Mode. | | |
| 5 | STBY_PDSW_EN | | Keep PDSW Alive in Standby Mode. | 0x0 | R/W |
| | | 0 | Power-Down Switch Disabled in Standby Mode. | | |
| | | 1 | Power-Down Switch Enabled in Standby Mode. The PDSW_m settings in the CHAN-NEL_m registers determine if the power-down switch closes or opens when the device is in standby for the channels using ADC Setup n. | | |
| 1 | STBY_BURNOUT_EN | | Keep Burnout Current Sources Alive in Standby Mode. | 0x0 | R/W |
| | | 0 | Burnout Currents Disabled in Standby Mode. | | |
| | | 1 | Burnout Currents Enabled in Standby mode. The BURNOUT_n settings in the CON-FIG_n register determines if the burnout current is enabled when device is in standby for the channels using ADC Setup n. | | |
| 3 | STBY_VBIAS_EN | | Keep VBIAS Alive in Standby Mode. | 0x0 | R/W |
| | | 0 | VBIAS Disabled in Standby Mode. | | |
| | | 1 | VBIAS Enabled in Standby Mode. The VBIAS settings in the VBIAS register determine if VBIAS is enabled for the respective AINx pin. | | |
| 2 | STBY_IEXC_EN | | Keep Excitation Current Sources Alive in Standby Mode. | 0x0 | R/W |
| | | 0 | Excitation Currents Disabled in Standby Mode. | | |
| | | 1 | Excitation Currents Enabled in Standby Mode. If set to 1, the I_OUT0_n or I_OUT1_n bits in the CONFIG_n register determines if the excitation current is enabled when device is in standby for the channels using Setup n. The excitation current value specified on the corresponding I_OUT0_n or I_OUT1_n field goes to the channels specified on the I_OUT0_CH_m and I_OUT1_CH_m fields of the CHANNEL_m register even in standby. | | |
| 1 | STBY_REFHOL_EN | | Keep Reference Holder Alive in Standby Mode. | 0x0 | R/W |
| | | 0 | Reference Holder Disabled in Standby Mode. | | |
| | | 1 | Reference Holder Enabled in Standby Mode. | | |
| 0 | STBY_INTREF_EN | | Keep Reference Alive in Standby Mode. | 0x0 | R/W |
| | | 0 | Internal Reference and REFOUT Buffer Disabled in Standby Mode. | | |
| | | 1 | Internal Reference and REFOUT Buffer Enabled in Standby Mode | | |

analog.com Rev. A | 98 of 99

OUTLINE DIMENSIONS

| Package Drawing (Option) | Package Type | Package Description |
|--------------------------|--------------|--|
| CP-32-29 | LFCSP | 32-Lead Lead Frame Chip Scale Package |
| CB-35-3 | WLCSP | 35-Ball Wafer Level Chip Scale Package |

For the latest package outline information and land patterns (footprints), go to Package Index.

Updated: May 12, 2022

ORDERING GUIDE

| Model ¹ | Temperature Range | Package Description | Packing Quantity | Package Option |
|--------------------|-------------------|---------------------|------------------|----------------|
| AD4131-8BCBZ-RL7 | -40°C to +105°C | 35-Ball WLCSP | Reel, 1500 | CB-35-3 |
| AD4131-8BCPZ-RL7 | -40°C to +125°C | 32-Lead LFCSP | Reel, 1500 | CP-32-29 |

¹ Z = RoHS Compliant Part.

EVALUATION BOARDS

| Model ¹ | Description |
|--------------------|------------------|
| EVAL-SDP-CK1Z | Evaluation Board |
| EVAL-AD4131-8WARDZ | Evaluation Board |

¹ Z = RoHS-Compliant Part.

